

BREATHE: Balanced Responsive Environmental Airflow and Temperature Housing Enhancer



EEL 4914 Senior Design I
Group 40

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1.0 Executive Summary

Improving the environment of living conditions in common households is a goal that industry aims to solve through finding new ways to implement technology. A significant problem includes irregular temperature distribution throughout the household, causing some rooms to be significantly hotter or colder than others. This can cause discomfort and force residents to choose or rely on alternative, less efficient means of temperature control such as ceiling fans and heaters. These inconsistencies can also negatively affect sleep quality due to the low temperature accuracy of these options and other variables such as the sound generated from ceiling fans. In many situations, the problem isn't necessarily due to an air condition unit, but rather ineffective air distribution amongst the rooms of the building. Finding an energy efficient solution to these problems is crucial towards improving the quality of life for residents living in common households, which serves as the main motivation for the development of this project.

BREATHE is a smart ventilation system that aims to provide a solution to these temperature concerns by allowing users to automate their ceiling registers' louver positions, and in turn adjusting the temperature of their room through a control unit. This control unit functions by a user inputting a desired temperature and in turn the device will automatically adjust the angle of the louvers on the vent in accordance with the room's current temperature. BREATHE will consist of two separate units; a control unit which will monitor the environment through sensors and interact with the user, and a vent interaction subsystem that will interface with the vent's louvers and open or close it according to signals from the control unit. The vent interaction subsystem is designed with battery efficiency in mind, reducing the amount of power consumed while the device is operating while also achieving the goal of maintaining a comfortable and desired environment.

This document covers the design process of BREATHE, providing a comprehensive view of the overall project's development. To establish a clear foundation for the development of BREATHE, the content begins with the specification of attainable goals and the objectives to achieve them. This includes the thought process behind the hardware selection, choosing components such as the microcontroller unit, temperature sensor, carbon dioxide sensor, motor and encoder, buzzer and LCD screen. Moreover, the approach regarding the software of BREATHE was also discussed, encompassing areas such as coding environments and graphic libraries. This

also includes the justification of components, graphs and flowcharts of subsystems within the project, and related items. The document further discusses the implementation of our component selection into prototyping and experimentation to deepen our knowledge in these fields. The project was designed to align with our main goals, aiming to optimize elements to meet our design specifications.

2.0 Project Narrative

2.1 Background and Motivation

In today's society, the demand for reliable and efficient home ventilation systems has become paramount. Individuals depend on these reliable home ventilation systems, as they not only establish overall comfort in indoor spaces such as residential, commercial, and industrial spaces, but they also serve to maintain excellent indoor air quality as well as provide the means to regulate temperature. By creating a more effective method of regulating ventilation, BREATHE will be able to sufficiently improve one's health and comfort levels while keeping energy demands low.

Despite advancements in this specific field, there exist some ventilation systems that do not meet the standards that individuals demand in these living spaces. Issues such as inconsistent airflow distribution and poor temperature regulation both contribute to an uncomfortable indoor environment. Moreover, a poor ventilation system can lead to health issues that are problematic to both residential and commercial settings. The circulation of carbon dioxide has been proven to have adverse effects on various environments. For this reason, the importance of proper ventilation not only circumvents the problem of discomfort, but also recognizes the need to monitor the air quality that is being circulated.

Thus, the motivation for this project can be defined by the need to develop an efficient system that directly combats issues that are commonly found in home HVAC systems. This motivation also stems from the team's personal experiences with poor ventilation that results in some rooms with improper heating/cooling systems. Particularly in the tropical state of Florida where rooms can reach upwards of 90 degrees Fahrenheit, many have experienced the discomfort of poorly ventilated rooms. This can become especially unpleasant during the warmer months of the year. The personal struggles in dealing with hot living spaces has reinforced the need to create an efficient system that takes these problems into account.

In developing this project, the team seeks to integrate various electronic and software systems, including environmental sensors and microcontrollers, to intelligently adjust the airflow based on real time environmental data. By taking advantage of these electronic and software systems, air circulation is optimized, thus resulting in a more comfortable living environment.

By addressing both the problems identified in comfortability as well as inefficiencies found in pre-established ventilation systems, the overall aspiration of this project is to bolster the everyday individual's comfortability to their specific needs, facilitate an environment with safe air quality, and contribute to sustainable living. Our motivation leads us to design and implement an efficient and smart ventilation system that not only mitigates the flow of inconsistent and inefficient airflow, but also guarantees an indoor environment that is conducive of a comfortable and healthy living space.

2.2 Previous and Existing products or projects.

2.2.1 Google Home

An existing product on the market that has the ability to adjust temperature via a cell phone application is the Google Home. Google Home has the capability to connect various devices ranging from speakers, doorbell cameras, alarm systems, smoke alarms, Nest thermostats, and beyond. The Nest Thermostat is the device connected through the Google Home app, and this shares the most similarity to BREATHE. With the Nest Thermostat one can view and adjust the temperature of your home's thermostat, toggle from cold to heat settings, select how long the fan should run for, view the humidity percentage of the home, and set a desired temperature schedule per day. It also includes an energy dashboard which displays how much energy is being saved. The device compares the amount of hours of heating and cooling to the previous month, and the daily average of heating and cooling per day. The inspiration we drew from this application as a team was the ability to access temperature readings and manually adjust the temperature output. Our project will be different from this product because we are not modifying the temperature for the entire house, but rather an individual room where our device is placed with a carbon dioxide sensor integrated with our design. BREATHE consists of a manually controlled vent that has the ability to be open or closed in regard to a user's desired room temperature [1].

2.2.2 The Automated Ventilation Controller

One of the first similar projects to catch our eye was the Automated Ventilation Controller project from another senior design group in 2021. The idea was similar, but instead focused on a warehouse environment where accurate temperature control was a necessity for keeping sensitive components and machinery maintained. We conversely wanted to take a different approach which focused more on the comfort of the average person in a residential space. We also wanted to see if we could further optimize the power consumption to make a more approachable product for your average consumer who wouldn't want to replace a battery every few months. We additionally plan to implement a CO₂ sensor which would alert the user of high concentrations of CO₂ in their living space, something that is not acknowledged often as a health risk. We were also very inspired by their convenient mobile app integration, something that we see many other projects incorporate as well. Though we see this as a stretch goal, we do hope to incorporate a mobile app and autonomous vent control in our project as well [2].

2.2.3 Ctrl Flow

Another past project we gained inspiration from is a senior design group that altered fan controls to reach desired room environment quality. Their project, the CTRLFlow, is different from ours in that their main controller was operated through a mobile app connected to a remote cloud server. This is how they would change the speeds of the fans and the angle of the louvers to adjust to the temperatures of the corresponding rooms. Our project will pursue similar goals, however, as mentioned prior, we plan on utilizing a CO₂ sensor to optimize the air quality of the room whilst using power-saving techniques to achieve a stronger battery life. As a stretch goal, one technique we would like to implement is a miniature wind turbine to generate electricity, taking advantage of the AC airflow [3].

2.3 Project Goals

The overarching goal of BREATHE is to design and develop a vent system that will open or close in order to adjust the airflow in a room while monitoring basic environmental conditions such as temperature and carbon dioxide. Using real-time data that is provided by the respective sensors, BREATHE should aim to facilitate a comfortable living space. The fundamental basis of this project's objectives can be simplified to a set of basic, and stretch goals described below.

Basic Goals

1. The vent can be opened or closed remotely from user input.
2. Autonomous control of the vent will be based on user-specified temperature parameters.
3. The temperature of the room in which the vent is located will be regulated based on user input.
4. BREATHE will have a sensor that will sense the Carbon Dioxide levels in a room.
5. A buzzer will alert the user during necessary situations.
6. The power system will ensure a reliable delivery of power to each necessary component.
7. The device will be easy for the user to control and adjust.

Stretch Goals

1. The user can open the vent to a desired angle.
2. BREATHE will incorporate a fan behind the vent to be used as a power generation feature similar to a wind turbine in order to increase battery life of the vent interaction subsystem.
3. BREATHE will incorporate a fan behind the vent to be used in the event that Carbon dioxide levels are high and increase airflow into the room to dissipate excess Carbon dioxide
4. A mobile application will be used as a secondary way to control BREATHE.

2.4 Project Objectives

In essence, BREATHEs goal is to provide a user with an efficient ventilation system that adjusts airflow that is dictated by environmental conditions, ensuring the facilitation of a comfortable living space. With respect to comfortability, BREATHE will be designed to tailor the airflow of the vent in response to any variations found in room temperature. For example, the colder the room temperature, the more restricted the air flow will be and the hotter the room temperature, the less restricted the air will be. In essence, BREATHE will have the capability to attenuate airflow based on sensed room temperatures, thereby facilitating comfortability in a living environment.

BREATHE will provide users with the capability to provide full manual control on the airflow based on their input. A vent interaction sub-system will allow the vent to be adjusted between a fully open and fully closed position through the use of a DC motor, which will be controlled by an MCU. The user will be able to implement these adjustments via a control unit which houses the LCD unit and

the sensors. Alternatively, the user can specify a desired temperature value, which enables an autonomous mode that will fluctuate the vent's state to change based on the current sensor reading of the room's temperature.

BREATHE will have a control sub-system with an LCD unit that takes in user input in conjunction with sensors to provide accurate readings of temperature and CO₂ levels. In order to achieve reliable and accurate readings, an appropriate temperature and CO₂ sensor will be selected. Calibration methods, such as multi-point calibration and span calibration, will be implemented to ensure accuracy over its operating range. These sensors will be connected to a secondary MCU, which will be responsible for aggregating and interpreting the data gathered from both the temperature and CO₂ sensor.

Furthermore, BREATHE will need a power system that is capable of delivering power to all subsystems including the temperature sensor, CO₂ sensor, DC motor, LCD screen, and both MCUs. Implementing this system will bring challenges, such as finding a suitable battery that will provide adequate power to each component and limiting the battery usage of each subsystem to reduce the inconvenient task of replacing the battery frequently. This problem necessitates finding a bluetooth compatible MCU and sensor with relatively low power consumption that will still satisfy our technical requirements. Modes such as Sleep Mode and Power Down Mode can be integrated in tandem with a reliable power supply section to optimize energy usage.

Next, BREATHE will have an LCD unit that is used to control the vent system and display sensor values. The utilization of a touchscreen LCD along with an intuitive interface will create a user-friendly and easy-to-use system. The LCD unit will be programmed to display different warnings if necessary, with the help of visual and audio cues. One of the display warnings will be for low battery reading of the vent and LCD units, which will consist of an intermittent beep and a warning message on the LCD screen. The other display warning will be for a high CO₂ sensor reading. If the CO₂ sensor reads a theoretical value of 4000 ppm, the LCD unit will sound an alarm and present a warning message on the screen. A dedicated MCU will be needed to power the LCD screen and manage its associated functions.

Lastly, BREATHE will be Bluetooth compatible, allowing communication between both MCUs involved in the overall system. Intuitively, the MCUs chosen will need to have Bluetooth integrated within them. Bluetooth connectivity will be tested in order to confirm an established and reliable communication method between MCUs over a specified range. Software will be developed for Bluetooth

communication protocol to ensure scalability and communication with both the sensors and DC motors to the main unit from different rooms.

2.5 Specifications

Specification	Description	Quantitative Measure
Manual Vent Control	The system should be capable of manual operation that fully opens or closes the vent through user input	Vent can be in 1 of 2 positions, <i>open</i> or <i>closed</i> .
Autonomous Vent Control	The system should be able to autonomously adjust the louver position according to the room's temperature and the user's desired temperature threshold.	If the temperature variation (in $^{\circ}F$) is $\geq 5\%$, the vent should open or close depending on if the variation is above or below the desired temperature set by the user.
Sensor Accuracy	Sensors should maintain high accuracy within a specific range	Temperature reading should be accurate to $\pm 1^{\circ}F$ and CO_2 reading should be accurate to $\pm 50 ppm$
Sensor Operating Range	Each sensor should have a sufficiently wide defined operating range to accommodate for extreme conditions.	Temperature sensor operation range should be from -40 to $176^{\circ}F$, whereas the CO_2 sensor operation range should be from $0 ppm$ to $5000 ppm$
Battery Life	Units should be able to operate for a certain length of time before a battery replacement.	Minimum duration of <i>6 months</i> before needing replacement
Bluetooth Range	Bluetooth	Bluetooth

	communication should work within a specified range	communication should work up to a <i>10-meter range</i>
Dimensions	The overall system's physical dimensions should fit within the average residential vent cover design.	<i>12 x 6 inches</i>
Audio Alarm System	An audible alarm should be triggered when CO ₂ levels exceed a certain threshold. A separate alarm will trigger when the battery is low.	Alarm sounds when CO ₂ exceeds <i>4500 ppm</i> . When the battery of the vent control unit is below <i>10%</i> capacity it will sound intermittently at a lower pitch and volume. There should be only a $\leq 10\%$ chance of a false alarm occurring.
Vent Actuation Time	The vent should fully open or close within a defined time limit.	Vent will be able to fully open or close within <i>5 seconds</i>

Table 1: Specification Table

2.6 Block Diagrams

2.6.1 Hardware

The system is split into two main sections: the vent interaction subsystem, and the control unit which houses the LCD unit, and sensors. The diagram shows the communication between each of the components, as well as the main interactions between each sub-system. The vent interaction sub-system focuses on delivering proper airflow to the environment by utilizing a motor to adjust louver positions. The control unit focuses on taking input from the sensors and the LCD unit is responsible for sending the control signals to the vent interaction sub-system. The LCD unit will then display information such as temperature and CO₂ levels, allowing data to be monitored. It will also trigger an alarm if a hazardous situation occurs. The Hardware Diagram is shown below.

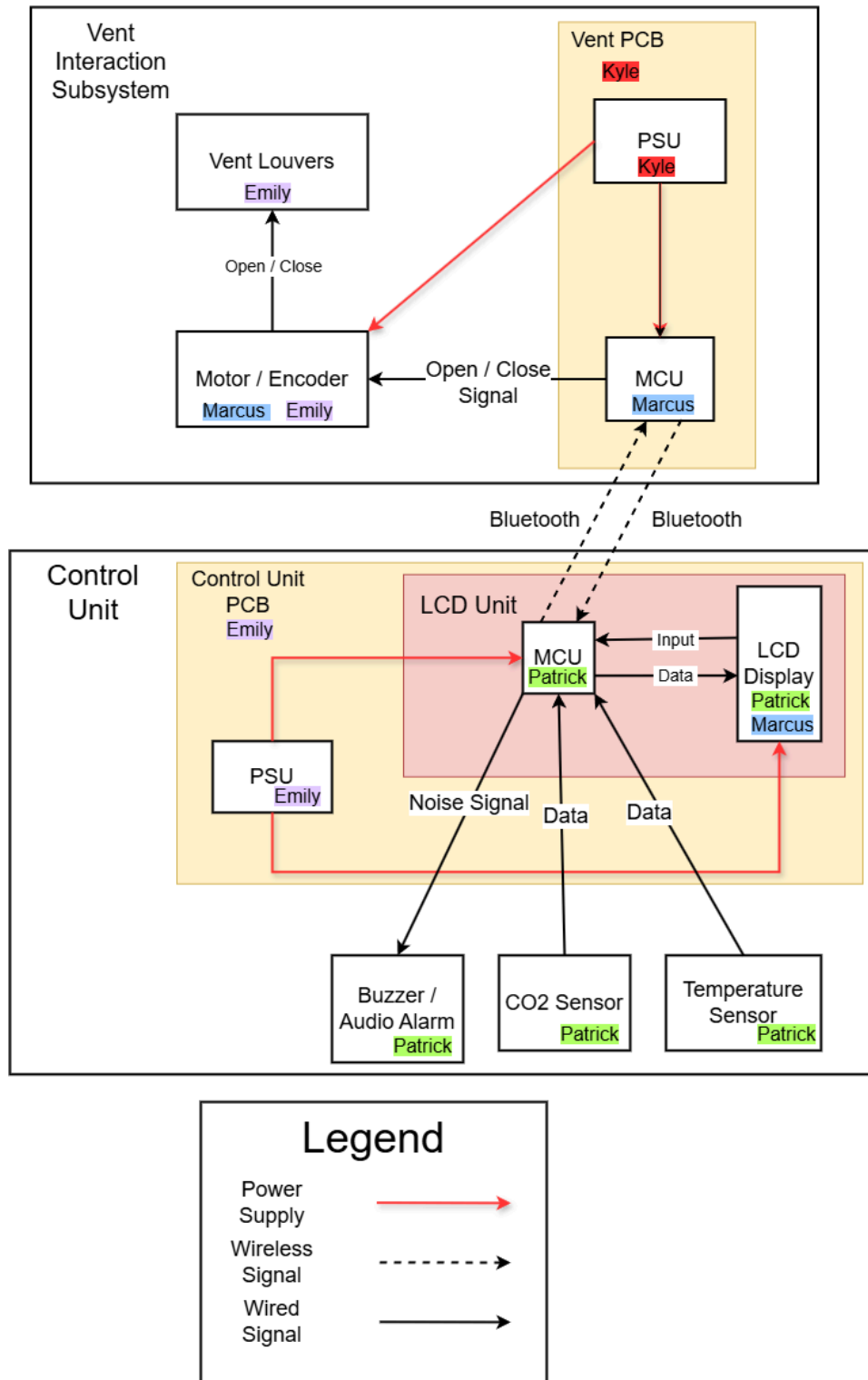


Figure 1. Hardware Diagram

2.6.2 Software

The software use-case flow chart below demonstrates the functional interactions between each of the three subsystems, as well as the work distributed between group members.

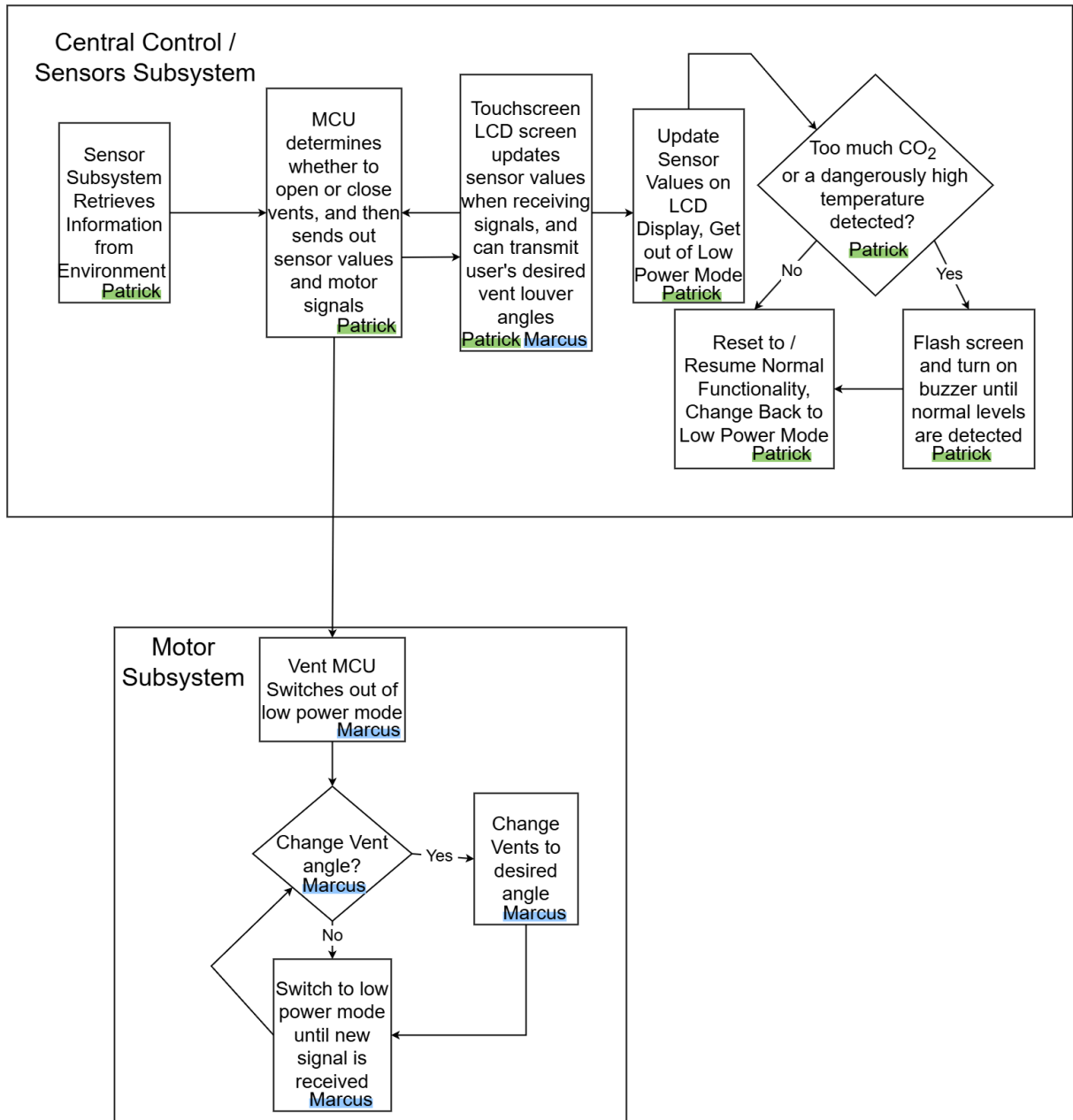
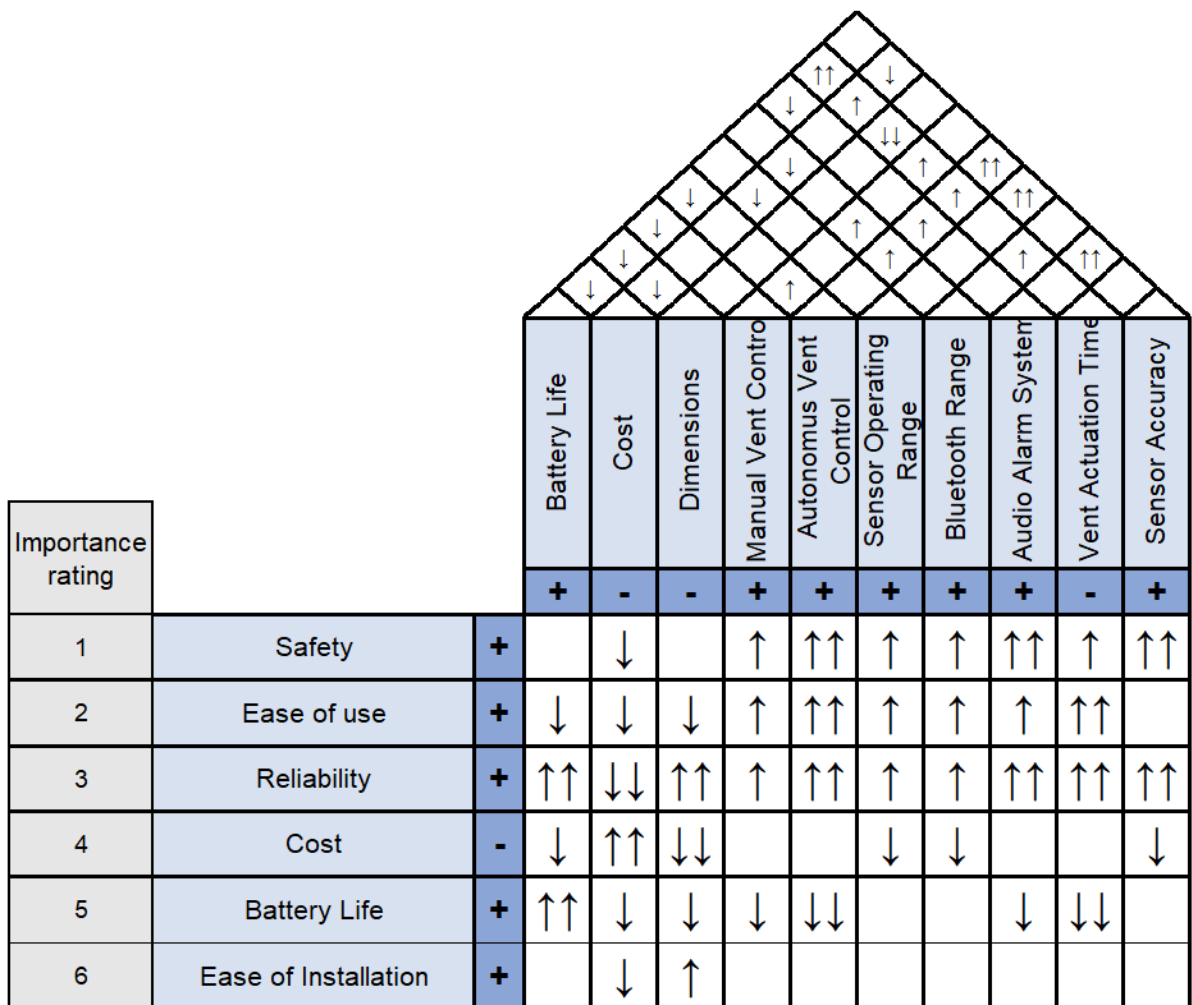


Figure 2: Software Flowchart

2.7 House of Quality

Showcasing the polarities as well as correlations between the functional requirements and the customer requirements the House of Quality diagram is shown below.



Polarity		
+	-	-
Positive		Negative

Correlation		
↑		↓
Maximize	Target	Minimize

Figure 3. House of Quality diagram

3.0 Research

This research section offers an overview of the hardware and software components utilized in BREATHE. It details each component's role and emphasizes their function in achieving the project's objectives. The hardware components such as microcontrollers, sensors, LCD displays, and motors are described alongside their specifications and contributions to the system's overall functionality. The software aspect covers the programming languages, development environments, and libraries used for the system's firmware and user interface. By exploring both hardware and software, this section provides insight into the technological framework of BREATHE and how each component is essential for creating an efficient, responsive, and user-friendly smart vent system.

3.1 Microcontrollers

When selecting an MCU, there were three important factors that were considered: power consumption, integrated Bluetooth Low Energy (BLE), and ease of integration. To achieve the system's desired lifespan of 6 months, it was crucial to choose an MCU that balanced both performance and energy efficiency. Ideally, the desired MCU should have a small form factor, a reasonable operating frequency, and low current consumption in both active modes and low power modes. Equally as important is the inclusion of integrated Bluetooth Low Energy (BLE), since Bluetooth was needed to communicate with the vent interaction subsystem's MCU. This eliminated the need for an external Bluetooth module, simplifying the system's design and further optimizing power usage. Lastly, ease of integration was another important factor. Given time constraints and adherence to the project's specifications, we should prototype the system's code on associated development boards while the PCB is being developed with the standalone chip. With these factors in mind, several MCUs were considered during the selection process.

ESP32: Initially, the ESP32 was considered to be a viable option for the project due to the team's experience with it, its integrated BLE capabilities, affordability, and compact form factor. However, after further research, it became clear that the ESP32 had some properties that weren't ideal for this project. The ESP32 has a relatively higher power consumption for an application such as a smart vent. In active mode, it draws between 278mA and 335mA [4]. For a battery powered system, especially one that needs to operate for an extended period, the current draw is way too high. Over a long period of time this high current

consumption would rapidly drain the system's battery, making it unsuitable for our system. Even considering further optimizations such as using the ESP32's sleep mode, which draws only 5 μ A, the smart vent system will frequently wake up to take sensor readings. Each time the ESP32 needs to process something it will consume the full current draw in active mode. This will likely drain the batteries very quickly even if it spends little time in active mode. Although the ESP32 has powerful capabilities, its high frequency and inefficient power consumption makes it unsuitable for this application, where efficient power usage is a critical requirement.

nRF52840: The nRF52840 was one of the more feasible options for the project. It operates at a frequency of 64MHz, which is reasonable for the vent interaction subsystem's requirements. What also made the nRF52840 a desirable choice was its low power consumption. In its active mode, it draws only 3.3mA [5], and it also offers numerous power saving modes, including a low power mode and deep sleep mode, both drawing 2.35uA [5] and as low as 0.4uA [5] respectively. For BLE operations, the nRF52840's current draw is 6.26 mA during transmission (Tx) [5] and 5.2 mA during reception (Rx) [5]. While these figures are relatively low, other MCUs offer slightly lower current consumption during BLE operations. In summary, the nRF52840 offers excellent power efficiency and low power-mode performance.

EFR32BG22: Another option for the project was the EFR32BG22. It has an operation frequency of 76.8MHz, which is appropriate for the vent system's requirements [6]. Moreover, the EFR32BG22 offered efficient power consumption, drawing 42uA/MHz in its active mode. This allows for a sufficient level of flexibility, as the operating frequency can be manually configured to a desired level. Even at the highest possible operating frequency, the EFR32BG22 would only draw 3.23mA [6], being slightly more efficient than the nRF52840. The EFR32BG22 also offers various low power modes. When set to EM2 mode, the MCU consumes 1.94uA and at its lowest consumption mode, EM4, it consumes as low as 0.17uA [6]. One disadvantage regarding this MCU is that configuring it is often more complex than other MCUs. The chip supports multiple operational modes, each requiring specific setup for power management and peripheral functionality. For instance, developers must navigate intricate settings for low-power modes, communication protocols, and peripheral initialization. This complexity is highlighted by the interdependencies among different features; enabling one mode may impact the operation of others, necessitating careful planning and testing. As a result, the EFR32BG22 offers efficient power consumption, great flexibility and capabilities, while its disadvantages lie in its configuration process [6].

DA14531: A further MCU option is the DA14531. The DA14531 was considered a suitable choice for an MCU due to its very low power consumption. Comparatively, the DA14531 consumes the least amount of power out of every considered MCU, making it the most power efficient selection. It draws an impressive 830 μ A in its active mode and offers multiple low power options. Its Extended Sleep Mode draws 1 μ A and Hibernation Mode draws 270 nA. Its operating frequency is also the lowest out of every MCU being considered, being at only 16MHz [7]. Additionally, it has an impressive form factor, being very compact at 1.7×2.05 mm [7]. Despite these advantages, the DA14531 has some limitations such as its processing power. The DA14531 uses an ARM Cortex-M0+, which is considerably less powerful than the EFR32BG22's ARM Cortex-M33 or the STM32's ARM Cortex-M4. Likewise, the DA14531 houses only 48 KB of RAM and lacks flash memory. While these limitations may not pose concerns for basic sensor data collection and transmission, they can impact the performance and functionality of the LCD screen. The LCD display typically requires a certain amount of memory and processing power to handle data updates. The limited RAM and lower processing power of the DA14531 could restrict the responsiveness of the LCD interface, leading to slower performance or difficulties in handling complex graphics. This constraint could also limit the ability to implement features such as animations, real-time data updates, or a user-friendly interface with multiple menus or options. Nonetheless, the DA14531 is by far the most power-efficient choice for a MCU, however it may lack the necessary processing power needed for the entire system [7].

CC2640R2F: The CC2640R2F was another potential MCU option for the project. Like the other aforementioned MCU's, it has low power consumption. Its active mode consumes 1.45 mA + 31 μ A/MHz, and at its maximum operating frequency it'll draw only 2.938mA, making it slightly more efficient than many of its alternatives. In its standby mode, which is one of several low power modes, draws 1 μ A, and its shutdown mode draws 0.15 μ A. While the CC2640R2F is offered as a SoC, it is also offered as a development board, which adheres to an ease of prototyping. However, a downside of the CC2640R2F is its limited memory. Although the CC2640R2F has flash memory, its value is considerably less than other options, only being at 128KB. Moreover, it only has 28 KB of SRAM. The lack of memory that the CC2640R2F has poses a similar concern with the DA14531, where it might not be powerful enough to handle the LCD screen. Furthermore, the development board of the CC2640R2F is quite expensive, costing \$29 [8].

STM32: Another viable option for an MCU was the STM32. Like previously mentioned MCUs, the STM32 not only has an operating frequency of 64MHz,

but also has relatively low current draw. Its active mode consumes 53uA/MHz. Therefore at its maximum operating frequency of 64MHz, the STM32 will draw 3.39mA. A significant advantage the STM32 has is its extensive selection of low power modes. For instance, Stop Mode 2 draws only 0.5uA while retaining RAM and allows for a fast wake-up time. In Shutdown mode, current consumption reaches as low as 13nA. The flexibility of having a wide selection of low power modes allows the STM32 to efficiently manage power based on the system's needs. Whether the MCU is periodically collecting sensor data or staying idle for extended periods of time, these low power modes ensure both energy efficiency and responsiveness. Therefore, this flexibility makes it particularly well-suited for a battery powered smart vent system that requires both longevity and reliability [9].

Another benefit that the STM32 has over other MCUs is its processing power. It has a Cortex-M4, similar to the nRF52840, which can handle complex tasks effectively. This architecture balances both power consumption and high performance by integrating features such as single precision Floating Point Unit (FPU), a set of DSP instructions, and dynamic voltage scaling. These features allow for efficient signal processing, complex algorithm execution, and optimized power usage [9]. A last benefit that the STM32 provides is the availability of software libraries, such as TouchGFX. TouchGFX is a powerful graphics library designed for the STM32, and is optimized for touchscreen interfaces. Access to TouchGFX streamlines the development process, as it provides a wide range of pre-built functions and graphical elements. Despite its advantages in power-efficiency, the STM32's active mode does have slightly higher power consumption compared to the other MCUs, especially the DA14531 and the CC2640R2F. However, the variation in comparison is minimal, typically ranging only a few milliamperes. This minimal variation shouldn't pose any significant challenges for power efficiency, and is made up from its adaptability from its numerous low power modes. However, a more notable downside is cost, as STM32 development kits can be quite expensive compared to alternatives. For instance, the STM32WB5MM Development Kit costs \$25 [9]. Overall, the STM32 stands out as a viable choice due to the combination of performance and low power consumption, flexibility, and extensive development resources.

MCU	Frequency	Run/Active Mode Current Consumption	LPM Consumption	Current	BLE Current Transmission	Tx/Rx
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ESP32-C3	160MHz	TX: 278 mA - 335 mA RX: 84 mA - 87 mA	Light Sleep: 130 μ A Deep Sleep: 5 μ A Modem Sleep: 13 mA - 28 mA	RX: 84 mA - 87 mA TX: 278 mA - 335 mA
nRF52840	64 MHz	Run Mode (Using DC/DC Regulator + Flash Memory): 3.3mA	Deep Sleep (System OFF Mode): 0.4 μ A - 1.86 μ A Low Power (System ON, wake up from interrupt): ~2.35 μ A	RX: 6.26 mA TX: 5.2 mA
STM32WB09XX	64 MHz	Run Mode: ~2.679 mA - ~3.85 mA	Low Power Sleep Mode (1 MHz): 1.023 μ A - 12.929 μ A Shutdown Mode: 20 nA	RX: 3.6 mA TX: 4.9 mA
DA14531	16 MHz	Run Mode: 830 μ A Run Mode with CPU Idle: 5 mA	Extended Sleep Mode: 1 μ A Hibernation Mode: 270 nA	RX: 2.2 mA TX: 3.5 mA
EFR32BG22	76.8 MHz	Active Mode (EM0): 42 μ A/MHz	Low Power Mode (EM2): 1.94 μ A Lowest Mode (EM4): 0.17 μ A - 0.43 μ A	RX: 2.5 mA TX: 3.4 mA
CC2640R2F	48 MHz	Active Mode: 1.45 mA + 31 μ A/MHz	Idle Mode: 650 μ A Standby Mode: 1 μ A Shutdown Mode: 0.15 μ A	RX: 5.9 mA TX: 6.1 mA

Table 2: MCU Comparisons

3.1.1 Final MCU Selection and Justification

In conclusion, the selection of the MCU for the smart vent system involved a thorough analysis of various options, each with its own strengths and weaknesses in terms of power consumption, available integrated Bluetooth Low Energy (BLE) capabilities, ease of integration, and operating frequency. The ESP32 was initially appealing due to its capabilities but was ultimately dismissed due to its high power consumption, which would shorten the project's lifespan. The nRF52840 emerged as a strong candidate, offering excellent energy efficiency and low power mode performance, but its BLE operation drew more current than the alternatives.

The EFR32BG22 showcased superior efficiency at higher frequencies but presented a complex configuration process that could impact development time constraints. On the other hand, the DA14531 excelled in power efficiency, with the lowest consumption rate, but its limited processing capabilities raised concerns about operating the LCD screen effectively. The CC2640R2F provided low power consumption and easy prototyping but was limited by its memory capacity.

Finally, the STM32 offered a balanced combination of performance and efficiency, further supported by an extensive selection of software libraries that would improve the development process. While it had a slightly higher active mode current draw than the DA14531 and CC2640R2F, its wide array of low-power modes and the ability to manage processing tasks effectively made it a suitable choice for the smart vent system. Despite the cost considerations associated with development kits used for prototyping, the STM32's capabilities to support the necessary functionalities for the project, along with its reliability and efficiency, solidified its selection as the ideal MCU for the system.

Overall, the decision to choose the STM32 reflects a balance between the need for sufficient processing power, the importance of low power consumption, and an ease of integration into the smart vent system. By prioritizing these criteria, the selected MCU will facilitate a successful implementation that meets the project's performance and efficiency goals.

3.2 Sensor Selection

3.2.1 Introduction

BREATHE will incorporate two key sensors: a temperature sensor and a CO2 sensor. These sensors are integral to the smart vent system, as they will

continuously monitor environmental conditions in order to ensure optimal airflow. The temperature sensor will ensure the vent system adjusts ventilation based on current room conditions while the CO₂ sensor will monitor the air quality, where both are crucial for a safe and comfortable living indoor environment. The collected data is sent to the MCU for further processing and control, allowing the vent to open or close autonomously based on real-time room conditions. This data is also displayed on an LCD screen, giving users the option to manually override the system if needed. Moreover, collection of reliable data from the sensors will improve safety since the sensors will be able to detect dangerous levels of temperature or CO₂. This will allow the system to adjust airflow accordingly or alert the user, thus helping to prevent any potential dangers.

3.2.2 Selection Criteria

When selecting suitable sensors for the project, there are several criteria that need to be considered. One important aspect is accuracy. The sensor must provide precise readings so that the system can adjust airflow based on accurate environmental data. In adherence to the project's specifications, the temperature sensor should have an accuracy of $\pm 1^{\circ}\text{F}$ and the CO₂ sensor should be accurate to ± 50 ppm. This will ensure the system performs as expected. Another crucial factor is its operating range. The sensor must accommodate both a wide range of temperatures and CO₂ levels to ensure proper operation under various environmental conditions. According to the project specifications, the temperature sensor must function within a range of -40°F to 176°F , while the CO₂ sensor must function within a range of 0 ppm to 5000 ppm. Having a wide temperature range allows the system to remain effective in both extreme heat and cold, ensuring it can monitor and control ventilation in nearly any situation. Additionally, a wide CO₂ range allows the system to effectively detect and respond to varying air quality levels, further promoting a healthy indoor environment.

3.2.3 Types of Temperature Sensors

With respect to temperature sensors, there are several different types with each offering distinct advantages. These sensors vary in terms of accuracy, integrated features, and communication protocols. The ideal sensor will involve carefully evaluating these factors and making trade-offs based on specific requirements of the vent system. For instance, higher accuracy may come at the cost of a slower response time, while a more expensive sensor may come with greater accuracy. Thus, the objective is to balance these considerations to select the most suitable sensor for the application.

Analog temperature sensors: Analog temperature sensors output a continuous voltage signal that is linearly proportional to temperature [10]. Moreover, they are relatively simple to integrate with MCUs. They offer reasonable accuracy, typically ranging from ± 0.28 to $0.56^{\circ}\text{C}/\pm 0.5$ to 1°F and exhibit low power consumption. Likewise, they have a typical operating range from -50°C to $150^{\circ}\text{C}/-58^{\circ}\text{F}$ to 302°F [11]. However, generally over time collected data tends to drift which can lead to inaccuracies and interrupt operations, therefore calibration can be used to mitigate this.

Digital temperature sensors: Digital temperature sensors convert temperature to digital signals. They consist of a sensing element that detects temperature and conditions the detection through signal conditioning. Digital temperature sensors offer similar benefits to analog temperature sensors in the sense that they offer low power consumption, have similar accuracy, and are easy to integrate with MCUs. They also have a similar operating range, typically spanning from -40°C to $125^{\circ}\text{C}/-40^{\circ}\text{F}$ to 257°F . However, they are generally more expensive than Analog Temperature Sensors [11].

Thermocouples: are versatile sensors suitable for measuring extreme temperatures. They consist of two dissimilar metals joined at one end, creating a voltage that varies with temperature. Thermocouples can operate over a wide range, typically from -200°C to $1250^{\circ}\text{C}/-328^{\circ}\text{F}$ to 2282°F , but they require additional signal conditioning to produce accurate readings. Their advantages include high-temperature capability and durability, but they may have lower accuracy compared to other sensor types, ranging from ± 1 to $2^{\circ}\text{C}/\pm 1.8$ to 3.6°F [11].

Thermistors: are temperature-sensitive resistors that change resistance with temperature. They are highly sensitive and accurate to ± 0.1 to $0.2^{\circ}\text{C}/\pm 0.18$ to 0.36°F within a limited temperature range, typically from -50°C to $150^{\circ}\text{C}/-58^{\circ}\text{F}$ to $+302^{\circ}\text{F}$. While they offer high precision and low power consumption, thermistors can be nonlinear and require more complex calibration methods to maintain accuracy [11].

RTDs (Resistance Temperature Detectors): use the principle of resistance change in metals to measure temperature. They offer high accuracy ranging from ± 0.1 to $0.5^{\circ}\text{C}/\pm 0.18$ to 0.9°F , stability, and a wide operating range, generally from -200°C to $850^{\circ}\text{C}/-328^{\circ}\text{F}$ to $+1562^{\circ}\text{F}$. However, they require precise signal conditioning and a constant current source for accurate measurements, which can make integration moderately complex. RTDs are also more sensitive to lead resistance, often needing 3-wire or 4-wire configurations to reduce errors.

Additionally, RTDs tend to be more expensive and can be less robust than thermocouples in harsh environments [11].

Sensor Type	Accuracy in °F	Temperature Range in °F	Ease of Integration
Analog	± 0.5 -1°F	-58°F to +302°F	Easy
Digital	± 0.5 -1°F	-40°F to +257°F	Easy
Thermocouples	± 1.8 -3.6°F	-328°F to +2282°F	Difficult, requires signal conditioning
Thermistors	± 0.18 -0.36°F	-58°F to +302°	Moderate, requires calibration
RTDs	± 0.18 -0.9°F	-328°F to +1562°F	Moderate, may require external ICs

Table 3: Sensor Type Comparisons

3.2.4 Temperature sensor type selection

Upon further research, it has been decided that analog and digital temperature sensors are the most suitable options for the smart vent system. These two sensors offer simplicity in integration and sufficient compatibility with the STM32, making them the most practical choices. Digital temperature sensors are particularly advantageous due to their straightforward implementation. They typically communicate with the STM32 via communication protocols such as I2C and SPI, which eliminates the need for additional circuitry. Since necessary procedures for sensing such as signal conditioning and analog to digital conversion occur within the sensor itself, no external signal processing components are needed. This not only significantly reduces design complexity, but also improves accuracy by minimizing external factors such as noise.

Similarly, analog temperature sensors provide simple integration, requiring only a direct connection to the MCU. The STM32's built-in ADC efficiently handles the conversion of the analog signals into digital values, eliminating the need for additional external signal processing circuitry. Likewise, they provide a linear output that is easily interpreted by the STM32, further simplifying system design.

Thermistors are relatively easy to integrate as well, often requiring only a single resistor or voltage divider. However, their nonlinear output can complicate obtaining accurate readings, introducing a layer of complexity in calibration and signal interpretation.

RTDs provide high accuracy, however require more elaborate external circuitry. Components such as an external constant current source, signal conditioning components, and possibly dedicated RTD IC's are needed in order to handle amplification and changes in resistance. These additional elements will unnecessarily complexify the implementation of the sensors, making them less desirable to choose as a temperature sensor.

Lastly, thermocouples were considered to be unsuitable for the smart vent system. One significant disadvantage is its form factor; a thermocouple is not ideal for the smart vent system due to its relatively loose and larger form factor, which complicates its integration with other components such as the LCD display. In conclusion, analog and digital sensors offer the best balance of simplicity, accuracy, and ease of integration for this specific smart vent system. Their reduced need for external components and ease of communication with the STM32 make them the most efficient and practical choices.

3.2.5 Temperature Sensor Options

Outlined below are analog and digital temperature sensors that are under consideration for the smart vent system:

1. The LM35 is a precision analog temperature sensor developed by Texas Instruments and was considered as a viable temperature sensor for various reasons. It is known for its linear voltage output directly proportional to temperature in Celsius, which disregards the need of complex signal processing or conversions. This allows for an ease of integration with components such as microcontrollers, as less computational resources and memory would be utilized. Moreover, This sensor is designed for applications requiring precise and reliable temperature measurements, with built-in calibration that eliminates the need for implementing external calibration methods. This is a very substantial advantage, as this also reduces software design complexity. The LM35 also provides an accuracy of $\pm 0.5^{\circ}\text{C}/0.9^{\circ}\text{F}$. and operates over a range of 4V to 30V [12]. It also has an impressive temperature range, spanning from -55°C to $150^{\circ}\text{C}/-67^{\circ}\text{F}$ to 302°F , which surpasses the smart vent's temperature range specifications. Despite these advantages, one potential downside is found in its operating range. The smart vent's

selected MCU, the STM32, operates at a voltage rating of 3.3V, while the LM35 requires a minimum operating voltage of 4V. While the LM35 could be connected to an external power supply and share a ground with the STM32, this approach may require using two separate voltage rails in the LCD unit. This setup would increase the board footprint and add to the overall cost. Despite the challenge posed by its higher minimum operating voltage, the LM35 remains a strong candidate due to its precision, reliability, and ease of integration.

2. The TMP36 is another suitable option for a temperature sensor, offering many of the same advantages as the LM35. This low-voltage, precision sensor also outputs a voltage linearly proportional to the Celsius temperature, simplifying integration with microcontrollers and other electronic components. Like the LM35, it has integrated self-calibration measures that ensures consistent and reliable temperature readings over extended periods of time. Although its accuracy is slightly lower than that of the LM35, it provides sufficient accuracy ranging from ± 1 to $\pm 2^{\circ}\text{C}/\pm 1.8$ to $\pm 3.6^{\circ}\text{F}$. Moreover, it has a very reasonable operating range, spanning from -40°C to $125^{\circ}\text{C}/-40^{\circ}\text{F}$ to 257°F , exceeding the smart vent's specifications. It also has an operating voltage range of 2.7 V to 5.5 V, ensuring compatibility with the 3.3V supply of the STM32. Additionally, the sensor is stable when driving large capacitive loads and is designed for reliability across various environmental applications, ensuring consistent performance in the smart vent system. The sensor also benefits from low self-heating characteristics, which help maintain accurate readings without significant temperature drift [13]. Overall, the TMP36's ease of integration, adequate accuracy and operating range, and stability and self-heating characteristics make it a reliable option for a temperature sensor.
3. TMP102: Developed by Texas Instruments, the TMP102 stands out as a viable temperature sensor for a number of reasons. It provides the same accuracy as the LM35 at $0.5^{\circ}\text{C}/\pm 0.9^{\circ}\text{F}$, and does not require any further calibration [14]. Its operating range is identical to the TMP36, ranging from -40°C to $125^{\circ}\text{C}/-40^{\circ}\text{F}$ to 257°F , making it suitable for environments beyond the smart vent's specified range. With a voltage range between 1.4V and 3.6V, the TMP102 is well-suited for integration with the STM32, similar to the TMP36, as it can operate within the MCU's 3.3V range without requiring external power sources. Additionally, since the TMP102 is a digital sensor, it communicates using the I2C protocol, which is natively supported by the STM32, further simplifying integration. Moreover, the TMP102 has a very fast response time compared to the

LM35 and TMP36. It reaches 63% of the final temperature value in just 0.8 seconds, whereas the LM35 takes between 20 to 30 seconds, and the TMP36 requires under 50 seconds in still air conditions. This rapid responsiveness makes the TMP102 highly suitable for real-time temperature monitoring applications [14].

4. SHT30: The SHT30 is a digital temperature sensor developed by Sensiron and was considered a suitable sensor for the smart vent. It integrates seamlessly with the STM32, as it has an operating range from 2.15V to 5.5V, and uses the I2C protocol. Moreover, it offers an operating range similar to that of the previously mentioned sensors, with an operational range of -40°C to 125°C/-40°F to 257°F and an idle range of -40°C to 160°C/-40°F to 302°F. It comes fully calibrated and linearized, delivering temperature-compensated digital output with impressive accuracy of $\pm 0.1^{\circ}\text{C}$ [15]. The sensor also has a relatively fast response time, having a thermal time constant of approximately 2 seconds to reach 63% of its final value. However, a notable consideration is that the SHT30 combines both temperature and humidity sensing, which may lead to increased power consumption and greater sensitivity to environmental factors such as moisture levels, potentially introducing inaccuracies in readings. In contrast, dedicated temperature sensors like the TMP102 or LM35 focus solely on thermal measurements, making them less susceptible to variations in humidity, airflow, and other environmental conditions.

3.2.6 Final Selection and Justification

After extensive research and consideration, the TMP102 was chosen as the sensor used for the smart vent. While each considered sensors were all suitable options for the project and shared similar benefits, the TMP102 distinguished itself with its ease of integration and rapid response time. When compared to its analog counterparts, the TMP102 simplifies integration through its I2C communication protocol, which is natively supported by the STM32. More specifically, the TMP102's operating range is compatible with the STM32,, unlike the LM35, simplifying its integration within the smart vent system. Additionally, the TMP102 boasts the fastest response time of all the sensors, reaching 63% of its final value in just 0.8 seconds. With a reasonable accuracy of $\pm 0.5^{\circ}\text{C}/\pm 0.9^{\circ}\text{F}$, the TMP102 meets the project's specifications and comes fully calibrated, removing the need for any external calibration. Furthermore, it shares an identical operating range with the TMP36, operating from -40°C to 125°C/-40°F to 257°F, making it an ideal choice for the smart vent. Lastly, unlike the SHT30, the TMP102 is a dedicated temperature sensor, thus there is no concern of environmental variables such as humidity and airflow posing a threat

to the sensor's overall accuracy. Ultimately, the TMP102's combination of power efficiency, rapid response time, and reliable performance makes it the ideal choice for the smart vent system

3.2.7 Summary Table of Sensor Specifications

Below is a table summarizing important specifications of each sensor.

Feature	LM35	TMP36	TMP102	SHT30
Accuracy	±0.5°C	±1°C to ±2°C	±0.5°C	±0.1°C
Temperature Range	-55°C to 150°C/-67°F to 302°F or	-40°C to 125°C/-40°F to 257°F	-40°C to 125°C/-40°F to 257°F	-40°C to 160°C/-40°F to 302°F Or -40°C to 125°C/-40°F to 257°F
Operating Voltage	4V to 30V	2.7V to 5.5V	1.4V to 3.6V	2.15V to 5.5V
Time Constant (Response Time)	20-30 seconds (still air)	<50 seconds (still air)	0.8 seconds	2 seconds

Table 4: Sensor Specifications Summary

3.2.8 Types of CO2 Sensors

Generally, there is less variety of CO2 sensors than temperature sensors. Unlike temperature sensors, which have a wide variety of types and are used in many different industries and applications, CO2 sensors are more specialized, focusing mainly on gas detection needs. This specialization results in fewer types of CO2 sensors overall because the applications are narrower, targeting specific industries like HVAC, environmental monitoring, and industrial safety. Moreover, CO2 sensors generally consume significantly more current than temperature sensors and are more expensive. Below are the most common CO2 sensors used:

Infrared (NDIR) Sensors: Infrared (NDIR) sensors measure amounts of wavelengths such as infrared light that is absorbed by CO₂ molecules in the air [6]. It operates by allowing air to flow into the sensor chamber. The sensor emits infrared light at a wavelength specific to CO₂, typically around four microns. On the opposite end, a detector measures the amount of infrared light that passes through the air sample. If carbon dioxide is present, it absorbs a portion of the light, reducing the amount that reaches the detector. The level of absorption is directly related to the concentration of CO₂ in the air—the more CO₂, the more light is absorbed [16]. NDIR sensors offer several advantages such as high accuracy, typically in the range of ± 50 ppm or better, moderate to fast response times, and minimal maintenance requirements. However, NDIR sensors are typically more expensive than other CO₂ sensors.

Electrochemical Sensors: Electrochemical sensors detect CO₂ by measuring changes in voltage or current using electrodes to determine how much CO₂ is in the air [17]. A chemical reaction occurs when CO₂ molecules interact with an electrolyte or electrode material inside the sensor, resulting in an electrical signal that relates to the concentration of CO₂. Electrochemical sensors exhibit numerous advantages, such as high sensitivity, compact form factor, and sufficient energy efficiency. They also generally exhibit adequate accuracy, ranging from ± 50 -100 ppm. However, one drawback that electrochemical sensors have is that they have a slower response time compared to other sensors. This is due to its reliance on the chemical reaction between the gasses and electrodes as well as additional signal processing conversions.

Metal Oxide Semiconductor Sensors (MOS): Metal Oxide Semiconductor (MOS) don't directly measure CO₂, rather they use the resistivity of metal compounds to estimate the concentration of CO₂ in the air. Compounds such as SnO₂ (tin oxide) and WO₃ (tungsten trioxide) are used as the sensing material to detect gasses [17]. When CO₂ or other gasses come into contact with the metal oxide surface, chemical reactions occur that alter the sensor's electrical resistance. This change in resistance is measured and used to estimate the concentration of CO₂ in the air. Due to the way these sensors work, they offer benefits such as enhanced sensitivity, cost effectiveness, and fast response times. However, they are less accurate than other CO₂ sensors, falling within a range of around ± 100 -200 ppm. Furthermore, due to their cross sensitivity to other gasses, it may in some cases lead to inaccuracies in measuring CO₂ concentrations.

Photoacoustic Sensors: Photoacoustic CO₂ sensors operate by emitting modulated light into a chamber containing air. When the light is absorbed by CO₂ molecules, it causes them to heat up and expand, creating a pressure wave (sound wave) that is detected by a microphone. The strength of the sound wave

correlates to the concentration of CO₂. These sensors exhibit excellent accuracy, with a typical range spanning from ± 10 -20 ppm, and are stable, but they tend to be more expensive and consume more power, making them less ideal for cost-sensitive or low-power applications.

Sensor Type	Response Time	Accuracy	Advantages	Disadvantages
Infrared (NDIR)	Moderate to Fast	± 50 ppm	High accuracy, reliable	Larger size, higher cost
Electrochemical	Slow	± 50 -100 ppm	High sensitivity, compact, energy efficient	Slower response time due to chemical reactions
MOS	Fast	± 100 -200 ppm	Fast response time, cost-effective, sensitive	Sensitivity to other gasses may lead to inaccuracies
Photoacoustic	Moderate	± 10 -20 ppm	Highly accurate, stable	High cost, higher power consumption

Table 5: Carbon Dioxide Sensor Type Comparisons

3.2.9 CO₂ sensor type selection

Upon further analysis, it has been decided that NDIR sensors will be the best fit for the smart vent system. They provide the ideal balance of accuracy and reliability, making them suitable for long-term use. While electrochemical sensors offer compactness and sensitivity, their slower response time makes them less optimal for this application. Similarly, metal oxide semiconductor (MOS) sensors may offer fast response times and cost-effectiveness, but their cross-sensitivity to other gasses could result in measurement inaccuracies. Given the smart vent system's need for accurate, real time CO₂ monitoring, NDIR sensors, such as the MH-Z19B or SenseAir S8, offer the most appropriate solution.

3.2.10 CO2 Sensor Options

Outlined below are various CO₂ sensors that were considered for the smart vent system:

MH-Z19B: The MH-Z19B is a commonly used NDIR CO₂ sensor that provides many advantages. It offers sufficient accuracy of ± 50 ppm and has a range spanning from 0 to 5000 ppm, aligning with the specifications of the smart vent system. It also allows easy integration with the STM32, as it communicates using UART and Pulse Width Modulation (PWM). However, a downside is that it has a relatively slow response time, that being of 120 seconds to reach 90%, of the final reading, which may limit its effectiveness in an environment where rapid CO₂ level changes can occur [18].

SEN0159: The SEN0159, which uses the MG-811 sensor, is another NDIR CO₂ sensor being considered for the smart vent. It features a high sensitivity to CO₂ while exhibiting less sensitivity to alcohol and Carbon Monoxide, which ensures both reliability and minimal interference. It also features an onboard heating circuit optimized for sensor performance and includes a built-in conditioning circuit for signal amplification. With a measurement range extending from 0 to 10,000 ppm, it surpasses the MH-Z19B in terms of range. It boasts an impressive response time of 20 seconds, significantly faster than both the SenseAir S8 and the MH-Z19B. The accuracy is consistent with the MH-Z19B, but its broader range makes it better suited for environments with higher CO₂ concentrations. Overall, the SEN0159's faster response time and broader ppm range make it a strong contender in scenarios where quick detection and a wider range are necessary [19].

SenseAir S8: Another sensor we considered was the SenseAir S8. It is an NDIR CO₂ sensor with a measurement range spanning from 0 to 20000 ppm, which is higher than both the MH-Z19B and the SEN0159. The response time is around 30 seconds, which is faster than the MH-Z19B but slower than the SEN0159. It communicates using UART, making integration with the STM32 straightforward. The SenseAir S8's accuracy of $\pm 0.02\%$ volume CO₂ $\pm 3\%$ of reading can be a downside, especially in low CO₂ environments, where the fixed error of ± 200 ppm may result in significant deviations from the true value. Additionally, at higher concentrations, the combined error can exceed ± 350 ppm, potentially affecting the smart vent system. Overall, the SenseAir S8 provides an ease of integration, though its slower response time and possible inaccuracy problems are limiting factors compared to the SEN0159 [20].

SCD41: The SCD41 is an advanced NDIR CO₂ sensor designed for high accuracy and compact applications. It provides a measurement range of 0 to

40,000 ppm, significantly surpassing the other sensors, which makes it suitable for environments with extreme CO₂ levels. In terms of accuracy, it offers an impressive precision of $\pm(40 \text{ ppm} + 5\% \text{ of reading})$, making it one of the most accurate sensors in its category. It also has a response time of 60 seconds, faster than the MH-Z19B but slightly slower than the SEN0159. The combination of high accuracy and a wide ppm range makes the SCD41 a great choice for demanding applications, although its higher price point could be a limitation for budget-conscious projects [21].

3.2.11 Final Selection and Justification

The SCD41 has been chosen for the smart vent system due to its exceptional performance in critical areas such as accuracy, measurement range, and reliability. With a measurement range of 0 to 40,000 ppm, the SCD41 is uniquely capable of handling a wider spectrum of CO₂ concentrations compared to other sensors, making it ideal for diverse environments, including those with potentially high CO₂ levels.

In terms of accuracy, the SCD41 provides a precision of $\pm(40 \text{ ppm} + 5\% \text{ of reading})$, ensuring reliable measurements that are crucial for effective air quality management. This level of accuracy enhances the system's ability to respond to varying CO₂ levels promptly, improving overall performance and effectiveness.

Moreover, the SCD41 boasts a response time of 60 seconds, which allows for timely adjustments based on real-time CO₂ measurements.

While the SCD41's price point is higher than some alternatives, its combination of high accuracy and extensive range justifies the investment. The capabilities of the SCD41 make it a robust choice for applications that demand precision and reliability in monitoring CO₂ levels, ensuring that the smart vent system operates effectively in maintaining optimal air quality.

	MH-Z19B	SenseAir S8	SCD41	SEN0159
Accuracy	$\pm 50\text{ppm}$	$\pm 0.02\%$ volume CO ₂ $\pm 3\%$ of reading	$\pm 40 \text{ ppm}$	$\pm 50 \text{ ppm}$
PPM range	0 to 5000 ppm	0 to 20,000 ppm	0 ppm to 40,000 ppm	0 to 10,000 ppm

Response Time	$T_{90} < 120 \text{ s}$	Varies, typically very fast (ms)	60 seconds to reach 63%	< 3 minutes for 90% step change
Cost	\$29-\$38	\$46-\$59	\$37	\$49

Table 6: Carbon Dioxide Sensor Comparison

3.3 LCD Screen selection

3.3.1 Introduction

The LCD screen plays an important role in the smart vent system by serving numerous essential functions. It will display environmental data gathered from the sensors, providing users with real time information. Additionally, the LCD screen will also act as the control mechanism for the vent system, allowing users to manually adjust the vent cover if deserted. Lastly, the LCD screen will also display warnings when hazardous levels of either CO₂ or temperature are detected, making sure the smart vent system warns users of potentially dangerous environmental conditions.

3.3.2 Selection Criteria

When selecting an LCD screen, several criteria must be considered to ensure optimal performance and usability. Like other elements of BREATHE, such as the MCU and sensors, low power consumption is a crucial factor for the LCD. Given that the LCD screen will likely be used for extended periods, it is important to choose a power-efficient display. A display that consumes minimal power will extend the overall battery life of the system, making it ideal for long-term operation in various environments.

Moreover, it is essential for the LCD screen to integrate seamlessly with the STM32 microcontroller. This integration involves compatibility with communication protocols, such as SPI or I²C, allowing for efficient data transfer and control. An LCD that can easily interface with the STM32 will not only streamline development, but also enhance system performance. This can include the availability of graphic libraries that facilitate quick implementation and configuration.

Another important criterion is touchscreen capability. A touchscreen LCD provides an intuitive user interface, allowing users to navigate through the system efficiently. The interactivity of a touchscreen can lead to a friendly user experience, making it easier to access various features and environmental data.

Lastly, form factor is another critical element. It is essential to find a balance between visibility and compactness. The LCD should be large enough to ensure that information is easily readable, yet not so large that it obstructs other components or hinders overall functionality. A well-designed form factor enhances user interaction while maintaining an efficient use of space.

3.3.3 Types of Touch Screen LCDs

There are numerous types of touch screen each with its own technology and applications. Each type of touchscreen has its own unique advantages and limitations, which makes choosing a desirable type essential for the smart vent system.

Resistive Touchscreen: Resistive touch screens are one of the most common types of touch screen LCDs, with applications found in medical and military settings [22]. Likewise, they typically can be used with a pointing device, such as a stylus. They utilize changes in resistance caused by pressure applied to the screen for accurate touch positioning [22]. They are designed with multiple layers, including a top flexible layer and bottom rigid layer, each coated with conductive material. When pressure is applied, the layers make contact, allowing the system to measure resistance changes and determine the touch coordinates. Resistive touchscreens can be further divided into two distinct types:

- *Four-Wire Resistive Touch Screen:* This design uses four distinct wires to measure touch coordinates. It features a top and bottom conductive layers of resistive film [22], each layer connected with two wires. These layers are separated by spacers, and when the screen is touched, they make contact at the touch point, allowing the system to detect the X and Y coordinates by measuring voltage changes across the four wires.
- *Five-Wire Resistive Touch Screen:* This design has a very similar structure to the four-wire type, however it uses an inner and outer conductive layer with a fifth wire connected to it. Similar to the four-wire type but includes an additional wire for improved accuracy and durability. When touched, the conductive layer on the glass panel makes contact with the sensing layer, creating a change in resistance near the touch point. This variation is measured by the circuit to calculate the exact touch coordinates [22].

Resistive Touchscreens have advantageous characteristics, with one being their durability. They have a strong resistance to dust, oil, and moisture. A second advantage is high accuracy. This is highlighted in the five-wire type, as its fifth wire helps measure resistance values more accurately and provides more precise touch position detection [22]. Lastly, it requires low touch pressure, making it highly accessible and convenient for users. However, a disadvantage can be found in the four-wire configuration, which is its susceptibility to wear. The top conductive layer can develop cracks over time due to frequent use, leading to inaccuracies. This issue can be mitigated by opting for the more durable five-wire version.

Below is a table comparing the two types of resistive touch screens.

Type	Description	Advantages	Disadvantages
Four-Wire Resistive	Uses four distinct wires connected to conductive layers to detect touch	Cost-effective and simple design	Prone to wear and reduced accuracy over time due to frequent use
Five-Wire Resistive	Includes an additional fifth wire for improved measurement accuracy and durability.	More precise, longer-lasting than the four-wire type.	More expensive compared to the four-wire version.

Table 7: LCD Resistive Touch Screen Type Comparisons

Capacitive Touchscreen: Capacitive touchscreens are undoubtedly the most common type of touchscreens used. They are utilized in a plethora of applications, such as today's smartphones, tablets, and laptops. Capacitive touchscreens consist of a glass panel coated with a conductive layer and an induction electrode. When untouched, the electric field formed by the induction electrode remains uniform. Touching the screen with a finger or stylus alters the field, adding capacitance at the touch point. The induction electrode detects this change, and the control circuit measures it to determine the touch coordinates [22]. Capacitive Touchscreens can be further categorized into four types:

- Surface Capacitive Touch: This type consists of a single ITO conductive layer on a glass panel with a protective coating. Four electrodes are connected to the corners. Touching the screen allows charge to ground through the user's body, which enables the controller to determine the touch position. However, it only supports single-touch detection.

- Projection Capacitive Touchscreen: The self-capacitive design includes two ITO conductive layers, with a control circuit applying driving signals to small coils. When touched, the screen senses changes in the electric field and determines the touch position. However, it lacks the multi-touch capability of projection capacitive screens.
- Self-Capacitance Type: The self-capacitive design includes two ITO conductive layers, with a control circuit applying driving signals to small coils. When touched, the screen senses changes in the electric field and determines the touch position. However, it lacks the multi-touch capability of projection capacitive screens.
- Mutual Capacitance Type: This type also has two ITO layers, but it excels in multi-touch accuracy and sensitivity. The control circuit detects changes in the electric field when touched, and the screen can differentiate between multiple touch points. Mutual capacitance has superior wiring simplicity, fast acquisition speed, low power consumption, and excellent anti-interference capability, making it ideal for interactive applications.

Given the variety of capacitive touch screens, each carries their own advantages and disadvantages. For instance, projection capacitive touch screens support multitouch, but are more complex and costly than surface capacitive touch screens. Likewise, mutual capacitance completely outperforms self-capacitance touch screens across a variety of metrics. They have more simple wiring, have fast acquisition speed, low power dissipation, have a higher signal stability, and support multitouch.

Furthermore, capacitive touch screens generally have several advantages over resistive touch screens. They are much more sensitive than resistive touch screens, responding effortlessly to light and gentle points of contact, making them easier and more intuitive to use. Additionally, they have a longer service life, as they don't rely on physical pressure of a point of contact for operation. Moreover, a distinguishable advantage is that some capacitive touch screens can support multi-touch capabilities, which can allow for operations such as pinching and zooming. Lastly, mutual capacitance offers a great advantage, that being low power dissipation, which can be very beneficial to the smart vent system. The biggest disadvantage that capacitive touch screens have is that they are more expensive than resistive touch screens due to complex technology involved in their construction, such as multi-layered designs.

The following table presents a comparison of capacitive touch screens.

Type	Description	Advantages	Disadvantages
Surface Capacitive	Single ITO conductive layer with electrodes at the corners of a glass panel	Durable and reliable for basic touch applications	Limited to single-touch detection
Projection Capacitive	Dual ITO layers that support multi-touch and high sensitivity	Multi-touch capability, fast response time	Higher cost and complexity
Self-Capacitance	Two ITO layers, detects touch by sensing electric field changes	Simple wiring and fast touch detection	Lacks multi-touch capabilities
Mutual Capacitance	Excels in detecting multiple touch points accurately with two ITO layers.	Supports multi-touch, high signal stability, low power consumption, fast response	More expensive due to advanced technology

Table 8: LCD Touch Screen Type Comparisons

Acoustic Wave Touch screens: Acoustic wave touch screens are another specialized type of touch interface, with more niche applications compared to capacitive and resistive screens. These screens are commonly used in environments such as ATMs, information kiosks, and touch-screen arcade machines [23]. Acoustic wave touch screens are classified into different types:

- Surface Acoustic Wave (SAW) Touch Screens: The most common variation of this particular type are surface acoustic wave (SAW) touch screens. They use ultrasonic transmitters and receivers to calculate x and y coordinates. When touched, the screen disrupts acoustic waves, allowing a point of contact to be detected. As per their application, they are excellent for large sized screens with persistent durability, however they are susceptible to contaminants and random unintended touches.
- Bending Wave Scheme: Another variation includes the bending wave scheme, which detects sound waves generated by tapping the touch

screen. This is further categorized into two approaches, acoustic pulse recognition (APR) and dispersive signal technology (DST).

- Acoustic Pulse Recognition (APR): APR touch screens use piezoelectric transducers to detect touch positions based on stored wave data. While effective, APR requires an extensive prior process to store bending wave data across the screen. This approach is prone to errors in touch location estimation, supports only single-touch input, and depends on sufficient tapping strength [23].
- Dispersive Signal Technology (DST): DST processes measured bending wave data without pre-stored information, but suffers from similar limitations, including single-touch support, high tapping strength, and computational demands [23]. Similar to APR touch screens, they can only detect single touch inputs.

There are numerous advantages and drawbacks of acoustic wave touch screens. As mentioned earlier, they are highly durable, allowing for a long lifespan and resistance to wear. Moreover, they possess higher sensitivity than resistive touch screens, as they depend on acoustic wave disruption, rather than physical pressure. Lastly, they can also detect some non conductive materials, such as microfibers or wool. However, unlike resistive touch screens, they are more susceptible to contaminants, such as dirt or moisture. Additionally, they are also prone to errors in touch detection, such as false touches or unresponsiveness, as a result of variance in data processing. Specific to the DST configuration, they require significant processing power to process bending wave data, which can in turn lead to more power consumption.

A table comparing the two types of acoustic wave touch screens is shown below.

Type	Description	Advantages	Disadvantages
Surface Acoustic Wave (SAW)	Uses ultrasonic transmitters and receivers to detect touch through wave disruption	Ideal for large screens, durable, good sensitivity	Susceptible to contaminants such as dirt and moisture
Bending Wave Scheme	Detects sound waves generated	Durable with a unique detection	Requires high tapping strength,

(APR/DST)	by touch and processes wave data	method	supports only single-touch, computationally demanding
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Table 9: Acoustic WaveLCD Touch Screen Type Comparisons

Optical Touch Screens: Another type of touch screens are optical touch screens. They have similar applications to acoustic touch screens, such as arcade machines, kiosks, and aviation [24]. They work by placing IR transmitters and receivers on opposite sides of the screen. When a touch blocks the IR light path, the x and y coordinates are calculated by detecting which receivers don't receive the signal. However, this design requires a raised bezel for the IR components, and multiple touches can result in ghost touches. There are two primary types of optical touch screens:

- **Planar Scatter Detection (PSD):** This method sends IR light through a waveguide under total internal reflection (TIR). When touched, the TIR is interrupted, and scattered light is detected to determine the touch location. PSD supports multi-touch and offers high image clarity but requires significant computational power for large displays.
- **Frustrated Total Internal Reflection (FTIR):** FTIR also uses TIR, but the touch location is determined by the IR light that escapes toward the opposite side of the touch. This light is captured by cameras or vision sensors, which generate images to identify the touch points.

Benefits of optical touch screens include their ability to support multiple touch points, their compatibility with large displays, and excellent visual clarity due to the absence of additional layers that can obstruct the view. However, disadvantages include the need for a raised bezel to accommodate IR transmitters and receivers. They are also prone to ghost touches, where unintended inputs may be registered due to multiple simultaneous touches. Moreover, the extraction of touch locations for larger screens requires significant computational power, increasing the overall system demand.

Displayed below is a table that compares the two types of optical touch screens.

Type	Description	Advantages	Disadvantages
Planar Scatter Detection (PSD)	IR light is sent through a waveguide and interrupted by touch,	Supports multi-touch, high image	Requires significant computational

	scattering light to determine location	clarity	power for large displays
Frustrated Total Internal Reflection (FTIR)	Detects touch by capturing IR light that escapes during touch using cameras or vision sensors	Multi-touch support, excellent visual clarity	Complex setup, higher computational demands

Table 10: Optical LCD Touch Screen Type Comparisons

3.3.4 LCD type selection

After further analysis, the best suited options were undoubtedly either resistive touch screens or capacitive touch screens. Capacitive touch screens are advantageous due to their high sensitivity and ability to support multi-touch interactions, allowing for a friendly and seamless user experience. Their long lifespan and durability make them suitable for environments where the system will be in frequent use. However, the higher cost of capacitive screens compared to resistive options is a consideration. On the other hand, resistive touch screens offer durability and accuracy at a lower price point, making them a viable alternative. Although acoustic wave touch screens and optical touch screens have their benefits, they simply aren't suitable for the smart vent system. One major drawback is their typically large size, which is unnecessary for this application. A more compact interface would be sufficient to display essential environmental data and controls. Moreover, it would be difficult to even interface one with an STM32, as they require additional hardware. Acoustic wave touch

screens would require a specialized controller, and optical touch screens would require hardware such as IR transmitters, receivers and cameras. Lastly, these hardware would consume large amounts of power, making the overall vent system inefficient. Conclusively, acoustic wave and optical touch screens are not only practically unsuitable for the smart vent system, but also introduces additional overhead and complexity. Conversely, resistive and capacitive touch screens present the most effective solutions for the smart vent system, balancing performance, cost, and ease of integration while ensuring a user-friendly interface.

3.3.5 LCD Options

DFR0669 3.5" IPS Capacitive Touchscreen Display: The DFR0669 3.5" IPS capacitive touchscreen display is a considered option for a LCD touchscreen. This module has a resolution of 480x320, utilizes the ILI9488 driver IC, and uses

SPI for communication. An advantage that the DFR0669 has is that it uses the GT911 chip instead of a I2C connection, which allows the screen to handle multiple points of contact effectively. Moreover, it offers a reasonable resolution and size which can be particularly advantageous for displaying user-friendly interfaces. It offers an operating voltage between 3.3 to 5V [25].

2.8" Capacitive TFT Touch Shield: The 2.8 Capacitive TFT Touch Shield is another capacitive display that is being considered for BREATHE. Due to its smaller form factor, it has a smaller resolution than the DFR0669, being at 240x320 [26]. Likewise, it uses an ILI9341 driver, similar to the WaveShare 3.2" LCD screen. Moreover, its FT6206 capacitive touch screen driver, which communicates through SPI, provides a multitude of advantages such as self-capacitive sensing, auto calibration, and an integrated MCU [27]. Similarly to the 3.2" WaveShare LCD screen, it offers 262K colors and has an operating voltage of 3.3V [26].

WaveShare 4" Resistive Touch LCD: The WaveShare 4" Resistive Touch LCD is one of the resistive touch screens that will be considered for BREATHE. It has a resolution of 480x800, being higher than both the MSP4020 and DFR0669 displays. Moreover, it utilizes the NT35510 driver [28], which offers several advantages, such as support for 16.7 million colors to achieve high color depth, integrated frame memory, and individual gamma correction. It also includes a tearing effect control system that allows for synchronization between the MCU and the LCD screen in order to mitigate against display artifacts [29]. Furthermore, the WaveShare 4" LCD's touchscreen functionality is managed by the XPT2046 resistive touch controller, which uses SPI for communication and enables precise touch input detection with pressure sensitivity. It also operates at a 3.3V to 5V voltage level, which allows for an ease of integration with the STM32 microcontroller.

WaveShare 3.2" Resistive Touch Screen: WaveShare also offers a 3.2" Resistive Touch LCD screen. It has a resolution of 320x240 and uses a ILI9341 driver [30], which supports 262K colors instead of the 16.7 million offered by the NT35510 in the 4" model, providing sufficient color depth for simpler graphic needs. The ILI9341 also has a more basic configuration of tearing effect control compared to the NT35510 as a result of its lower resolution [31]. However, like the NT35510 driver, it also supports on-chip RAM and gamma correction, both allowing for a smooth graphical display. Like the 4", The WaveShare 3.2" LCD screen also uses the XPT2046 touch screen control, using the SPI communication protocol as mentioned earlier. Lastly, this LCD display also operates at 3.3V, allowing for easy interfacing with the STM32.

3.3.6 Final Selection and Justification

After further consideration, it has been concluded that the WaveShare 4" Resistive Touch Screen LCD was the best option for BREATHE. A large factor that justified this LCD screen over its counterparts was its form factor, as it provided a sufficient balance between display area and compactness, allowing information to be clearly displayed without overwhelming the physical design of the LCD and sensor system. Moreover, the screen provided the largest resolution and highest graphical fidelity of all the LCD screens considered, allowing for vibrant visuals that will contribute to a user-friendly interface. In comparison, the smaller 2.8" capacitive and 3.2" resistive options offered lower resolutions (240x320 and 320x240, respectively) and fewer colors, making them less ideal for detailed data visualization. Additionally, the advanced NT35510 driver in the WaveShare 4" model supports superior tearing effect control, which minimizes visual artifacts during updates and further enhances the clarity and readability of displayed information. Furthermore, the XPT2046 resistive touch controller allows for precise, pressure-sensitive input, and a flexible 3.3V to 5V operating voltage allows for compatibility with the STM32. Conclusively, the WaveShare 4" LCD was found to be the most substantial and versatile display choice for BREATHE.

Feature	DFR0669 3.5" Touch Screen	2.8" TFT Touch Shield	WaveShare 4" LCD Screen	WaveShare 3.2" LCD Screen
Touch Type	Capacitive	Capacitive	Resistive	Resistive
Resolution	480x320	240x320	480x800	320x240
Color Depth	262k Colors	262k Colors	16.7 million colors	262k Colors
Communication Protocol	SPI	SPI	SPI	SPI
Operating Voltage	3.3V to 5V	3.3V	3.3V to 5V	3.3V
Display Driver IC	ILI9488	ILI9341	NT35510	ILI9341

Table 11: Touchscreen LCD Comparison

3.4 Buzzer Selection

3.4.1 Introduction

As mentioned before, BREATHE will require a buzzer to alert the user when dangerous levels of CO₂ or temperature are detected. When the temperature or CO₂ sensors exceed a predefined safety threshold, the MCU will immediately signal the buzzer to emit an audible alarm, alerting the user of any potential danger. Once CO₂ or temperature levels stabilize, the buzzer will turn off, allowing the system to resume normal operations.

3.4.2 Selection Criteria

When selecting a buzzer it is important to select one that will be audible enough for the user to hear. It must produce a sound loud enough to be heard clearly in various indoor settings, even in cases where there may be background noise such as HVAC systems or household activities. Moreover, the selected buzzer should be compact enough to fit within the system, without adding unnecessary bulk to the design.

3.4.3 Types of buzzers

Buzzers are essential components when producing an audible alert is necessary. It's applied in many systems such as alarm systems, appliances, and doorbells. While there are numerous models of buzzers available, the range of buzzer types are quite limited, leading to fewer considerations being made when selecting an actual type of buzzer. Nonetheless, it's important to consider the advantages and disadvantages of these buzzers to determine the most viable option.

Piezoelectric Buzzers: One of the most common variations of buzzers are piezoelectric buzzers, which use the piezoelectric effect to generate sound. These buzzers are known for their high efficiency and low power consumption, making them ideal for battery-operated devices like the BREATHE system. Piezoelectric buzzers exhibit numerous advantages, such as a long lifespan that can reach upwards of 10,000 hours [32]. Additionally, they produce zero interference since they do not generate RF noise, which ensures that they won't disrupt other circuits. A desirable trait that piezoelectric buzzers have is that they have low power consumption, as they typically draw less than 20mA of current, and they rarely exceed 100mA [32]. However, a notable downside is that they can be susceptible to hazardous temperatures or changes in humidity [33]. Extreme temperatures or high humidity levels can affect the piezoelectric material's properties, which can lead to inefficiencies.

Magnetic Buzzers: Along with piezo buzzers, magnetic buzzers are the other most common type of buzzer [34]. Magnetic buzzers function by passing an electrical current through a coil of wire to create a magnetic field. This current attracts a flexible ferromagnetic disk, generating sound as the disk oscillates similarly to a speaker cone. As current fluctuates, the disk moves back and forth, producing audible alerts. These buzzers are current-driven devices that require a voltage source, with the current flow determined by the applied voltage and the coil's impedance. Magnetic Buzzers offer numerous benefits similar to piezoelectric buzzers, such as a long service life, compactness, and cost effectiveness [35]. However, they are less energy efficient than piezoelectric buzzers, and can consume upwards of 100mA or even more. Likewise, due to the moving parts such as the vibrating diaphragm in magnetic buzzers, they are generally more prone to wear and tear than their piezoelectric buzzers counterparts. This translates to a shorter operational lifespan [36].

	Piezoelectric	Magnetic
Power Efficiency	Higher	Lower
Vulnerable to damage from environment (Extreme Temperature and Humidity)	Possible	Possible
Operational Lifespan	Higher	Lower due to potential wear and tear

Table 12: Buzzer Type Comparisons

3.4.4 Buzzer Type Selection

Due to the limited kinds of buzzers, both magnetic buzzers and piezoelectric buzzers will be taken into consideration. As discussed, both provide valuable advantages as well as various disadvantages in relation to BREATHE's specific requirements. Given the project's focus on energy efficiency and long-term reliability, piezoelectric buzzers may be a more viable option. However, if a higher sound output is needed, then magnetic buzzers could be preferred, despite their higher current consumption. Ultimately, the decision will be concluded based on balancing the tradeoffs between both buzzers in order to ensure both optimal system performance and adherence to BREATHE's constraints.

3.4.5 Buzzer Options

PS1240: The PS1240 is a buzzer developed by [37] that has a compact form factor, measuring at just 12.2x6.5mm [37]. Moreover, it has a sound pressure level of 70dB and a frequency of 4kHz [37]. Although this level is outperformed by other magnetic buzzers, it is still an acceptable level that is adequate enough in indoor environments. Its wide operating voltage range of 3V to 30V [37] also allows for an easy integration with the STM32, as it operates at 3.3V. Another substantial advantage is that it is very affordable, typically priced around \$0.50 to \$0.60 [32], which aligns very well with BREATHE's budget constraints. However, besides its lower sound output to magnetic buzzers, possible disadvantages include its susceptibility to environmental factors such as high humidity or temperature levels, which can impact both the sound quality and operability of the buzzer. Despite this, the PS1240 serves as a practical choice for BREATHE for its acceptable sound output, voltage range, and affordability.

CMI 1295: Another piezoelectric buzzer that will be considered is the CMI 1295. It has a similar form factor, measuring at a dimension of 12 x 9.5 mm [38]. Likewise, its sound level outperforms the PS1240, offering a sound pressure level of 85 dBm. This may be more effective in scenarios where a user is not present in the room where the sensor system is located or if loud background noise is a concern. It also is very affordable, pricing at about \$1.21. However, the CMI operates at a much higher operating range, being at 8V [38]. This would require an additional DC-DC step down converter, whereas the PS1240 simply needs a connection with the STM32. Moreover, the CMI 1295 uses much more current than the PS1240, consuming about 30mA at 8V [39]. Lastly, like other piezoelectric buzzers, it is also susceptible to environmental factors like temperature and humidity. That said, the CMI 1295 is a strong alternative for applications where louder output takes precedence over power efficiency and ease of integration.

Jameco 5V Magnetic Buzzer: The Jameco 5V magnetic buzzer is a magnetic buzzer that will be taken into consideration. It has a similar size to both the PS1240 and CMI 1295, sizing at 12x7.5mm [40]. Moreover, it has an operating voltage range from 3 - 7V, which like the PS1240, will facilitate an easy integration with the STM32. It has a frequency of 3.31KHz $\pm$ 300Hz and also offers a very audible output sound, that being at 83dB [40]. The Jameco 5V Buzzer is also very affordable being priced at \$0.59, falling into a similar price range with the PS1240 [40]. However, it has the same power consumption as the CMI1295, that being at 30mA [40]. Likewise, since it is a magnetic buzzer, it may potentially have a shorter life span than the piezoelectric buzzers

mentioned, however this problem may not be detrimental as the buzzer will only be used in emergency situations. Conclusively, the Jameco 5V magnetic buzzer offers advantages that both the CMI1295 and PS1240 have such as an ease in integration as well as audible output sound, however it falls short in power consumption.

3.4.6 Final Selection and Justification

We decided that the PS1240 would be the most suitable option for BREATHE for a number of reasons. Although all three buzzers share traits such as affordability and compact form factor, the PS1240 appeared to have the least drawbacks.

One advantage is that its sound output to current consumption ratio is the best out of the three buzzers. Despite being slightly quieter than the Jameco 5V magnetic buzzer and the CMI 1295, it is still acceptable within the context of the project. Additionally, it draws the least amount of current, further facilitating a power-efficient system. Lastly, its voltage range allows for an easy implementation with the STM32 and other peripherals on the control unit with only one voltage rail.

	PS1240	CMI 1295	Jameco 5V Magnetic Buzzer
Dimensions	12.2 x 6.5mm	12 x 9.5 mm	12 x 7.5 mm
Operating Voltage	3V	8V	3V
Current Consumption	~5mA	30mA	30mA
Sound Pressure Level	70 dB	85 dB	83 dB
Frequency	4 kHz	3.6 kHz	3.31KHz $\pm$ 300Hz

Table 13: Buzzer Comparison

3.5 Motor Selection

3.5.1 Motor Type Comparisons

	AC Motors	Brushless DC Motor	Brushed DC Motor	Servo Motor	Stepper Motor
Torque Output	High	Medium	Low	High	Low
Speed Output	Very High	High	High	Moderate	High
Power Consumption	Very high	Moderate - High	Moderate - High	Moderate - High	Moderate - High
Heat Generation	High	Low	High	Low	Low
Energy Efficiency	Good	Good	Bad	Good	Good
Built-in Motor Controller	No	No	No	Yes	No

Table 14: Motor Type Comparisons

When selecting a motor it's very important to take into account the specifications for the project. In order for BREATHE to be able to open or close its louvers while also maintaining an efficient, persisting battery life, it's important for the selected motor to be capable of supplying the necessary amount of torque while also fitting size requirements and utilizing an average power consumption that is as low as possible. It is possible to utilize mechanical designs in conjunction with our electrical parts to improve characteristics of the vent, such as speed and size, to help the project align with the specifications.

AC motors generally have a higher speed and torque output at the cost of an exhaustive power consumption [41]. This could be practical if we have time to pursue our stretch goal of implementing a device capable of acting as both a wind turbine and an emergency fan capable of blowing a high amount of air into a room full of CO₂. This is because we would be able to blow a generous amount of clean air into the room without having to worry too much about the power consumption. The benefits of an AC motor would not be necessary for adjusting the louvers, and the power consumption would make the choice cause more harm than good.

Comparing a brushless DC motor with a brushed DC motor gives benefits and drawbacks on both sides, however a brushless DC motor would fit our specifications better. Generally, brushed DC motors are cheap and provide the same functionality at the cost of a weaker lifespan, louder sound. Due to the design of the brushes, these motors generate more heat and require more power due to internal friction [42]. The power consumption contradicts our energy efficiency specification, and so for our project it would be best to avoid these motors. A brushless DC motor, on the other hand, generally costs more but provides a longer lifespan and better energy efficiency, making it a better choice if we decide to use a DC motor [42].

Servo motors offer a high torque and a small size, which fit our specifications. It functions by taking a PWM signal and adjusts its angle accordingly. This would make coding the functionality very straight forward; the basic goal of completely opening and closing the louvers and the stretch goal of opening to a desired angle would have minimal changes. The project will rely on the servo's high torque to move the louvers, and will also require a mechanical design that is capable of opening and closing the louvers through the servo's range of motion. There are also existing 360 degree servo motors which can provide continuous movement and adjust speed according to the PWM signal [43]. These motors tend to have a slower rotational speed but higher torque, which can be beneficial for opening and closing the vent's louvers.

Stepper motors utilize a magnetic force that can be manually controlled against multiple coils to create motion. These motors can output a different range of torque and speed, each having an inverse effect on the other. In other words, if we wanted to achieve a high torque then we would be sacrificing speed, and vice versa [44]. BREATHE's specifications show that a high torque is more important than speed, however we will still need to be fast enough to open and close the vent within the specified amount of time.

When comparing stepper motors and servo motors, both have their own applications and associated advantages and disadvantages in terms of power consumption. If there is no torque required for holding a specific position then stepper motors are more power efficient. On the other hand, if a lot of torque is required for holding a position then servo motors will consume less power [45]. Ultimately it'll depend on the amount of force generated from the AC's wind. Since most available vents do not have additional mechanisms to ensure louver angles are held, it's likely that the air pressure will be enough to move the vent by itself and so additional support from the motors wouldn't be necessary to hold desired angles. Taking this into account a servo motor will likely be able to

provide us the best amount of torque while reducing the amount of total power consumption.

3.5.2 Servo Motors Comparisons

	SG92	HS-5645MG	MG996R
Torque Output	0.245 Newton-Meters	1.01 Newton-Meters	0.92 Newton-Meters
Voltage Rating	4.8V - 6V	4.8V - 6V	4.8V - 6V
Current Rating	100mA - 300mA	350mA - 450mA	170mA - 900mA
Stall Current (at 4.8V)	600mA	2.4A	1.3A
Lowest Power Consumption	0.48 W	1.68W	0.816W
Dimensions	0.9055 x 0.4803 x 1.063 inches	1.59 x 0.77 x 1.48 inches	1.6024 x 0.7756 x 1.689 inches
Speed (s / 60 degrees)	0.1	0.23	0.2
Weight	9g	60g	55g
Price	~\$2-3	\$45.99	~\$4.75

Table 15: Comparison between servo motors

There are two types of servo motors: continuous movement and regular. Continuous movement servos function just like DC motors, but intake a PWM signal and adjust its speed accordingly. Regular servos tend to only open around 180 degrees. They also intake a PWM signal and adjust their angle according to the value [46]. It is also possible to make edits to a normal servo motor to enable 360 degree rotation [47]. Most vent designs can fully open and close through 180 degree rotation, so the servo's limited rotation would not be a problem. The following paragraphs will talk about a few different options for potential servo motors.

The SG92 is a small micro servo capable of 180 degree rotation. It only weighs 9g and the dimensions are 0.9055 x 0.4803 x 1.063 inches, making it friendly with the size constraints of many different mechanical designs. It rotates at a speed of 60 degrees every .1 seconds at an operating voltage range of 4.8V, making it friendly with the timing requirement of BREATHE. Although there isn't an official current rating on the datasheet, some sources indicate through experimentation that it consumes about 100-300mA on average and can use up to 600mA depending on the loading force. The main problem with this servo is that it can only supply a force of 0.245 Nm [48]. This has a chance of not being enough torque to open and close the vent. The motor will require experimentation with different vents and their associated friction, but it would provide a very flexible solution to mechanical constraints.

Another potential servo motor is the HS-5645MG. This motor is more on the expensive end, costing about \$46. This motor intakes a minimum of 4.8V and can provide torque of up to 1.01 Nm, which can help if our vent has a very high amount of friction. The motor uses on average 450mA, and can use up to 2.4A depending on the amount of force required. The motor can also move at a speed of 60 degrees every 0.23 seconds, making it well within our time constraints. The physical dimensions are 1.59 x 0.77 x 1.48 inches, making it a bit larger than the SG92. This means that it may not be as flexible for positioning and may require some mechanical tricks to translate the servo's force towards moving the vent's louvers. Aside from this, it weighs 60 grams which is heavier than the SG92 [49]. There is a chance that the weight may affect the vent's balance, but if the vent is bolted to a wall or ceiling then this would likely not cause a problem.

Another potential servo motor is the MG996R. This motor weighs 55 grams and has dimensions of about 1.6024 x 0.7756 x 1.689 inches, making it slightly bigger than the other two servo motors. This unit has an operating voltage between 4.8V and 6V, and can produce about 0.92Nm. The official datasheet mentions that it consumes anywhere from 500mA to 900mA, but this is off of 6V.

Other sources indicate through experimentation that it typically consumes about 170mA, and has a stall current of about 1.3A when operated at 4.8V [50]. This means that if the motor gets stuck then it may consume a great amount of power, but as long as our vent doesn't have much friction we shouldn't have to worry too much about power consumption.

When comparing these different motors it's shown that the MG996R would be the most reliable option. Although the other motors have a lot of benefits including flexibility with positioning and a great amount of torque, the MG996R offers a balance between power consumption and torque, which are two important aspects for meeting our specifications.

Servo motors don't necessarily need a motor controller since they're typically already embedded within. That being said, these motors can still intake current even when not operating. Although the power consumption is minimum, it can still affect our overall battery life if gone unnoticed. This problem can be solved if we utilize a switch controlled by the MCU that can enable and disable the connection between the servo motor and the power supply. That way the motor will not be pulling current from the battery when it is not in use, saving an accumulated amount of power overtime.

3.5.3 Encoders

3.5.3.1 Encoder Types

Encoders are devices that are able to detect rotational movement. This is useful because this will allow us to know the distance of the louver's movements and will tell us when to turn the motors on and off. Regular servo motors can already detect movements, but if we choose to make modifications to it and enable 360 degree rotations then we will need to use an encoder to keep track of positioning.

There are two types of encoders: incremental and absolute. Incremental encoders detect whenever there is a slight deviation in position and send a corresponding signal to an MCU. It is common for programs to keep track of a position integer, and increment or decrement the integer's value depending on the encoder's signals. Absolute encoders, on the other hand, can also detect the actual position of the rod in relation to its initial position. Any time there is movement it sends a signal to the MCU to indicate a change, and also sends the new position, usually through a binary of multiple pin values [51]. Both of these types of encoders would work for the project. When choosing an encoder, the deciding factor will be dependent on other variables such as size and power consumption.

3.5.3.2 Encoder Comparisons

	EC10E1220501	EAW0J-B24-AE0128L	92V1X00A
Number of pulses per revolution	12	128	24
Number of tracking positions	6	64	12
Dimensions	9mm x 17.1mm x 4.4mm	23.88mm x 27.94mm x 28.19mm	20mm x 21.45mm x 6.4mm
Voltage Rating	5V	10V	2.97V - 5.5V
Current Consumption	1mA	10mA	20mA - 30mA
Power Consumption	0.005W	0.1W	0.0594 - 0.165W
Lifespan	100,000 cycles	50,000 cycles	500,000 - 2,000,000 cycles
Price	\$0.90	\$11.83	\$15.23
Supplier	Digikey	Digikey	Digikey

Table 16: Comparison between motor encoders

The EC10E1220501 is a cheap encoder costing about \$1. This encoder operates at 5V and intakes about 1mA, making it have relatively low power consumption. It has an operating life of about 100,000 cycles, translating to about 200,000 full open / close operations. If the vent were to fully open and close 100 times a day, then that would translate to 36500 operations a year, giving us an operating duration of about 5.5 years. The encoder has about 12 pulses per revolution, which means it can only detect movement after 30

degrees [52]. Since we are only opening the vent 180 degrees, this can be very limiting as it can only indicate movement a total of 6 times throughout its movement.

$$360 \text{ degrees} / 12 \text{ pulses} = 1 \text{ pulse every } 30 \text{ degrees}$$

$$180 \text{ degrees} \times 1 \text{ pulse} / 30 \text{ degrees} = 180 / 30 = 6 \text{ pulses}$$

$$\text{Power consumption} = 1\text{mA} * 5\text{V} = 0.005 \text{ W}$$

The EAW0J-B24-AE0128L is an encoder costing about \$11. This is an absolute encoder that transmits both movement and position through a binary of eight different pins. For every pin, a high or low signal is transmitted to represent a 1 or 0. Combining the eight different pins gives a binary representation of the absolute position, which the MCU can then read and interpret. The encoder has 128 pulses per revolution, allowing it to be very accurate in detecting different positions. This encoder is significantly more power intensive, intaking 10mA of current at 10V. This translates to a 20 times increase over the EC10E1220501, which is a significant disadvantage due to power consumption being a very important specification. Although there can still be different techniques to save power such as disabling power when not using the encoder, this will still have a significant impact on BREATHE's battery life. The encoder also has a lifespan of at least 50,000 rotations, which makes it have half of the life expectancy of the EC10E1220501 [53].

$$360 \text{ degrees} / 128 \text{ pulses} = 1 \text{ pulse every } 2.8125 \text{ degrees}$$

$$180 \text{ degrees} \times 1 \text{ pulse} / 2.8125 \text{ degrees} = 180 / 2.8125 = 64 \text{ positions}$$

$$\text{Power consumption} = 10\text{mA} \times 10\text{V} = 0.1 \text{ W}$$

Another alternative is the 292V1X00A. This unit costs about \$15, and has an operating range from 3.3V to 5V. At 3.3V, the input current is 20mA, translating to a power consumption of about 0.08W according to the datasheet. This encoder is also incremental and has 24 pulses per revolution, which translates to about 12 pulses between opening and closing the vent. This allows for more possible positions when opening and closing the vent compared to the EC10E1220501, while also using slightly less power consumption compared to the EAW0J-B24-AE0128L. This encoder also has a lifespan from anywhere between 500,000 and 2 million rotations, making it anywhere from 5 to 20 times longer than the EC10E1220501 [54].

$$360 \text{ degrees} / 24 \text{ pulses} = 1 \text{ pulse every } 15 \text{ degrees}$$

$$180 \text{ degrees} \times 1 \text{ pulse} / 15 \text{ degrees} = 180 / 15 = 12 \text{ pulses}$$

When examining the possible encoders, the EC10E1220501 seems to be the best choice due to the cost effectiveness and the lower power consumption. It also has a higher lifespan than the EAW0J-B24-AE0128L despite being nearly 1/10th of the cost. It is also significantly smaller than the previous two options, making it more flexible for different mechanical designs.

3.6 Mechanical Systems

Due to the nature of this project, we will need to find ways to transfer the motor's rotational motion into the louver's rotating rod. The main issues involve size constraints and potential torque required to overcome the friction of the vent. If we put the motor on the side and there is not enough space to fit the vent into the wall or ceiling, then the product will not work as intended and we will therefore fail our specifications. There are a few systems that can be implemented to translate the motor's force into the desired location, while also potentially increasing the torque at the cost of speed if necessary.

3.6.1 Rack and Pinion

Rack and Pinion gears allow for a rotational gear to push a rod forward, essentially converting rotational motion into linear motion. This is commonly referred to as a linear actuator, which uses a motor such as a stepper motor and allows for the rod to deliver forward force. Looking at many vent designs, users are able to move a slider up or down to open / close the vent. This translates to rotating the louver rod, taking advantage of the prebuilt design to increase the input torque [55]. This way we will be able to save a great amount of battery life due to less overall power consumed overtime. This will be dependent on the chosen vent's frame, as it will need to be able to support a linear movement with a leveraged handle.



Figure 4: Rack and Pinion Gear [56]. (awaiting approval)

3.6.2 Chained Gears

Chains can also be utilized to connect two gears together. This implements the same logic as connecting two gears together, but without having to have contact with positioning directly next to each other. This also ensures that the two gears move in the same direction. If one gear has more teeth than the other, then this will implement a difference in gear ratio and therefore change the values of speed and torque. These two variables have an indirect relationship with each other; if one increases then the other decreases by the same factor and vice versa. If gear 2 has double the amount of teeth than gear 1, then we can say there is a gear ratio of 1:2. This means that the speed of gear 2 is half of gear 1, but gear 1 has doubled the amount of torque of gear 1. This design can be helpful if we need to implement more torque for the louvers and if we need to position the motor a distance away from the louver's rotational rod [55].



Figure 5: Picture of Chain [57]. (awaiting approval)

3.6.3 Bevel Gears

Bevel gears act similarly to other gears, but they also allow for rotational motion to be transferred in another axis direction. They have similar torque and speed conversions depending on the number of teeth. The gears allow for the redirection of force by being angled at 90 degrees. If we need to position the motor where the shaft cannot be aligned in the same plane as the louver's rotational rod, then this system will be a great way to allow flexibility for positioning the motor in other parts of the vent [55].



Figure 6: Bevel Gear [58]. (awaiting approval)

3.6.4 Worm Gears

Worm gears allow for motors to translate high amounts of speed into higher amounts of torque. It works by rotating a cylinder with thread against a bigger gear with a large amount of teeth. It's common for these devices to multiply an input torque by 30 times, and in some cases even greater than 300 times. The downside is that increasing the torque by a multiplied constant causes the speed to be divided by that same constant. In other words, if we multiply an input torque by 30 times then it will require 30 rotations for a single rotation. For some servo motors with lower RPM this can cause movement of the vent's louvers to take a really long time, which can cause the product to fail the timing specifications. For other motors that have a very high RPM but a very low torque rating, this can be a perfect implementation [55].



Figure 7: Worm Gear [59]. (awaiting approval)

3.7 Power selection

The power section of both the vent interaction subsystem and the control unit is extremely important to ensure all of our peripherals receive sufficient power that is within their respective manufacturer specifications. For the control unit, since it will likely be in close proximity to wall outlets, some type of AC-DC power adapter unit would be sufficient for powering it. Part of what led to this decision was the LCD's power consumption, which would likely drain any battery relatively quickly considering it needs to be on most of the time (it would be a little inconvenient if the user had to wake up the LCD each time just to see the temperature). To reduce unneeded complexity this was the best option for the control unit. For the vent interaction subsystem, however, due to its location it will be impossible to power it using anything but a battery. This makes it especially important to design a power system that will be efficient enough to ensure the battery lasts at least 6 months as previously specified.

Both systems will need some type of voltage regulation present to ensure all peripherals receive proper voltages. For the control unit, thankfully all devices can be powered from 3.3V, so only one voltage rail is needed to provide power to the whole unit. As for the vent interaction subsystem, the motor requires 5V whereas the STM32 has a max input voltage of 3.6V. This means there will need to be two separate voltage rails in the vent interaction subsystem. It is important to note that there are important things to consider besides just efficiency and current draw. The vent interaction subsystem will need to fit in a relatively compact space, so it is necessary to consider regulation schemes that have low footprints. Cost is also a factor to consider. Overall, whatever method is used to provide power to all the peripherals in the vent interaction subsystem in particular will need to be balanced between all these considerations.

3.7.1 Battery Types:

The most important decision to make regarding the vent interaction subsystem's power supply design is the type of battery we will use. Since we want the subsystem to be powered for as long as possible without the user having to change the batteries, we need to prioritize battery capacity. This also needs to be balanced with cost and overall size since the vent cover only allows a small amount of space to place components.

For the most part, lithium-ion batteries usually provide the most capacity with relatively reasonable sizes. They are also easy to find in any department store or supermarket.

Alkaline batteries in contrast have the most limited capacity and are prone to leakage which can easily corrode and damage sensitive components if they are left in for too long. As a result, we likely will not consider this as a reasonable battery type to use.

Lithium-polymer batteries are another type of battery we could consider for this application. The main downside to this battery type, however, is that the cost is much higher and lithium polymer batteries are not as widespread in use as lithium ion or alkaline batteries. This means a potential user would have to actively search for a proper battery and likely pay more as opposed to just finding the model in a department store. Lithium-ion batteries can also hold more energy in a smaller form factor.

It is helpful to note that typical battery voltages tend to be uniform across all types. Lithium-Polymer batteries are the only exception as they tend to have a nominal voltage of 3.6-3.7V.

	Alkaline	Lithium-ion	Lithium-Polymer
Cost	Cheapest battery type	Balanced Cost	Most expensive battery type
Size	Relatively small size depending on model, comparable overall to most lithium-ion batteries	Relatively small size depending on model, comparable overall to most alkaline batteries	Tend to be thin but very wide, which is inconvenient for fitting into a vent cover
Availability	Easily accessible in any department store	Easily accessible in any department store	Not very accessible outside of online purchasing.

Table 17: Comparison between different types of batteries

Overall, Lithium-ion batteries seem to offer the best ratio between capacity and size. The fact that they are also easy to find in stores also makes this option very attractive both for testing and for the user.

The two lithium batteries that will be considered will be the CR123 battery as well as a lithium 9V battery. The CR123 is rated for a capacity of 1500mah and

the 9V is rated for 1200mah. These batteries provided the most capacity whilst being easily attainable and moderately sized.

3.7.2 Voltage Regulation

Voltage regulators are commonly used to provide a stable voltage output from a variable voltage source to meet the specific voltage requirements of each component. Both subsystems will need voltage regulators as the voltage range of each of our components isn't simple to match with a battery or wall adapter. This is especially important for our batteries since their discharge voltage can decrease over time. There are two general types of voltage regulators: Linear and switching regulators.

3.7.2.1 Linear Voltage Regulators

Basic linear voltage regulators consist of a circuit utilizing an op-amp with a closed feedback loop and a bipolar transistor to stabilize the output voltage. This circuit allows quick adjustments when the load current changes. Linear regulators commonly come in IC packages that either have output voltages that are adjustable using a voltage divider, or output voltages that are fixed to that model of regulator.

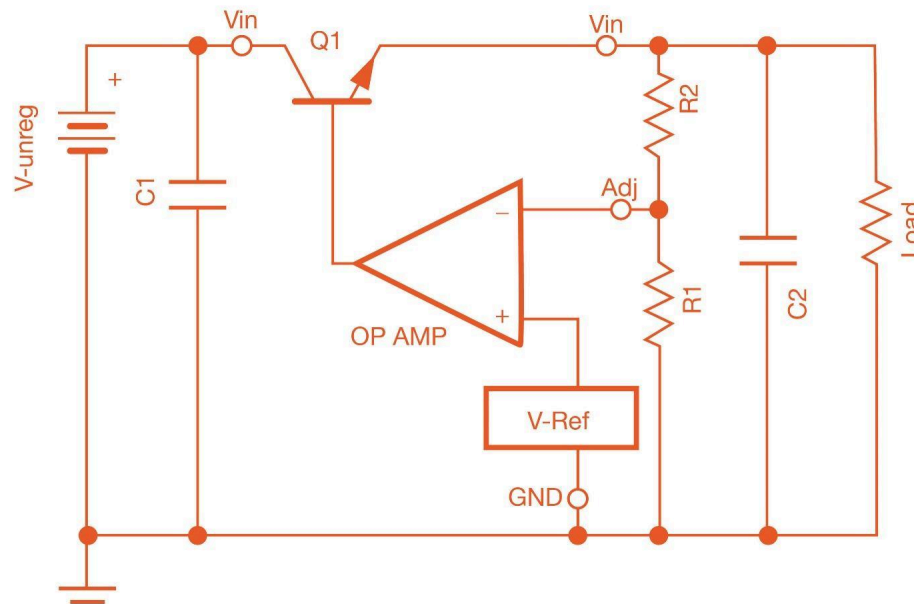


Figure 8: Circuit schematic of simple linear voltage regulator [60].

The main issue with these regulators is efficiency. Basic linear regulators typically have a dropout voltage of around 2.5V, which means the input voltage must be at least 2.5V more than the output voltage to guarantee the output is

stable. These regulators have an input power that is directly proportional to the output power, meaning that higher the voltage difference between input and output causes less efficiency in the regulator. These regulators are therefore most efficient when $V_{in} = V_{out} + V_{Dropout}$. More importantly, the extra power from this difference between the input and output is dissipated as heat, so using such a regulator would likely require having a heatsink attached to it. The main upsides to a linear regulator are cost, ease of use, and lack of switching noise which is common in switching regulators. Regulators such as the LM78xx series and others are so ubiquitous and cheap that they are commonly considered jellybean components.

3.7.2.2 Low Dropout Regulators

One solution to the dropout voltage requirement of basic linear regulators is a low dropout voltage regulator.

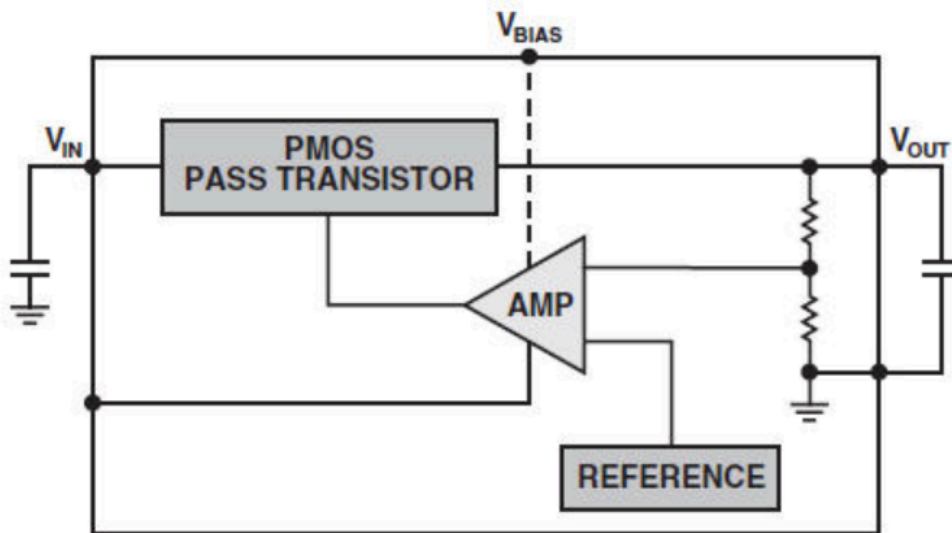


Figure 9: Basic LDO Block Diagram [61].

Low dropout regulators allow us to use voltages closer to the output voltage whilst also wasting less power given that our input voltage is very close to the output voltage. These regulators can commonly reach up to 90% efficiency given this condition. The main downside to this is that the higher the input voltage is the less efficient the regulator becomes, which is the same as the behavior found in basic linear regulators. There are many 3-3.6V batteries we could use to power our components, but if the discharge voltage were to drop below $V_{out} + V_{Dropout}$ then our output voltage would not be stable. Trying to use batteries with higher voltages would also reduce the efficiency. Ultimately this

option is more useful than basic linear regulators but careful considerations would need to be made regarding battery choice. Once more, heat is also a factor, and this will require careful considerations in regards to IC package type to ensure the temperature of the device is kept under control.

3.7.2.3 Switching Regulators:

Switching regulators utilize an inductor, a diode, and a FET controlled by a switching IC to turn the FET on or off depending on if the desired output voltage has been reached [62]. Due to the nature of the design, switching regulators are capable of high efficiency regardless of input voltage and it can be used in many more conditions such as with an input voltage that is lower than the output voltage (boost configuration). Switching regulators typically have above 90% efficiency and a typical regulator IC likely wouldn't be too much more expensive than a linear regulator.

The main downside to this is that the design requirements are quite strict and finding proper capacitors and inductors that fit the datasheet's requirements would cost more than a comparable linear regulator circuit. There is also added complexity due to the fact that efficiency is also dependent on the output current, and the overall output current can be limited depending on the input voltage and the IC. Thankfully our devices don't consume much current, so this shouldn't be much of an issue. The presence of switching noise is another downside as it requires more careful component choices and design considerations to mitigate the noise. Thankfully modern DC-DC switching ICs are very reliable [62].

	Linear Regulator	Switching Regulator
Cost	Due to the low component count and basic nature of the design, cost is generally low.	Higher component count and more complex and robust ICs generally result in higher cost.
Efficiency	Not Fixed, dependent on difference between V_{in} and V_{out} Can be a maximum 60% for a basic linear regulator and 98% for an LDO. There is no minimum	Typically fixed and only slightly dependent on output current. Tends to be above 90% but can reach a minimum of around 70% at low current draw
Design Complexity	Simplistic	Slightly Complex

Size	Low component count consisting of mostly tiny SMD components. Takes up little space on PCB.	Requires anywhere from 6-15 depending on the type of regulator and design. Utilizes an inductor which can increase PCB footprint drastically.
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Table 18: Comparison between different types of voltage regulators

Due to their high efficiency, switching regulators are likely to be a fitting choice for BREATHE's power supply design. Despite the complexity and increased footprint, the fact that switching regulators operate at a mostly fixed efficiency is helpful for lithium-ion batteries which can drop in discharge voltage over time. This also allows less concern for thermal concerns as less power is able to be dissipated as heat.

3.7.3 Types of switching regulators

There are three main types of switching regulators that we can incorporate into the design of our power system. The type of regulator we use is also going to partly decide what battery we use and is also integral to optimizing the overall battery life of the vent interaction subsystem.

For the sake of simplicity, the battery life calculations for this section will not account for low power modes and other general discontinuities in current draw, though low-power mode features will be mentioned. The calculations will be entirely based off of an 800mA continuous current load with a 5V output rail. This is because the motor will require a voltage of at least 5V and has a maximum current load of 800mA. Obviously, the motor's current load will be discontinuous, but this scenario is merely to offer a simple and fair comparison. This will also mostly ignore common lithium battery phenomena that occur with continuous current loads such as reduced capacity or reduced discharge voltage. This is to once again provide an easily understandable comparison as a baseline.

3.7.3.1 Boost Converter (TPS 61023)

A boost converter, sometimes referred to as a step-up converter, is a switching regulator that allows a voltage source to output more voltage than it can typically provide.

This means that if we used a common battery with a 3V supply we would still be able to supply 3.3V or even 5V to the components that need it. This would also be safe in case the battery's discharge voltage were to fall below 3V nominal.

This would be beneficial for battery sources with high capacity but low output voltage.

There is, however, a major downside to this design due to the nature of how a boost converter is able to output a higher voltage. Since in a switching regulator the power must be conserved (i.e. $P_{in} = P_{out}/\text{efficiency}$), the boost converter will draw more current from the source compared to the output [63]. For example, if we were to use a battery that supplies nominal 3V and we needed an output of 5V at 800mA, then

$$P_{out} = (5V)(0.8A) = 4W$$

According to the TPS61023 datasheet, with these input and output characteristics the efficiency of the regulator would be about 94% [64]. So for the input power:

$$P_{in} = 4W/0.94 = 4.255W$$

Our source current draw would therefore be:

$$I_{in} = 4.255W/3V = \sim 1.418A$$

This isn't great for overall battery life regardless of the capacity of the battery. Batteries can be optionally stacked in parallel to increase capacity, but even then the current draw of a boost converter is generally unsuitable for a battery source if longevity is a main priority. Boost converters are also typically less efficient compared to buck or buck-boost regulators, but they all tend to be around 90-95% efficiency regardless.

3.7.3.2 Buck converter (MAX77505)

A buck converter, sometimes referred to as a step-down converter, is a switching regulator commonly used to output a lower voltage from a higher voltage source. This allows us to potentially use a 9V battery or several other battery types in series.

One main advantage of using a buck converter, especially in comparison to boost converters, is how the converter handles input and output currents. Just like the boost converter, power must be conserved from input to output [65]. For a voltage source such as a 9V battery, if we were to once again calculate for a 5V output with 800mA current draw:

$$P_{out} = (5V)(0.8A) = 4W$$

According to the MAX77505 datasheet, the efficiency at 800ma is about 94% [66]. So

$$P_{in} = 4W/0.94 = 4.255W$$

$$I_{in} = 4.255W/9V = 472.7mA\sim$$

Essentially, in this configuration a buck converter would give us a 800mA output while only drawing nearly half that at the source. This would be highly beneficial for the vent interaction subsystem where battery life is of utmost importance. Using a 9V battery this would result in a very reasonable battery life despite the high current draw of the motor. One thing to note, however, is that this reduction in source current is dependent on the difference in voltage between the battery and the desired V_{out} . Another important factor to consider is a battery's discharge voltage over time. Batteries will not have a consistent output voltage across their entire lifespan, instead they will slowly discharge less voltage until they reach their "cutoff voltage" which is when they will stop discharging entirely. This cutoff voltage will vary but tends to be within the same range depending on the battery's nominal output voltage. For the 9V battery example that was used in this section, the cutoff voltage tends to be around 5.5-6V. This means the buck-converter will work across the battery's entire lifespan since the regulator only requires V_{in} to be equal to $V_{out}+I_Q$ (quiescent current). For batteries that have a cutoff below that requirement, they will not be able to function across their entire lifespan. This would in turn decrease overall battery life.

3.7.3.3 Buck-Boost converter (TPS63070)

The last major topology we considered for the power section is the buck-boost topology. This is a combination of the two previous switching regulator designs that allows for voltages both above and below the desired output voltage. This is helpful for the exact scenario stated in the prior section: a lithium battery that will have a discharge voltage lower than the output voltage after a certain period of time. Instead of that battery becoming unusable before its rated cutoff, the buck-boost topology would allow the battery to be usable in boost mode until it eventually dies. Of course, this would result in increased source current draw which isn't optimal for high battery life. However, this would still be ideal for use with said batteries as opposed to a buck converter. This begs the question why not use a buck-boost topology as opposed to a regular buck-converter? Buck-boost topologies are often paired with lithium-ion batteries and have many built-in protections specific to them [67]. Unfortunately, buck-boost converters tend to cost more and require more components to work, which will make the PCB larger as a result. This makes a buck-boost converter practically useless for any battery that can't fall below the desired output voltage. As a note, the efficiency of this buck-boost converter is practically the same as the other options [67].

3.7.3.3.1 A Quick Note on SEPIC converters:

SEPIC converters are a variation on buck-boost converters that can reduce board size by reducing the overall parts count. SEPIC converters work by chaining a boost converter to an inverted buck-boost converter. This has a few other benefits such as a proper 0V shut down mode and a non-inverted output (buck-boost converters have inverted outputs that need to be accounted for in the design) [68]. They are also less prone to switching noise.

The main issue with SEPIC converters is poor efficiency in comparison to buck-boost converters and a higher IC cost. SEPIC converters therefore will not be considered in this design.

	TPS 61023 Boost converter	MAX77505 Buck converter	TPS55289 Buck-Boost converter
Efficiency (5V 800mA output)	94%	94%	94%
Source Current (5V 800mA output)	1.418A	472.7mA	473mA
Quiescent Current	20uA	800nA	760uA
IC Cost	\$0.78	\$2.72	\$6.60

Table 19: Comparison of Switching Regulators

Overall, the buck converter with a 9V battery seems to be the most reasonable option for our power section due to its high battery life, low cost, and moderate size. Both size and battery life are the main concerns for BREATHE considering the components have to fit within a narrow space and the batteries need to last at least 6 months before needing replacement.

3.7.4 Lithium-ion Battery Choice:

As previously stated, the method of regulation will also directly tie into what battery we must use in the vent interaction subsystem. Due to the fact that both a buck and buck-boost topology are very similar and reasonably useful depending specifically on what battery is used, this section will cover battery choices that match either scenario in which one is needed or more useful as opposed to the other. Boost-converters have been understandably ruled out as they would draw far too much extra current. This section will use battery life calculations that are extremely simplified and once again based off of a

hypothetical continuous 800mA 5V output for the motor. There are two main considerations for lithium-ion battery types with high capacity and enough voltage to be used in conjunction with a buck regulator: A 9V battery and a CR123 battery.

3.7.4.1 9V Battery in Buck Topology:

A typical 9V lithium-ion battery has a capacity of around 1200mAh. This is relatively high considering both the size and availability of these particular batteries. Since the source current using a 9V battery for BREATHE's chosen buck-converter has already been calculated as 472.7mA, this value can be used to calculate an estimated battery life. This battery life would be around 2 hours and 32 minutes. Hypothetically, let's say it takes the motor 5 seconds to open or close the vent, and it only will be powered for those 5 seconds. In this case the motor could move 1824 times before the battery would run out (ignoring quiescent current and the MCU's power draw). Overall, this option is extremely efficient and very suitable for the vent interaction subsystem. Notably with a buck-converter this battery would be able to function across its entire lifespan.

3.7.4.2 CR123 Battery in Buck-Boost Topology

Another option is using two CR123 batteries in series to get a nominal 6V with 1500mAh capacity. In terms of size, this option would take up more space since two batteries in series would be slightly longer than one 9V battery, though they would have similar depth. This is also coupled with the fact that A style batteries require an enclosure with spring contacts to properly use them, potentially taking up more space. As for battery life, using our previous example

$$P_{in} = 4W/0.96 = 4.17W$$

$$I_{in} = 4.17W/6V = 695mA\sim$$

Using this configuration, the overall battery life would be around 2 hours and 9 mins. This performance is significantly worse than that of the 9V battery which makes this option less sensible for our purposes, especially since it takes up more space. Another factor that hasn't been touched upon is discharge voltage. These batteries have a cutoff at around 2V, so there is a possibility it is still operational but discharging under 3V [69]. Hypothetically, the battery could be somewhat old and discharging at 2.4V, in this case it would not be able to supply a 5V output. This is in contrast to the 9V which has a cutoff discharge voltage of around 6V, meaning it could still provide power across the entire range of its lifespan [70]. This means using a buck-boost topology would be necessary to extend the battery life to accommodate the whole range of the battery.

To add to the previous calculation, using the datasheet we can find the discharge voltage corresponding to the Ah performance. From the figure below, we find that from 1.4-1.5Ah the discharge voltage is below 2.5 per battery, meaning that the input voltage will be below the output voltage and the regulator will be in boost mode [69].

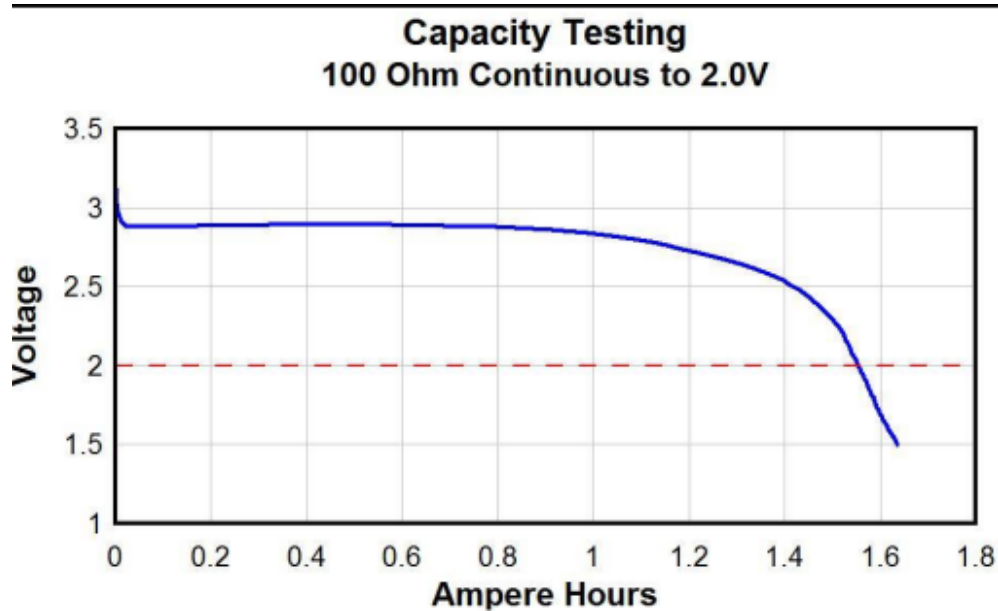


Figure 10: Duracell CR123 battery discharge voltage over capacity [69].

Therefore, without a buck-boost converter the actual battery life is around 2.014 hours. However, using a buck-boost converter we can get the full capacity of the battery

Calculating for the total battery life with lowest discharge voltage before cutoff (2.1V)

$$I_{in} = 4.17W/4.2V = 993mA\sim$$

This allows an extra 6 minutes bringing us a total of 2 Hours and 6 minutes of battery life as opposed to just 2 hours with a typical buck converter when accounting for the drop in discharge voltage. This isn't necessarily bad, but performance is still much worse than that of the 9V battery with a buck converter. Using the previous hypothetical example of the motor taking 5 seconds to adjust the vent, the motor would only be able to adjust 1,512 times before the battery would be fully drained.

	9V Battery	2 CR123 Batteries in Series
Source Current Draw(@800mA 5V output)	472.7mA	695mA
Battery Capacity	1200mAh	1500mAh
Battery Life (@800mA 5V continuous output)	2 hours and 32 minutes	2 Hours and 6 minutes
Cost	\$17.42	\$12.47

Table 20: Comparison of lithium ion battery types

3.7.5 Providing Split Rails:

As previously outlined, the power section will require two different voltage rails to properly supply power to both the MCU and the motor in the vent interaction subsystem. Thankfully, the MCU can take anywhere from 1.7-3.6V whilst the motor needs anywhere from 4.8-7.2V to function properly. In terms of current consumption, the MCU seems to draw at maximum 130mA, it is important to note it will likely never consume anywhere near this much current, but using this as a baseline means the MCU will be able to draw as much as it will ever need. Conversely, the motor will draw a maximum current of 900mA. Whatever solution chosen to compensate both output rails will also need to compensate for these maximum ratings just in case. It was already determined that a buck converter is the most reasonable solution, at least for the first stage of voltage regulation, but for providing our second voltage rail there are three unique solutions with their own respective tradeoffs. At this stage we can determine the specific ICs we will use for the entire power section in the vent interaction subsystem.

3.7.5.1 Chaining The Buck Converter into an LDO:

One option is to use an LDO on the output of the main voltage rail on our buck converter to step-down to the required voltage needed for the MCU. Previously, it was determined that linear voltage regulators would not be suitable for the vent interaction subsystem since the efficiency is dependent on the voltage difference between input and output and we could not guarantee that it would be above even 70% when using the batteries that are most ideal for this application. Buck converters also can provide a higher output current whilst sourcing less from the battery depending on the voltage difference. Conversely,

an LDO would only source exactly what the output is drawing in addition to the device's quiescent current. For our main voltage rail, which would step down 9V to 5V (ignoring discharge voltage loss), a buck converter is easily the best solution. However, when stepping 5V down to 3.3V the difference isn't nearly as large, especially when accounting for the fact that the MCU is usually drawing only a dozen or so milliamps at any given time. Whilst power consumption and efficiency are quite important downsides for this option, the tradeoffs are a lower overall footprint and lower cost.

A potential LDO to consider in this case would be the MCP-1700. This LDO has a quiescent current of about 1.6uA and only requires 2 capacitors in addition to the IC itself [71]. It features overcurrent protection as well as overtemperature protection as well. Stepping down 5V to 3.3V, the efficiency of this regulator would be about 66%. Using the maximum current draw of the MCU at 230mA, we can calculate the amount of power dissipated as heat as well as the proper package to use to ensure thermal reliability. We can also roughly calculate battery life using our previously established metrics.

$$P_D = (5)(.230) - (3.3)(.230) = 0.391W$$

According to the datasheet [71], an SOT-89 or a TO-92 package would easily be able to handle this extra power dissipation if the MCU were to ever hit its maximum current draw. The battery life of this solution (ignoring the motor) would be around 60 hours if we estimate the MCU draws 20mA consistently.

3.7.5.2 Using Two Buck Converters:

This option is the obvious conclusion for providing two voltage rails. The main downside of this being the footprint would be double that of a single buck converter circuit, which may potentially make it more difficult to fit the vent-subsystem's PCB in the actual vent cover. Thankfully, many of the other components in the vent interaction subsystem have very small footprints, making it feasible to fit this scheme inside the vent. One large advantage of this would be cost, dual-output converters tend to cost a bit more compared to a single buck-converter. Whilst it may cost more than a buck-converter chained into an LDO, this scheme would be much more efficient and as a result increase battery life. Moreover, this scheme would be very easy to test in case one regulator were to go bad.

It is important to note the best scheme for using two buck converters would be combining them in parallel as opposed to series. In series, there would be more current draw from the battery on the 3.3V rail since it would be sourcing from 5V instead of 9V. Moreover, switching noise may be more of an issue when using a

buck converter as a source for another buck converter. Reducing noise may require a more complex design and a more precise layout. Due to this, combining them in parallel would be preferred.

3.7.5.3 Using a Dual-Output Buck Converter:

Another potential option is utilizing a PMIC that has two buck converters integrated into one package. This would reduce the space concerns with having to use two ICs with their own relatively large components counts. Typical dual-output buck converters will have component counts comparable to a single buck-converter. This would substantially reduce the overall footprint. The main downside to this is cost, whilst an LDO and single buck-converter combination would be very inexpensive, a typical dual-output buck converter IC is very costly.

A great contender for this option would be the LTC-3622. This dual-output buck converter was one of the only ones on the market that had a somewhat lower cost, fulfilled our current output requirements, and maintained good efficiency across a wide range of output current loads. This IC also comes in leaded packages which will inevitably make testing simpler before we integrate the design into a full-fledged PCB. Curiously, the LTC-3622 also provides two optional modes of operation for each output, one that would reduce ripple voltage at the cost of some efficiency at lower current loads and another which would increase efficiency at the cost of ripple voltage. This would be extremely useful for debugging issues with either the MCU or motor which may be due to ripple.

3.7.5.4 MCU Input Voltage Options:

Since the STM32 has a wide input voltage range between 1.8V-3.6V and there aren't any extra peripherals which would require 3.3V, there are a few considerations to make when determining what voltage output should be sent to the MCU. Thankfully, the LTC-3622 datasheet specifies the efficiency of the regulator at different output voltages. Using this, we can compare the source current draw depending on whether we use a 2.5V output or a 3.3V output (note: these are the only two shown in the datasheet, 1.8V is also shown but efficiency plateaus far too low at that voltage) [72].

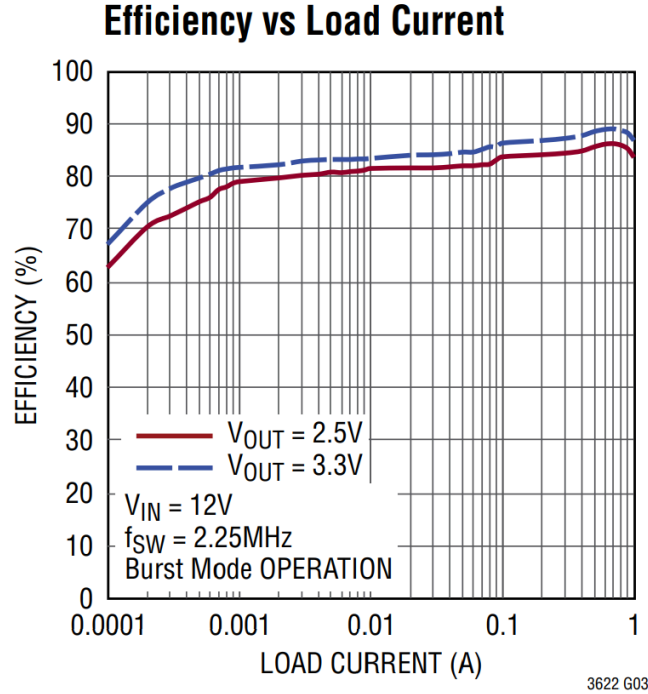


Figure 11: Efficiency vs Load Current of LTC-3622 at 2.5V and 3.3V output [72].

For the sake of simplicity we can calculate the source current draw for 20mA. At 3.3V:

$$P = (3.3 \cdot .02) / (.8) = 0.0825W$$

$$I_{in} = 0.0825 / 9 = 9.16mA$$

At 2.5V:

$$P = (2.5 \cdot .02) / (.83) = 0.0602W$$

$$I_{in} = 0.0602 / 9 = 6.68mA$$

As shown above, a 2.5V output would be ideal for the MCU output as it draws a little less current from the source due to the voltage difference. Heat issues due to efficiency would be negligible since the two output voltages are relatively close in efficiency anyways.

It is also important to note efficiency differences between the MAX77505 and the LTC3622. The MAX77505 has around 94% efficiency at 800mA (near max current draw of the motor) and the LTC3622 has around 92% efficiency at 800mA. This difference is nearly equal across most of the graph's range, except for extremely low current loads where the LTC3622 is actually more efficient.

	MAX77505 Buck Converter(5V) + MCP1700 LDO(3.3V)	LTC-3622 Dual-Output Buck Converter(5V and 2.5V)	Two MAX77505 Buck Converters in Parallel(5V and 3.3V)
Efficiency (5V 800mA output)	94%	92%	94%
Efficiency (3.3V/2.5V 20mA output)	66%	83%	91%
Source Current Draw (@3.3V and 2.5V with 20mA output)	20mA	6.7mA	8.05mA
Source Current Draw (@5V 800mA output)	472.7mA	483.1mA	472.7mA
Total Source Current Draw (neglecting quiescent current)	492.7mA	489.8mA	480.75mA
IC Cost	\$3.22	\$9.71	\$5.44
Footprint	Marginally larger footprint than dual-output regulator due to having to use two ICs	Smallest footprint and lowest component count	Largest footprint, nearly double the area of dual-output IC.

Table 21: Comparison between power supply options

Considering cost, source current draw, and footprint it is evident that using two buck converters in parallel would be the most effective solution for BREATHE. Whilst the LTC-3622 is a reasonable option, the extra source current draw and high cost makes it a less than ideal option. Moreover, it would be much easier to test two separate buck converters in case issues arise.

3.8 Communication Protocols

3.8.1 Serial Communications

There are several serial communication protocols that serve to ensure reliable data transfer, efficient power usage, and real time functionality. Each of which brings their own unique advantages best suited for various tasks. Below is a list of the most common serial communication protocols used.

UART: Universal Asynchronous Receiver-Transmitter (UART) is a widely used serial communication protocol that enables point-to-point data exchange between two devices. Unlike synchronous protocols such as SPI or I2C, UART is asynchronous, meaning it doesn't require a shared clock between the devices. Instead, data transfer relies on setting a common baud rate on both ends, which synchronizes data transmission and reception. Each UART data packet includes start and stop bits that signal the beginning and end of each byte, ensuring the receiving device correctly interprets the data without a shared clock signal [73]

UART communication uses two primary lines, TX (transmit) and RX (receive), enabling simple, bidirectional data flow. Data is transferred in a serial format, one bit at a time, with error-checking options like parity bits that help detect errors during transmission. UART's simplicity and widespread support make it ideal for low-speed data transfer applications, such as communicating between microcontrollers or interfacing with modules that don't require high data rates or complex handshaking protocols. However, UART's asynchronous nature limits its effectiveness over longer distances, as baud rate mismatches can lead to data errors [73].

In embedded systems like BREATHE, UART is especially useful for debugging and status reporting, where data is sent to a terminal or computer for monitoring. This protocol's low overhead and easy setup make it ideal for applications that don't require high bandwidth or multiple-device connectivity. While limited to single-device connections, UART's simplicity, reliability, and low resource requirements make it a versatile and valuable communication option for point-to-point data exchanges in embedded systems [73].

I2C: The Inter-Integrated Circuit (I2C) protocol, developed by NXP (formerly Philips), is a popular synchronous, multi-master, multi-slave communication protocol commonly used in embedded systems for connecting low-speed peripherals like sensors, memory devices, and ADCs. I2C requires only two lines—SDA (Serial Data) and SCL (Serial Clock)—making it efficient in terms of

wiring and well-suited for applications where multiple devices share a single communication bus. Each device on an I2C bus has a unique address, allowing the master to communicate with specific devices without requiring extra control lines [74].

I2C supports a range of data rates, from standard mode at 100 kbps to fast mode at 400 kbps, with high-speed mode reaching up to 3.4 Mbps. It operates as a half-duplex protocol, where data can only be transmitted in one direction at a time. The protocol also includes acknowledgment bits, enabling error detection by confirming successful data transfers between devices. This reliable communication mechanism allows I2C to handle various applications with multiple sensors or peripheral devices, despite its slower data rate compared to other protocols like SPI [74]

For BREATHE, I2C is particularly useful for connecting environmental sensors to a microcontroller, allowing multiple sensors to share the same communication lines. This scalability and simplicity are ideal for applications that require multiple devices on a single bus without complex wiring. Although I2C's slower data rate may not be ideal for bandwidth-intensive tasks, it excels in low-power, low-speed data collection, making it a practical and efficient choice for sensor integration in embedded systems [74]

SPI: The Serial Peripheral Interface (SPI) is a high-speed, synchronous communication protocol widely used in embedded systems for connecting microcontrollers with peripherals such as sensors, displays, and memory modules. SPI operates in a full-duplex mode, allowing simultaneous data transmission and reception, which is essential for high-performance applications. It uses a master-slave architecture with four primary lines: MOSI (Master Out Slave In), MISO (Master In Slave Out), SCLK (Serial Clock), and SS (Slave Select). The master device generates the clock signal (SCLK), enabling precise timing and coordination for data exchange with the slave devices. SPI's streamlined protocol and clock-driven communication allow data rates of several Mbps, providing efficient performance for bandwidth-intensive applications [Source: Analog Devices, Mouser]

One of SPI's significant advantages is its flexibility and simplicity in data exchange, achieved through dedicated communication lines that reduce bus contention. Since SPI does not have an addressing scheme, each additional device requires a unique SS line, which the master uses to select and communicate with specific peripherals. This method offers rapid data access, making SPI ideal for applications requiring real-time data transfer, such as driving graphical displays or reading high-speed ADCs. However, since each

device needs a separate SS line, systems with multiple devices can become more complex to manage, especially on PCBs with limited space [75]

SPI's speed and efficiency make it highly suitable for applications requiring frequent and large data transfers. For BREATHE, SPI is especially advantageous for interfacing with components like LCD screens, where high-speed data refresh is critical for smooth visual performance. Despite its wiring limitations, SPI's fast, full-duplex communication capabilities make it one of the most effective protocols for embedded applications requiring substantial data handling and minimal latency [76]

3.8.2 Serial Communication Final Selection and Justification

In the smart vent system, each communication protocol—UART, I2C, and SPI will serve different roles that will ensure reliable operation. UART will primarily be used for debugging and status reporting, allowing the system to send diagnostic information to a connected computer or terminal for monitoring. For instance, UART can be used to test the output of a sensor by s values to a terminal. Its simplicity and low resource requirements make it ideal for this purpose. For instance, UART can be used to test the output of the CO₂ sensor by sending its output values to a terminal. Likewise, I2C will facilitate communication between the STM32 microcontroller and multiple environmental sensors, such as the CO₂ and temperature sensors. With its multi-master, multi-slave capability and shared bus architecture, I2C minimizes wiring complexity while enabling the seamless integration of multiple peripherals. Finally, SPI will be employed for interfacing with the capacitive touchscreen LCD. Its high-speed, full-duplex communication will allow for quick data refresh rates, enabling smooth and responsive visuals for displaying environmental data and user feedback. Together, these protocols provide a robust foundation for the BREATHE system, optimizing communication efficiency across its various subsystems.

Below is a table comparing each type of wired serial communication.

Feature	UART	I2C	SPI
Communication Type	Asynchronous	Synchronous	Synchronous
Clock Requirement	No (asynchronous operation)	Yes (shared clock line: SCL)	Yes (master provides clock: SCLK)

Number of Lines	2 (TX, RX)	2 (SDA, SCL)	4 (MOSI, MISO, SCLK, SS)
Topology	Point-to-point	Multi-master, multi-slave	Single-master, multi-slave
Full-Duplex Capability	No	No	Yes
Speed/Data Rate	Limited by baud rate, less effective over longer distances	100 kbps (Standard Mode), up to 3.4 Mbps (High-Speed Mode)	High-speed communication, data rates up to several Mbps
Error Checking	Start and stop bits, optional parity bits for error detection	Acknowledgment (ACK) bits confirm successful data transfers	None mentioned, relies on application layer

Table 22: Comparison between wired serial communications

3.8.3 Wireless Communication

Bluetooth 5.0: Bluetooth is a wireless communication protocol designed for short-range, low-power data transfer. The introduction of Bluetooth 5 significantly enhanced the protocol, offering improved data rates, range, and broadcast capacity over previous versions. Bluetooth operates in the 2.4 GHz ISM band and uses adaptive frequency hopping (AFH) to minimize interference from other wireless signals. Bluetooth 5 offers three key modes: a high-speed mode for fast data transfer (up to 2 Mbps), an extended range mode to support longer-distance connections, and an advertising mode that allows devices to broadcast data to multiple devices simultaneously without a dedicated connection [77].

Bluetooth 5 expanded the functionality of the protocol by increasing the maximum range and enabling more flexible data transmission options. Devices can now transmit data over distances of up to four times that of Bluetooth 4.2, with adjustments available between range and data rate to fit specific application needs. Bluetooth's flexibility makes it suitable for applications like IoT, smart home, and wearable devices where reliable short-range communication is essential. Enhanced broadcast capabilities in Bluetooth 5 also

enable devices to communicate with multiple receivers simultaneously, allowing a single device to share information broadly, such as in beacon applications [77].

Bluetooth's low power consumption is another advantage, particularly in Bluetooth Low Energy (BLE) applications where devices are designed to transmit small amounts of data infrequently. This feature is ideal for applications that require minimal power usage, such as sensors, health monitors, and remote controls. For embedded systems like BREATHE, Bluetooth is beneficial for data-sharing applications that require secure, low-power connectivity, especially in devices that need to operate on battery power for extended periods. Bluetooth 5's enhancements in speed, range, and broadcast capabilities make it a highly versatile protocol for modern wireless communication needs [77].

Bluetooth Low Energy: Bluetooth Low Energy (BLE) is a wireless communication protocol designed to support low-power applications in areas such as IoT and wearable devices. Similar to traditional Bluetooth, BLE operates in the 2.4 GHz ISM band, utilizing a frequency-hopping mechanism to reduce interference and ensure reliable communication. However, BLE differs from traditional Bluetooth by optimizing energy efficiency, allowing devices to operate on small batteries for extended periods. This makes BLE suitable for applications that require periodic data transfers, such as sensor readings and device control, rather than continuous data streaming [78].

BLE is structured around the Generic Attribute Profile (GATT), which organizes data into services and characteristics for efficient data management. GATT allows devices to communicate in a structured format that is easy to standardize across various device types, from simple sensors to complex multi-function devices. BLE also supports various connection modes, including broadcast and connection-oriented communication, allowing devices to balance between conserving power and maintaining robust connectivity based on the application's needs [78].

The low energy consumption of BLE is achieved through brief data transmission intervals and a low-duty cycle, where devices can remain in low-power states between transmissions. This power-saving feature makes BLE highly suitable for applications in smart homes, health monitoring, and remote control systems, where maintaining long battery life is critical. Compared to traditional Bluetooth, BLE prioritizes energy efficiency over data rate, achieving a balance that supports frequent but brief data exchanges while preserving battery life [78].

Wi-Fi: Wi-Fi, based on the IEEE 802.11 standard, is a widely used wireless communication protocol that provides high-speed data transfer for local area

networks. Operating primarily in the 2.4 GHz and 5 GHz frequency bands, Wi-Fi allows multiple devices to connect to a central access point, which allows for efficient data sharing and internet connectivity within a local area. The protocol supports data rates ranging from several Mbps to several Gbps, depending on the specific 802.11 variant, making it ideal for applications requiring substantial bandwidth, such as video streaming, file transfer, and real-time data monitoring [79].

Wi-Fi uses Orthogonal Frequency-Division Multiplexing (OFDM) to divide the wireless channel into multiple subcarriers, improving spectral efficiency and reducing interference from overlapping channels. This approach, combined with Multiple Input Multiple Output (MIMO) technology, allows Wi-Fi to support high data throughput and multi-device connectivity. MIMO enables multiple antennas to transmit and receive signals simultaneously, increasing data rates and coverage by leveraging spatial multiplexing. As a result, Wi-Fi networks can handle a high density of devices, which is particularly valuable in environments like homes, offices, and industrial facilities [79].

While Wi-Fi offers significant advantages in speed and range, it also has higher power requirements than protocols like BLE, making it less suitable for low-power IoT devices. Wi-Fi's power consumption makes it more practical for applications where devices are either plugged in or require occasional charging. For embedded systems like BREATHE, Wi-Fi is best suited for applications involving large data transfers or real-time data access but may not be optimal for battery-powered devices needing long-term, low-power operation. Wi-Fi's versatility and high throughput make it an essential protocol for applications that require fast, reliable connectivity within local networks [79].

3.9.4 Serial Communication Final Selection and Justification

BLE (Bluetooth Low Energy) is the most suitable option for transferring environmental data, such as temperature and CO₂ levels, within the BREATHE'S interconnected MCUs. This is because BLE is specifically designed for low-power applications, making it highly efficient for systems that require extended operation on limited power, such as a battery-powered smart vent. Unlike traditional Bluetooth, which is optimized for continuous data streaming, BLE prioritizes energy efficiency by transmitting data in short bursts and maintaining a low-duty cycle. This aligns perfectly with the nature of environmental data, which does not require constant, high-bandwidth communication but rather periodic updates.

Additionally, BLE operates in the 2.4 GHz ISM band and uses the Generic Attribute Profile (GATT) to structure data transmission into services and characteristics, enabling a straightforward and standardized method for transferring sensor data between devices. This ensures reliable communication while conserving power, as only relevant data is exchanged.

Another key advantage of BLE is its support for both broadcast and connection-oriented modes, allowing the system to balance power conservation and robust connectivity. For BREATHE, the connection-oriented mode can securely transfer temperature and CO₂ levels to another MCU, ensuring data integrity and accuracy without the need for high-speed or high-power transmissions.

The STM32 microcontroller, which will serve as the foundation of the BREATHE system, is highly compatible with BLE. Its hardware and software flexibility allow seamless integration with BLE communication protocols, making it well-suited for both short-range communication and efficient power management. While the STM32 is capable of supporting other protocols such as Wi-Fi or standard Bluetooth, BLE remains the optimal choice. Its low power consumption, structured data management, and ability to maintain efficient and reliable communication over short distances make it the best choice for the BREATHE system's data-sharing requirements. BLE ensures minimal power usage while still providing the necessary functionality to transmit critical environmental data effectively.

Feature	Bluetooth 5.0	BLE	Wi-Fi
Frequency Band	2.4 GHz ISM	2.4 GHz ISM	2.4/5 GHz
Data Rate	Up to 2 Mbps (high-speed mode)	Optimized for low data rates	Several Mbps to several Gbps, depending on the 802.11 variant
Range	Up to 4x the range of Bluetooth 4.2	Short to medium range, optimized for low-power applications	High range within a local area network
Number of Lines	2 (TX, RX)	2 (SDA, SCL)	4 (MOSI, MISO,

			SCLK, SS)
Connection Modes	High-speed, extended range, and advertising modes	Broadcast and connection oriented modes	Centralized access point connecting multiple devices
Multi-Device Connectivity	Enhanced broadcast capabilities allow communication with multiple devices	Connection-oriented or broadcasting for flexibility	Supports multi-device connectivity through MIMO technology

Table 23: Comparison between power supply options

3.9 Software research

3.9.1 Coding Languages

Due to the coding environment of an STM32, the selection of coding languages must be optimized for embedded system development. Factors such as limited memory, performance demands, and compatibility with the MCU must be taken into account. Moreover, the coding environment should exhibit real-time qualities since BREATHE requires predictable and timely responses. As a result, object oriented programming languages should be avoided due to them introducing computational overhead in real time embedded environments [80]. Features such as inheritance, polymorphism, and function encapsulation can result in unpredictability and inefficiency, especially in resource-constrained environments such as embedded systems. Moreover, languages that have garbage collection should entirely be avoided, as the garbage collector runs whenever the system decides its appropriate, which is not only unpredictable [80], but very resource intensive [81]. Thus, these factors inherently narrow down the choices of languages suitable for embedded development, especially when dealing with real-time operations and resource constrained environments. Ultimately, careful language selection is crucial to ensure that the BREATHE project meets its performance requirements while effectively utilizing the limited resources of the STM32.

C: C is undoubtedly a strong choice for embedded system development. Not only is it the most common language used in embedded system development [82], but it has a plethora of advantages that make it arguably the most viable

option over other languages. One advantage that C has is that it has direct access to hardware and peripherals. This is crucial for embedded applications that require control over devices such as communication interfaces or sensors [80]. Moreover, C is able to produce compact and efficient code, and is able to efficiently utilize an MCU's resources when needed. This is important for embedded systems due to limited memory and performance constraints. C also remains as a ubiquitous choice for embedded systems, as it is the standard language used in not only the STM32, but also in Arduino, ESP32, TI, and many other microcontrollers. Further, C has its own variation, Embedded C [80], that is specifically optimized for embedded development. In summary, C remains as a substantial choice for a coding language due to its relationship with hardware, efficient utilization of resources, and ubiquity.

C++: C++ shares many of the same advantages that C has when it comes to embedded system development. Commonalities between the two include their close access to hardware, efficient utilization of resources, and widespread use in embedded systems [83]. A distinction that C++ has over C is that it is an object oriented programming language. Although there are concerns regarding the utilization of OOP in embedded systems, C++ can still serve as a powerful tool in embedded systems development when used carefully—by minimizing the use of OOP features and prioritizing low-level control.

MicroPython: MicroPython is an implementation of the Python programming language tailored for microcontrollers and embedded systems, much like how Embedded C is a derivative of C. One advantage that MicroPython has is its simplistic syntax. Since it is based on Python, it allows for code to be written that is not only more readable, but much simpler to develop compared to traditional languages such as C or C++. Furthermore, it has built-in libraries that make configuring peripherals like I2C much simpler than using C or C++ [84]. Another benefit that MicroPython has is its integrated Read-Eval-Print Loop (REPL), which allows for quick iterations and testing of code. This feature is very beneficial in an embedded environment, as it allows for fast debugging and testing [codeinst]. Additionally, MicroPython is supported in many STM32 boards, which can facilitate easy integration [85]. Despite its advantages and differences to C and C++, MicroPython has its disadvantages. C and C++ outperforms Micropython in terms of performance since it is an interpreted language rather than a compiled one [deep]. Therefore, it has slower execution time which can pose concerns to the real-time nature of BREATHE. Moreover, despite it being optimized for embedded environments, it's not only more taxing on memory than C and C++, but also has limited low level access to hardware. Lastly, MicroPython uses garbage collection, however it can be manually triggered or even disabled [86]. Conclusively, while MicroPython has

disadvantages like performance and resource limitations, it offers several compelling benefits such as rapid development and ease of use, making it a possible choice for BREATHE.

Java: While traditionally associated with desktop and enterprise applications, Java has established a presence in embedded environments, albeit in a very small capacity compared to other languages [82]. Like MicroPython and Embedded C, Java ME is a version of Java specifically optimized for embedded systems and mobile devices [87]. It provides APIs and tools designed for resource-limited devices such as *Connected Limited Device Configuration* (CLDC) [88], *Mobile Information Device Profile* (MIDP) [89], and Java ME SDK. A distinction that Java has over other programming languages is its portability, specifically through its *Write Once, Run Anywhere* (WORA) feature. WORA allows code that is written in Java to run on any platform that supports the Java Virtual Machine (JVM) without modifying any source code [90]. This means that the same Java code can be used across various architectures such as ARM, x86, and RISC without the need to adjust the code for specific hardware architectures, unlike languages like C or C++. While Java can be tailored for embedded environments, it still has its disadvantages. Not only does it use garbage collection, which cannot be disabled unlike in MicroPython, but it also has a substantially restrictive nature due to its reliance on the JVM. While this isn't inherently disadvantageous, it can introduce concerns within the context of embedded system development. The JVM introduces memory overhead, which can cause slower execution times and be a significant limitation for resource-constrained environments [91]. Additionally, the abstraction from the JVM limits direct access to hardware, making it difficult to optimize performance and interact with peripherals. Consequently, these restrictions can complicate development efforts and restrict the applicability of Java in many embedded scenarios, making lower-level languages like C more favorable for such applications [91]. While Java has some features tailored for embedded development, its reliance on the JVM introduces many concerns, including memory overhead, garbage collection, and limited hardware access.

Based on the requirements of the smart vent system as well as the embedded environment of an STM32, C was decided as the best choice as the programming language for BREATHE. Its direct hardware access, efficient utilization of memory, as well as its substantial support and ubiquity in embedded development make it a very strong choice as a programming language, especially given its real-time nature. C++ was another suitable choice, however it would require careful management of resources to avoid any performance deficiencies. MicroPython offers many advantages like simple syntax and built in libraries, however it is outperformed by C in terms of runtime

and management of memory. Lastly, Java also offers some benefits, however is inferior to C in terms of resource management and real-time capabilities.

	C	C++	MicroPython	Java
Object Oriented	No	Yes	Yes	Yes
Garbage Collection	No	No	Yes, can be manually enabled/disabled	Yes
Real-Time Capabilities	Excellent, deterministic and predictable behavior	Good, can be deterministic and predictable, requires careful resource management	Limited, slower performance may inhibit real time capabilities	Poor, garbage collection and JVM inhibits real time capabilities
Advantages	Direct hardware access, efficiently uses resources, ubiquitous in embedded systems	Direct hardware access, OOP capabilities (if used efficiently), ubiquitous in embedded systems	Simplified syntax, rapid development and prototyping, built in libraries	Portability, wide range of libraries
Disadvantages	Lack of OOP capabilities	Potential overhead from OOP	Performance limitations, interpreted nature, garbage collection (can be disabled)	Performance limitations, memory overhead, garbage collection

Table 24: Comparison between power supply options

3.9.2 Development Environments for the STM32

There are several development environments and tools available for programming STM32 microcontrollers. Each offers various features and capabilities that provide essential resources for coding, debugging, and optimizing the performance of the STM32.

STM32Cube: STM32Cube is a development environment platform made specifically for the ST-Line of microcontrollers. Due to it being specifically made for the STM32, it is designed to reduce development time, effort and cost [92]. It includes a broad range of tools and libraries to help streamline the development process. One feature is the *STM32CubeMX*, which is a tool that helps configure the settings and peripherals of the STM32 without needing to manually configure low level hardware such as clock speeds, peripheral functions, and pin assignments, as it automatically generates the code to initialize these components. Another set of features that are found in STM32Cube are various APIs such as *Hardware Abstraction Layer* (HAL) APIs and *Low-Layer* (LL) APIs that allow fine control and interfacing with hardware. Moreover, middleware tools such as RTOS, USB, and Touch sensing are included, which can help the integration of advanced functionalities without the need to write complex low-level code from scratch. In summary, STM32Cube serves as an essential resource for working with STM32 microcontrollers, offering a substantial set of tools, libraries, and middleware solutions that enhance productivity and support the creation of efficient embedded applications.

PlatformIO: Another development environment platform for the STM32 is PlatformIO. Rather than being made specifically for the STM32, PlatformIO is more generalized, supporting a wide range of microcontrollers, including Arduino, ESP32, and Nordic [93]. Furthermore, PlatformIO has an extensive library management, ensuring an ease of searching, installing, and updating libraries [94]. Moreover, it offers support for hardware debuggers designed for the STM32, such as the ST-Link. Although not made solely for the STM32, PlatformIO's extensive set of tools for embedded development makes it a respectable choice for a development platform.

Arduino IDE: Although associated with Arduino boards, it's actually possible to develop software for the STM32 using the ArduinoIDE. This is possible through additional configurations and libraries, such as the STM32 Board Support Package [95]. Additionally, the development process can be streamlined by leveraging existing Arduino libraries for peripheral interfaces such as I2C and UART, and applying them to the STM32. Despite the STM32's compatibility with the Arduino IDE, it lacks some of the substantial features offered by STM32Cube

and PlatformIO. Features such as HAL and LL are not supported, and direct access to complex debugging tools such as ST-Link isn't readily available within the Arduino IDE. Even though the Arduino IDE lacks these features, it still remains as a decent choice for developing software.

Wowki: Wowki, while not a dedicated IDE, can be a powerful tool for simulating and prototyping projects involving the STM32. It is an online electronics simulator that can be used to simulate both microcontrollers and electronic components [96]. Wowki not only provides an extensive selection of electrical components such as sensors, breadboards, and LCD screens, but also provides MCUs such as the STM32, Arduino, and ESP32. This can be very beneficial, as it allows for an ease of creating and testing circuit diagrams, facilitating rapid prototyping. While Wowki won't be used for actually integrating the STM32 within BREATHE, it is a very useful tool in prototyping and simulating theoretical implementations involving the STM32 and other electronic components.

Upon further research, STM32Cube was chosen due to its tailored features specifically designed for STM32 microcontrollers. It offers numerous advantageous tools, such as the STM32CubeMX tool, HAL, and LL APIs, which will enhance the efficiency of the development process, making it the best option for managing BREATHE's requirements. Additionally, Wowki will be utilized as a prototyping tool. Although it is not a dedicated IDE, Wowki serves as a powerful platform to simulate and visualize possible implementations involving sensors and LCD screens. While PlatformIO remains a respectable choice with valuable tools like extensive library management and support for complex debugging, STM32Cube was preferred for its similar advantages combined with optimized functionalities specifically designed for STM32 microcontrollers. Likewise, the Arduino IDE is also a viable option for developing software for the STM32; however, it is outperformed by STM32Cube due to the lack of the previously mentioned features. Overall, the selection of STM32Cube and Wowki both provide the necessary tools and capabilities to effectively develop and prototype the smart vent system.

Development Platform	Description	Key Features
STM32CUBE	A platform designed specifically for STM32 MCUs	STM32CUBEMX for hardware configurations, HAL and LL APIs, middleware such as RTOS, USB, and touch sensing
PlatformIO	A general purpose	Extensive library management for

	environment supporting many types of MCUs including the STM32	easy searching, installing, and updating of libraries. Supports STM32 debuggers like ST-Link
Arduino IDE	A platform designed for Arduino boards, but can be conFIGured for the STM32	Supports existing Arduino libraries for peripherals (I2C, UART), and STM32Cube's advanced features (HAL, LL APIs) and debugging tools. Suitable for simpler STM32 development.
Wowki	An online simulation tool for MCUs and electronic components	Useful for rapid prototyping and circuit simulation with components like sensors and displays. Allows visualization of potential STM32 applications without real hardware, though it's not intended for full development or integration.

Table 25: Table comparing different software environments for the STM32

3.9.3 Graphic Libraries

The STM32 microcontroller family is widely recognized for its flexibility and powerful performance. One particular advantage that the STM32 has is that it is highly compatible with various graphical libraries, providing smooth integration for creating a friendly and intuitive user interface. Its compatibility with popular libraries such as TouchGFX, STemWin, and LVGL allows for an ease of development for a wide range of graphical applications.

TouchGFX: Designed specifically for STM32, TouchGFX is a powerful, free graphic software framework that enables the creation of high-quality graphical user interfaces (GUIs). It comprises the TouchGFX Designer, an intuitive drag-and-drop tool for easy graphic building, and the TouchGFX engine, which offers optimized rendering capabilities. A massive advantage of TouchGFX is that it has automatic code generation, which automatically generates the necessary code once the GUI is designed, significantly simplifying the development process. Additionally, TouchGFX supports a variety of customizable widgets, dynamic interactions, and comprehensive text handling, making it easy to develop user-friendly applications. Fully integrated within STM32Cube MCU Packages and compatible with STM32CubeMX, TouchGFX

ensures seamless co-development of graphics and main applications in a unified environment, making it a power choice for creating high-quality graphical applications [97].

STemWin: STemWin is another graphical stack library designed specifically for the STM32 that leverages STM32 hardware accelerations whenever possible [98]. STemWin features an extensive selection of widgets such as buttons, checkboxes, and calendars. It also has advanced capabilities such as JPEG, GIF, and PNG decoding. It has development tools such as GUIBuilder, which similar to TouchGFX, uses an initiative drag-and-drop tool interface. Moreover, it includes features that help save memory as well as support for antialiasing.

LVGL (Light and Versatile Graphics Library): LVGL is an open-source graphical library designed for embedded systems, including the STM32 family. It is optimized for resource-constrained environments, enabling the creation of visually appealing user interfaces with low memory usage. Like STemWin and TouchGFX, LVGL supports a wide variety of graphical widgets, such as sliders, buttons, and charts. Moreover, it supports more advanced features, such as animations. Its efficient rendering capabilities, including anti-aliasing and real-time widget management, help save RAM by dynamically creating only currently visible elements [99].

Graphic Library	Description	Key Features
TouchGFX	A GUI framework specifically for STM32, enabling high-quality graphical interfaces.	TouchGFX Designer for drag-and-drop GUI design, automatic code generation, a variety of widgets, and optimized rendering. Seamlessly integrates with STM32CubeMX for co-development of graphics and applications.
STemWin	A graphical stack for STM32, using STM32 hardware accelerations to enhance performance.	Offers a wide range of widgets (buttons, checkboxes, calendars), image decoding (JPEG, GIF, PNG), GUIBuilder tool, memory-saving features, and antialiasing support.

LVGL	Open-source library optimized for embedded systems, including STM32, to create user interfaces in resource-limited environments	Provides various widgets (sliders, buttons, charts), supports animations, and has efficient rendering features with real-time widget management and RAM-saving capabilities.
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Table 26: Graphics Libraries Comparison

4.0 Relevant Standards and Design Constraints

4.1 Design Standards

This section will discuss the relevant standards applied in the project, particularly those associated with communication protocols, air quality, PCB development, and software development

With the design and implementation of BREATHE, adherence to industry standards is crucial. Standards ensure reliability and safety across the various components and technologies that will be used within the smart vent system. By following established guidelines for aspects like data transmission and sensors, the system will meet important performance and safety requirements. Additionally, compliance with regulatory frameworks governing wireless communication protocols, such as Bluetooth BLE, and the electrical integrity of system components will ensure seamless integration. This adherence guarantees the system's operational stability, longevity, and compliance with technical regulations.

4.1.1 Communication Standards

Bluetooth Low Energy (BLE) Standard: Bluetooth Low Energy (BLE) is a wireless communication standard that is designed for short range and low power operation [100]. BLE operates in the 2.4 GHz band and has a very low range of power which ranges from 0.01mW to 100mW [101]. BLE also leverages several methods that enhance its reliability, such as a frequency hopping transceiver, amplitude shifting keying modulation and shaped binary frequency modulation, as well as frequency division multiple access (FDMA) and time division multiple access (TDMA).

BLE is heavily based on the architecture of the general Bluetooth core system, leveraging a dual stack system that includes both traditional bluetooth and bluetooth low energy. At a high level, this system consists of both a host and a controller. The host layer manages numerous high-level protocols such as *Attribute protocol/Generic attribute profile* (ATT/GATT) and the *Security Manager Protocol* (SMP). These protocols handle device discovery, data exchange, and security in BLE communications. Moreover, it also includes a *Logical Link Control and Adaptation layer* (L2CAP), which is responsible for managing the flow of data between the host and controller. The controller section manages both BLE and traditional bluetooth operations. More specifically, the BLE controller handles the physical transmission of data and manages links with other BLE devices through the Link Manager and Link Controller [101].

BLE also employs several procedures for device communication. It begins with the advertising procedure, which allows devices to broadcast data without connections, making use of both the primary and secondary channels to mitigate congestion of data. Next, the scanning procedure listens for unidirectional broadcasts of data from any advertising devices casting data. Within this procedure are scanning devices, which can request additional data and initiate connections. The discovering procedure allows devices to find any other ones over a given proximity. Once discovered, devices will use connected mode to maintain communication. Finally, periodic advertising is used to synchronize broadcasts for data consistency, and decision-based scanning is used to optimize data handling by filtering out any packets that each device is not using.

The Bluetooth Low Energy (BLE) standard significantly enhances the development of the smart vent system by providing energy efficient and reliable communication between multiple devices. This standard is extremely viable, as it will allow the two STM32 microcontrollers to communicate together effectively while saving a significant amount of power. The aforementioned features mentioned also highlight BLE's positive impact on the smart vent system. Its low range of power facilitates a longer life span, especially since the MCUs will communicate often with each other. Moreover, the modulation methods that BLE employs, such as its frequency hopping transceiver and amplitude shift keying modulation mitigates signal interference and fading, which helps protect the integrity of communication between the two MCUs. FDMA and TDMA also assist in preserving the robustness of signals being transmitted by reducing signal congestion and interference that are transmitted from devices.

The previous features mentioned highlight BLE's positive impact on the smart vent system. Its low range of power facilitates a longer life span, especially since

the MCUs will communicate often with each other. Moreover, the modulation methods that BLE employs, such as its frequency hopping transceiver and amplitude shift keying modulation mitigates signal interference and fading, protecting communication integrity. FDMA and TDMA also assist in preserving the robustness of signals being transmitted by reducing congestion and interference that are transmitted from devices.

Furthermore, the BLE architecture enhances the design of BREATHE. In the host layer, ATT/GATT protocols allow for an efficient transmission of data by defining a simple protocol to discover, group, and access data services and characteristics. Additionally, the L2CAP layer helps guarantee smooth communication and data flow between devices by reducing latency and fastening system response. This aspect is particularly advantageous, as it allows the MCU that manages the environmental sensors to quickly relay data to the MCU responsible for controlling the vent. Subsequently, the architecture of BLE also integrates numerous security features such as encryption and authentication using a method called *Counter with Cipher Block Chaining-Message Authentication Code* (CCM) [101], which ensures data integrity and packet security [101]. While security isn't necessarily a big area of concern, it remains an important consideration to ensure the data being transmitted is protected.

BLE procedures also enhance the functionality of BREATHE. The advertising procedure allows for unidirectional broadcasts to be made between the two MCUs, which eliminates the need for a physical connection between them. This allows for the two MCUs to communicate wirelessly, making it both practical and efficient for indoor environments such as residential and commercial spaces. Moreover, the scanning and discovering processes enable quick identification and connection between devices, facilitating seamless interaction between the microcontrollers. In the connecting mode, a reliable and continuous link between the MCUs will be able to be established. Also, a method called *connection subrating* [101] can help with reducing power consumption by allowing the MCUs to reduce their active duty cycle without sacrificing communication strength, contributing directly to a longer life span. Additionally, decision-based scanning optimizes data handling by filtering irrelevant packets, which further conserves power.

In conclusion, adhering to the Bluetooth Low Energy (BLE) standard is pivotal for the successful operation of the smart vent system. Its utilization of efficient communication protocols as well as reliable data transmission methods help the interactivity between the two STM32 microcontrollers, and its architecture supports reliable data exchange while maintaining security. Overall, BLE's

capabilities not only improve operational efficiency but also contribute to a longer lifespan for the smart vent system, making it an ideal standard to conform to.

I²C Standard: The I²C standard is based on the UM10204 I²C-bus specification and user manual. It is one of the most common communication protocols, being implemented in over 1000 different ICs that are manufactured by more than 50 companies. I²C has distinguishable characteristics compared to other methods of communication. One feature is its dual-bus topology. As its name suggests, it uses two wires, serial data (SDA) and serial clock (SCL) to carry information between any device connected to them. Furthermore, each line allows for bi-directional data transfers, which contrasts with other protocols like SPI or UART where separate lines are used for transferring data. Another distinguishable trait are software addressable devices with unique addresses. While this feature is found in other communication methods, I²C's differentiates itself by using a master/slave device relationship that doesn't require a dedicated master device. Moreover, I²C supports multiple masters and includes collision detection and arbitration that prohibits devices from interfering with each other. I²C will greatly benefit the smart vent system, as both the temperature sensor and CO₂ sensor utilize this protocol for communication. Its simplicity and straightforward design allows for the seamless integration of multiple slave devices. By using I²C, these sensors can easily be interfaced with the STM32 microcontroller, reducing the complexity of wiring and allowing each device to bidirectionally read and write to each other.

SPI Standard: The Serial Peripheral Interface (SPI) is a synchronous serial communication protocol used to connect a master device, typically a microcontroller, to one or more slave devices. It operates using a 4-wire interface consisting of numerous transmission methods. The first one is MOSI (Master Out Slave IN), which is for data sent from the master to the slave. Secondly, SPI uses MISO (Master In Slave Out) for data sent from the slave to the master. Next, is SCK (Serial Clock), which is generated by the master to synchronize data transmission. Lastly is CSB (Chip Select), a low active signal that selects the slave devices for communication. Data is transmitted in a master-slave configuration where commands and data are shifted bit by bit, with the most significant bit (MSB) sent first. Communication begins when CSB is pulled low and ends when CSB is pulled high, allowing for both read and write operations. The maximum SPI clock frequency is typically 500 kHz, enabling data transfer rates of up to 6600 samples per second per channel for specific commands. While both I²C and SPI utilize a master-slave relationship when transmitting data, SPI differentiates itself from I²C by using full-duplex

communication rather than half-duplex. This means that data can be sent and received simultaneously, resulting in lower latency. In BREATHE, the SPI interface will be crucial for enabling communication between the microcontroller and LCD touch screen. This high-speed protocol will facilitate rapid data transfer, ensuring that user inputs and sensor data can be displayed and processed in real time. The fast response time provided by SPI will enhance the user experience by allowing for smooth and responsive touch interactions, which is essential in applications that require immediate feedback [102].

4.1.2 PCB Design Standard

IPC-2221 Generic Standard on Printed Board Design: IPC-2221 is a widely recognized standard regarding PCB design. It provides basic information regarding the general requirements for PCB design as well as discusses design recommendations and principles, such as material selection power distribution considerations, electrical performance, component routing, and general placement requirements [103]. The standard ensures that PCB designs meet critical requirements for manufacturability, reliability, and performance for many applications. Since BREATHE will incorporate two separate PCBs—one for the LCD screen and sensor system to display information and gather environmental data, and the other for the motor system to adjust the vent cover—ensuring the proper design for both is critical. IPC-2221 provides essential guidelines for optimizing these PCBs, from managing signal integrity and thermal dissipation on the sensor and LCD PCB to addressing noise control and current-carrying capacities for the motor PCB. These design principles will enhance performance, minimize interference, and ensure reliable operation [103].

For the PCB with the MCU, sensors, and LCD screen, IPC-2221's guidelines on component placement, trace routing, and power integrity not only help make the design of the PCB board more organized, but also aid in managing the varying power and signal requirements for each part. For example, with respect to component placement, the standard recommends that through-hole parts should be mounted on the side of the PCB board opposite to the side that will be in contact with the solder. It also considers orientation and accessibility, stating that components should be mounted parallel to the edges of the printed board [103], and electronic components should be spaced so that they are not obscured by other components. IPC-2221 also provides considerations regarding the power and signal integrity concerns. For example, it indicates that a low RF impedance should be maintained throughout the DC power distribution, as a design with an improperly incorporated ground can lead to RF emissions. Likewise, the standard also recommends isolating circuits with large

frequency differences (i.e, low frequency and high frequency circuits in order to minimize possible interference [103].

Additionally, the standard highlights that power supply design must take adequate thermal dissipation into account. Section 7 outlines thermal management requirements, and emphasizes several factors such as the method of heatsink mounting, soldering temperature requirements, and use of dielectric materials [103]. For the PCB with the motor, power consumption will likely be the highest as a result of the motor's stall current. By adhering to the IPC-2221 standard, incorporating a power supply within the PCB that is conscious of thermal dissipation is important. Section 7 outlines thermal management requirements, and emphasizes several factors such as the method of heatsink mounting, soldering temperature requirements, and use of dielectric materials [103]. IPC-2221's recommendations on trace widths and clearances also help prevent overheating and ensure current-carrying capabilities are sufficient for the motor. Moreover, the PCB with the motor may face issues managing noise from the motor's switching operations and protecting the board from electrical transients that could damage the MCU. The standard has information that can address this concern, as section 6.4.6 deals with managing switching noise, and recommends techniques such as the integration of decoupling capacitors and smaller vias to handle this. This is particularly relevant for mitigating noise from the motor's switching operations and protecting the MCU from electrical transients [103].

Overall, by adhering to IPC-2221 guidelines, BREATHE will ensure that both PCBs will be designed for optimal performance, reliability, and safety, addressing key considerations such as thermal dissipation, noise management, and power distribution, which are essential for the system's long-term functionality.

4.1.3 CO₂ and Temperature Standards

NIOSH Standard for CO₂ Exposure: The National Institute for Occupational Safety and Health (NIOSH) provides guidelines detailing the numerous impacts of CO₂ in a workplace environment. It specifies the recommended airborne exposure limit over a 10-hour work shift is 5000 ppm. Moreover, it also indicates that a concentration of 30000 ppm should not be exceeded at any time within a 15-minute work period. NIOSH also emphasizes the risks associated with being exposed to elevated levels of CO₂. When CO₂ levels exceed 5000 ppm, NIOSH highly recommends using a NIOSH approved air-supplied respirator or an auxiliary breathing apparatus. Additionally, when CO₂ exceeds 40000 ppm, NIOSH classifies this as life-threatening and strongly advises to use a full

facepiece and an emergency escape air cylinder on top of a NIOSH approved air-supplied respirator. NIOSH also provides information about both short term and long term effects of exposure to dangerous levels of CO₂. Short term effects outline symptoms of both initial contact and prolonged exposure. Initial contact symptoms may include irritation of skin and eyes, and prolonged exposure may result in headaches, difficulty in breathing, and death. Long term effects include an increased risk of cancer and reproductive hazards. Lastly, NIOSH provides instructions on how to manage CO₂ in workplace settings. This includes how to handle CO₂ leaks, protocols on operating and storing CO₂, and workspace safety practices when working in environments with elevated CO₂ levels. Understanding the risks of high levels of CO₂ as well as knowing when CO₂ levels start to become dangerous is very important. It not only provides guidance on defining what is considered dangerous for the CO₂ sensors, but also helps determine what is a sufficient range for a reliable CO₂ sensor. Moreover, knowing the risks of hazardous CO₂ levels highlights the importance of prioritizing the safety of users who use the smart vent, justifying the inclusion of features like LCD screen warnings and a buzzer to alert users [104].

OSHA 2017 Standard for CO₂ Levels: The Occupational Safety and Health Administration provides similar guidelines to NIOSH regarding the exposure limits of CO₂. Instead of using the *Recommended Exposure Limit* as a metric for defining a recommended limit, it uses the *Permissible Exposure Limit* to determine the maximum safe threshold for CO₂ levels. It is the same as NIOSH, being at 5000 ppm, however it is measured during a 8 hour work period rather than a 10 hour work period. Furthermore, along with the NIOSH standard, understanding the exposure limits as described by OSHA standards helps further contextualize what is a sufficient range to configure the CO₂ sensors [104].

ASHRAE 62.1 Standard: The American Society of Heating, Refrigerating, and Air-Conditioning Engineers guidelines for indoor air quality highlight various implications regarding CO₂ levels. It emphasizes that CO₂ concentrations above 1000 ppm may indicate potential inefficient ventilation methods and a higher average of CO₂ levels may be an indication of poor air mixing. Moreover, inconsistent levels of CO₂ that are measured overtime may result in misleading low readings. Elevated CO₂ levels can indicate factors such as increased occupancy, insufficient air exchange rates, and poor air distribution. Due to a possible fluctuation in CO₂ levels, the standard highlights the importance of choosing a well calibrated and reliable CO₂ sensor. The SCD41 adheres to this, as it comes pre-calibrated and doesn't require external calibration. Likewise, the standard highlighting variables like poor air mixing and inefficient ventilation allows for extraneous variables to be mitigated by recommending the use of

tools such as temperature profiles to remove any potential CO₂ measurement discrepancies. This will ensure accurate and reliable environmental data [105].

ASHRAE Standard 55: ASHRAE Standard 55 details various temperature ranges in regards to maintaining thermal comfort in indoor environments. It focuses on the balance between air and radiant temperature while also taking factors such as clothing insulation and metabolic rate into account. One method that the [106]. ASHRAE standard utilizes the *Analytical Comfort Zone Method*, which establishes metrics such as clothing insulation, metabolic rate, and airspeed to determine the comfort in a room with respect to temperature. For instance, ASHRAE states that at a clothing insulation level of 1.0 is correlated to a cooler temperature range spanning from 68°F to 77°F). Conversely, a lower clothing insulation level of 0.65 is correlated to a temperature range spanning from (73.4°F to 80.6°F). Moreover, the *Elevated Air Speed Comfort Zone Method* takes airspeed into account, indicating that each temperature limit fluctuates when airspeed exceeds 0.2 m/s. The information provided by the ASHRAE Standard greatly contextualizes what temperature ranges are considered comfortable and uncomfortable. By understanding the information given by this standard, BREATH's software can define acceptable temperature thresholds, thus allowing for the vent to more accurately change the airflow going into indoor environments [106].

4.1.4 Software Standards

C Standard: As of 2024, the C programming language standard is based on C18 (ISO/IEC 9899:2018) [107]. However, the most recent standard in development is C23 (ISO/IEC 9899:2024), which is expected to release sometime in October or November of 2024. The C standard is very important as it defines the core specifications needed to write reliable programs. The standard outlines numerous aspects, such as C's syntax, which are the formal rules for writing code, and constraints that determine what is allowed or not allowed within the language. Moreover, the C standard also specifies the representation of both input and output data, as well as various functions that C provides [107]. Since BREATH's software will be developed in C, it is important to closely adhere to C's standards. Doing so ensures reliability by enforcing rules that not only prevent undefined behavior, but also makes sure that fundamental concepts like memory management and standard library functions behave consistently within implementations. More particularly, this is crucial in embedded environments, where even minor inconsistencies can lead to significant errors.

4.1.5 Safety Standards

IEC 61508 Standard: The IEC 61508 standard, developed by the International Electrotechnical Commission outlines aspects to be considered when electrical/electronic/programmable electronic (E/E/P) components are utilized to carry out some kind of safety function [108]. Two central objectives of this standard are to facilitate the development of safety within systems that use E/E/P components as well as enable the development of other safety standards in sectors where such standards are lacking [108]. For instance, section 6 details various responsibilities and actions that should be considered if a system intends on incorporating some kind of safety function. For example, subsection 6.2.9 indicates that procedures will be developed for maintaining accurate data with respect to hazards/hazardous events, safety functions, and the safety of E/E/PE systems [108]. This directly applies to BREATHE, as both the CO₂ and temperature sensor will be responsible for obtaining accurate environmental data for the user. Furthermore, the selected sensors (the TMP102 and SCD41) have been optimized for obtaining very accurate readings, and will have software-defined thresholds established based off of standards such as ASHRAE and OSHA. These considerations not only have not guaranteed both the reliability and accuracy of each sensor, but also facilitate immediate safety responses whenever hazardous conditions are detected. By adhering to these guidelines, BREATHE will be able to facilitate an environment that is prepared to handle hazardous situations.

IEC 60364 Standard for Low voltage electrical installations: The IEC 60364 standard provides requirements for initial and periodic verification of electrical installation regarding systems with low voltage. This is especially important for BREATHE, as every component operates within a 3.3 to 5 voltage range. (verify this group). IEC 60364 covers numerous requirements such as installation verification, tests for verification, and fault protection. For example, section 6.4 outlines initial verification of a system, stating that every installation of a component must be verified during development before it is finalized [109]. It further emphasizes that precautions must be done in order to verify danger and damage won't be caused to people, livestock, or equipment, even if the circuit is defective [109]. Moreover, testing methods such as testing for polarity are outlined. Section 6.4.3.6 stresses to verify that wiring has been correctly connected to socket-outlets and similar accessories during a polarity test.

Fault protection is another area covered by IEC 60364, focusing on verifying that the installation has sufficient protective measures in place to protect the system and users from electrical faults such as short circuits. More specifically, section 6.4.3.7.1 stresses to verify the characteristics and effectiveness of protective

devices or methods that contribute to them such as voltage regulation, including methods like simple visual inspections or looking at current ratings for fuses [109]. Properly functioning fault protection ensures that dangerous conditions like electric shock or fires are mitigated. Electrical installations of each component within BREATHE must be thoroughly inspected to ensure both the safety and operational reliability of BREATHE. Verifying aspects such as potential damage or defective components is essential. Moreover, preventing dangerous incidents like electric shocks or fires remains imperative to ensure the safety of users and the continued reliability of the system under all operating conditions.

4.2 Design constraints

As engineers we will all have to deal with design constraints for the rest of our lives. Constraints are what fundamentally define our capabilities and boundaries within a design. Depending on the project at hand, constraints can range from the time given to complete a project, or the budget of a project to technical constraints like the size of a component, power supply capacity or mechanical capabilities. As such they are the most important part to any project.

4.2.1 Time Constraints

One of the main constraints of this capstone project is time. This is primarily due to the fact that the team only has two semesters to bring their design to a complete and fully working product. These time constraints as a team begin with the fact that we only have about a week and a half to think of an idea for this project. With that being said, not only does that involve research as to what ideas can be feasible and implemented within the two-semester time frame but it also involves various discussions as a team to find out our respective goals to achieve within a capstone project along with our capabilities as engineering students.

At the start the team is only given two weeks to think of an idea, decide how to appropriately implement the concept and write a ten page report detailing such along with determining nine key engineering objectives to achieve within the limited time frame. The team then has one month to research and select different components to facilitate their designs and complete a sixty page report detailing such discoveries. The remaining time in the first semester, which is one month, consists of designing the hardware and software for their design, ordering their chosen components, prototyping and initial testing along with writing the remainder of the one hundred and twenty or more page report. Most engineering students aren't dedicating their sole time to senior design and creating their

designs because they are taking other classes, labs and even working jobs or internships alongside senior design. Time management is such a critical component of senior design and can really weigh on a student's morale at times.

Shipping times for certain components can also arise complications with stock of items, back ordering and general transportation delays. Living in Florida weather also plays into the effect of the time constraints of our project, with the fall semester falling in peak hurricane season, weather delays can impact component shipping and research for the team. Due to some recent hurricanes, classes were canceled for a week and a half and most of our team members even lost power for several days while classes were canceled. This greatly impacted productivity as the 'free' days off from classes that could have been used to completely focus on research and documentation writing were wasted due to having no power and internet connectivity.

Aside from these aforementioned perspectives of time constraints, when comparing the actual time given for this team to complete this capstone project to the engineering industry where they have years of experience and time to complete research and development before even beginning to prototype it's clear to see how astounding it is to see these senior design projects come to life in such a compact amount of time.

4.2.2 Budget Constraints

Budget is yet another crucial constraint within engineering projects. Not only does this team have a budget constraint of two thousand dollars, but we have a moral obligation as young college students to make our product affordable for the consumer. As a team we are very grateful for the opportunity to have Dr. Qun Zhu Sun sponsor our design, but it is also very important for us to not take advantage of Dr. Sun's generosity. As such we have been careful to not only be considerate and select the most adequate components for our design but to also factor in cost so as to not exceed budget constraints. It is imperative that we consider such constraints in order to guarantee the success of the project.

One of the most expensive components to consider in our project is the Microcontroller Unit selection. After a careful analysis of seven different MCU's based on power consumption, Bluetooth Low Energy, ease of integration, and cost, we ultimately decided as a team to select the STM32WB55 mainly because of its low power consumption both in sleep and active modes. Though the cost is much more than similar MCUs, we found this expense to be necessary to ensure the vent interaction subsystem can last as long as possible off of battery power.

Another component that we found to be quite expensive is the carbon dioxide sensor. This was one of the more niche components to look for, but it was necessary for the core of our project so finding an accurate sensor was very important. Unfortunately, possibly due to their niche nature, many of the carbon dioxide sensors we found were very expensive, with most of them running above \$40. We determined most of these were accurate enough for our needs, so we decided to choose the cheapest one that was still reputable.

One of the most important components of our project is a functional motor, a component that can easily become expensive depending on its specifications. It's crucial to choose a proper motor to control the vent's movements while also maintaining a reasonable power consumption. The cost of these motors range heavily to provide a combination of either large amounts of speed or torque. Examining different motors and mechanical designs, we've managed to find a selection of motors that optimized the amount of power necessary while minimizing the cost.

Although having a sponsored senior design project has many advantages and truly lifts the financial burden off of the students' shoulders, it can also create some limitations. For example, as our sponsor is a member of the University of Central Florida Faculty, they not only are teaching several classes but they are the director of the Smart Infrastructure Data Analytics Laboratory, the associate editor of the Institute of Electrical and Electronics Engineers (IEEE) transactions of Smart Grids, the secretary of the IEEE Smart Buildings, Loads, and Customer Systems (SBLC) committee, and are currently participating in 3 separate research projects; This makes our sponsor hard to get in contact with at times and as such causing further delays. With our heavily decorated sponsor juggling multiple roles they don't necessarily have time to go over every single component selection and cost with a fine-toothed comb, this puts the paramount job of critically analyzing our selections with respect to budget in our hands. This responsibility not only educates us on the principles of budgets but prepares us for the real world of engineering.

4.2.3 Size constraints

Yet another design constraint to consider is size constraints. Since this project involves automating the louvers of a ceiling vent it is critical that as a group we consider the dimensions of the vent and its available space in the duct in order to guarantee as per our specifications that our vent design can fit inside a standard vent duct. With that being said each component that we researched and selected needed to be as small as possible. For this, we tried to use batteries that were sized to fit into the vent while still being able to last as long

as we specified. We also needed to limit our PCB footprint, which requires using small component packages and fewer components if possible.

4.2.4 Ethical Constraints

With sourcing the components, we also have to consider the Ethical Constraints. Not only as a team of students pursuing this project to fulfill our degree requirements, but also as future engineers wanting to create something that can be useful and helpful to society. As a team we also chose to only source our components from companies that we consider to be of high societal and ethical value. It is important that as members of society that we don't contribute or promote unethical working environments such as companies that use child labor, slavery, or poor working environments. The team is also actively working to protect users personal data such that our temperature or carbon dioxide sensor readings are adhering to piracy laws and we can ensure data security and confidentiality. Since battery life is so pivotal for our project, as a team we also are aware of choosing ethical environmentally conscious components that minimize our energy footprint. Low power mode is a crucial aspect to our project's longevity being successful and something we take

5.0 Comparison of ChatGPT with other Similar Platforms

With the recent boom in Artificial intelligence (AI) within the last couple of years in the technology sector, it's no wonder that so many different uses for AI have become easily available to everyone. Depending on who one would ask in the general population, the viewpoints of artificial intelligence can range from, totally for it to completely against it. Large Language Models (LLMs) are the most commonly used AI platforms today. One of the more widely known LLM platforms is ChatGPT, but following closely behind them are Microsoft Copilot, Google Gemini, Meta AI and more.

5.1 Large Language Models

Large language models are a type of Artificial Intelligence algorithm which use deep learning and enormous data sets in order to “understand, summarize, generate and predict new content” [110]. LLMs work by training the models, one of the training methods is called ‘unsupervised learning’, which is essentially a type of machine learning in which the model derives relationships between different concepts without the need for human intervention [110]. These models are also trained using information such as various articles, books, and websites to really understand how language works and how humans communicate. The

various LLMs don't think for themselves though, they utilize the patterns they have learned in order to formulate the best response.

5.2 Microsoft Copilot

Copilot was created by Microsoft and is the successor to Cortana. Cortana began as a 'virtual assistant' helping PC users perform basic tasks such as getting the current weather report, answering questions, and setting reminders. Cortana was Microsoft's response to Apple's widely known Siri where it would also pull information from the users' local device or connect to the internet for more information. Microsoft saw how Cortana had fallen behind with respect to its competitors and so they began developing Copilot. Copilot was released to the public on November 1st, 2023, and was marketed to be "your everyday AI companion" [111]. Coming in Stock with Windows 11 Copilot was also integrated with all Microsoft 365 products, Edge, and Bing. With this update, Microsoft also incorporated the AI within several of its applications such as, paint, photos, the snipping tool, Clipchamp, and notepad.

Some advantages to Copilot are improved productivity, and integration within the Microsoft ecosystem. The amalgamation of Copilot within Microsoft 365 greatly benefits the user experience and allows the user to focus on the creative personal aspects of their work by giving copilot the monotonous tasks, such as "drafting emails, generating reports, and analyzing data" [112]. This seamless integration provides the capability of a user to be more efficient and productive with their time so as to not worry about the little things such as, did they format that email properly, or is their presentation in PowerPoint of high quality that their company requires. Some disadvantages include high cost, connectivity issues, and privacy concerns. If a consumer already has a Microsoft subscription, then Copilot is automatically included, although if a user wants to just use the full version of Copilot, then they would need to pay either a monthly fee of \$30 or a yearly fee of \$360 [111]. As far as connectivity issues are concerned for Copilot, it seems that a constant internet connection is required, which greatly reduces the flexibility of this platform. For users that often work in environments with unstable internet connections or offline environments such as airplanes then their capabilities with copilot are limited.

5.3 Google Gemini

Google Gemini, created by Google AI is a powerful AI chatbot that was developed and released in February 2024 as a response to its fierce competitor ChatGPT. Google Gemini has four separate large language models implemented

within its AI they are, Gemini Ultra, Pro and Nano [113]. Each LLM within Google Gemini is set with different versions of the platform, to correspond with the sizes and capabilities. The main capabilities of this platform involve answering questions, generating code and summarizing information. Currently Google Gemini is integrated within the google ecosystem with applications such as YouTube, Gmail, the Google website, and Google Maps [113]. While the basic version of this platform is free, the advanced versions of Gemini cost around \$20 dollars a month.

Advantages to Google Gemini include variety and google application integration. Since Google Gemini can complete and process multiple types of user inputs such as images, questions, and suggestions, its variety is on clear display as it can analyze an image that incorporates text at the same time. Furthermore, the ease of Google Gemini being incorporated within applications that are used daily benefit users without them even realizing. For example, you can open the google website to complete a search and alongside the link results to your query a Google Gemini response will automatically generate and often provide the answer the user is looking for without them having to look through various links to find what they need. Disadvantages to this platform would be that because it works best within the google ecosystem it limits its ability and usefulness in other application settings.

5.4 Meta AI

Meta AI is an artificial intelligence driven chatbot assistant developed under the parent company of Meta Platforms Inc. which was formerly known as Facebook. The AI.Meta website describes Meta as an AI that, “helps you learn, create and connect in new ways” [114]. Meta boasts that with their platforms users are able to talk with recognizable voices and share images in order for them to learn more about their surroundings [114]. The application was built using the Llama 3 large language model which is a program that can recognize and generate text and images. Meta AI was first announced in September of 2023 when it was pre-installed in the Ray-Ban Meta smart glasses. Since then it has been gradually released to the public across the globe and among various Meta social media applications. Meta AI is currently available for free to all users and is embedded within Facebook, Instagram, Messenger and WhatsApp along with its own website Meta.ai [114]. Some of the ways Meta AI can help users is by automating text message responses, help with planning events, generate suggestions and images within a conversation, answer questions and provide insights during chats [115].

Meta AI at first glance has several advantages such as user experience convenience and business benefits, however a major disadvantage is privacy. Over half of the world's population are users of various social media platforms and Facebook, which has Meta AI integrated, is still the most widely used social media platform of them all. With this large usage of social media, it is no secret that the world is constantly giving and receiving information within this space. As such, content creation is inevitable if one is a social media user and with Meta AI's abilities, content creation has never been so significantly easier. Meta AI can create and edit unbelievable images, make captions for said images, along with generating suggestions to make the users current creations even better. The business benefits to this platform are also noteworthy in that Meta AI can manage content by scheduling the content to be posted at the peak times where it can be seen by the largest audience, it can also supply the creator with insights on how the posts are being interacted with by the audience. All of these tools that Meta AI has under its belt greatly optimizes a creator's marketing efforts. The main disadvantage with this platform though is its user privacy. It is well known that Facebook, now known as Meta, has gone to court and been fined exuberant amounts of money for their privacy violations. It only makes sense that since they have been so careless in the past that Meta AI doesn't fall too far from the tree so to speak. Meta AI currently utilizes public Facebook and Instagram images as a part of training for its learning model, and there are current issues with certain countries not being allowed to 'opt out' of these mass content scrapings. Living within a somewhat ethical society this violation of privacy deters new users from utilizing Meta AI and ultimately making Meta AI an ethically flawed platform.

5.5 ChatGPT

ChatGPT is an artificial intelligence AI chatbot that has exploded into everyone's homes all over the world. The artificial intelligence research company Open AI created ChatGPT and released the platform to the general public in November 2022 [116]. The GPT in ChatGPT stands for "Generative Pre-trained Transformer", and much like the abbreviation suggests it refers to how the platform processes requests and formulates responses" [116]. The way Open AI trains the ChatGPT platform is through a machine learning (ML) technique called "reinforcement learning through human feedback" (RLHF) [116]. Reinforcement learning through human feedback performs tasks asked by humans and incorporates their feedback in a reward function in order to align with "human goals, wants and needs" [117]. This way of RLHF training is implemented in ChatGPT with a thumbs up or thumbs down button that a user can select to rate the prompt responses. ChatGPT's capabilities have progressed to great extent,

in its initial roll out it was mainly a question and answer platform with answers ranging from somewhat correct to extremely wrong. The current knowledge cutoff date for the platform is late 2023 and it can now go way beyond simple questions and answers. Since conception of the platform one of the new duties ChatGPT can perform is to run python code directly to assist with data analysis, simulations, graph plotting and calculations. ChatGPT can now also accept attachments for evaluation and create images based on detailed descriptions. One of the most significant ways ChatGPT has improved is with its ability to retain and reference previously shared information with the platform, this has extraordinarily enhanced the user experience and efficiency of conversations. It is clear to see how ChatGPT has dominated the AI chatbot space and become almost a household name in regards to AI. Additionally, this platform has now incorporated real time internet browsing for the most up to date information.

It's safe to say that ChatGPT is a multifaceted tool which can be extremely beneficial to anyone. Advantages to using ChatGPT include enhanced user efficiency, diversity, and personalization. Disadvantages of Open AI's ChatGPT include misinformation and privacy concerns. With all of Open AI's upgrades to ChatGPT user efficiency has skyrocketed, the platform's ability to quickly handle mundane tasks, and answer any questions that come its way have freed up a great deal of time for users to focus their attention to more important parts of their projects. This platform has become the most famous AI chatbot for its diversity, it has a range of abilities from image generation, to solving complex math problems. ChatGPT's personalization features are also a plus due to the platform's ability to reference the prior conversations a user has had with the platform with this knowledge ChatGPT can tailor its responses based on the users preferences [116]. Although there are a lot of advantages with using ChatGPT misinformation is still a concern, inaccurate or unverified information is highly possible with the current training data used. Even though Privacy is taken seriously at Open AI the retention policies in effect could also potentially expose sensitive information and thus users should be weary when sharing such information.

Some of the ways ChatGPT could assist us in our senior design group would be in deciphering various high level language documents, examining pdf's to locate crucial information, suggest components for selection, give basic ideas on how to implement certain designs, along with proofreading and assisting with debugging and troubleshooting. On the other hand, ChatGPT could also hinder our learning experience by holding us back from free thinking, if we are constantly asking how to do x, y, z, then we will lose the critical and outside the box thinking that can fuel innovation in design and fundamentally limit progress

within society. It also can be quite risky to heavily rely on ChatGPT due to the fact that inaccurate information is highly plausible.

5.5.1 ChatGPT Prompt Examples

This section reflects on ChatGPT's responses viewable in appendix E to our team's prompts in order to actively show the advantages and disadvantages of using Open AI's ChatGPT.

5.5.1.1 Prompt 1

In regards to the prompt and response in appendix E Prompt 1 it was actually quite helpful in getting a base understanding of the different types of voltage regulators and how they would be beneficial in a battery powered device. Some of the regulators mentioned are even the same ones we used as examples prior to searching the prompt. The only potential criticisms of this response would be the fact that it is very generalized and lacks some of the nuances of power and input current calculations for some of the switching converters. However, as a starting point ChatGPT could be very useful if we had no prior knowledge of voltage regulators [118].

5.5.1.2 Prompt 2

In regards to the prompt and response in appendix E Prompt 2 although ChatGPT outlines valid and applicable standards regarding temperature and CO₂, it did provide a European standard, which is not applicable to BREATHE, which is based in the United States. The group's focus needs to align with relevant local regulations and guidelines, such as those established by OSHA and ASHRAE in order to adhere to various compliances within its intended environment. Moreover, relying on standards specific to a different region could lead to discrepancies in performance expectations, as foreign standards may provide information that is incongruent to those found in the United States [119].

5.5.1.3 Prompt 3

In regards to the prompt and response in appendix E Prompt 3 it unfortunately contains multiple inaccuracies. Taking a look at each point, ChatGPT stated that in low power mode, the SCD41 typically consumes 70uA [120]. However, according to the official SCD41 datasheet, it actually consumes 3.2mA and has a maximum consumption of 3.5mA [21]. As one can see, this is a huge inconsistency, as the difference between the value that ChatGPT gave and the one provided by the official SCD41 datasheet is significant. Moreover, when comparing ChatGPT's claim that the SCD41's measurement mode uses up to 120uA as well as a peak current of 2.5mA to the datasheet, it is clear that this

response is also inaccurate. Based on the SCD41 datasheet, the peak current ranges from 175 - 205 mA and the SCD41's measurement mode consumes 15 - 18mA. Again, this difference in values highlights major discrepancies between ChatGPT and the datasheet. Thus, it is fair to say that when ChatGPT is in use, its contents should be verified as it cannot be accurate indefinitely.

6.0 Hardware Design

In order to create a successful senior design project and meet the course's guidelines, a Printed Circuit Board (PCB) with significant peripherals is required. To meet these specifications we decided that the most efficient way to bring our design to life was to split Breathe into two main subsystems we call, the Control Unit and the Vent interaction Subsystem. With these subsystems in mind, two PCBs are needed.

With the intention of creating two PCBs from scratch we needed to select suitable software to design them before they could be sent to be fabricated. We decided to use the free software suite KiCad to layout the PCB schematics and board design. We considered other alternatives such as EAGLE, Fusion 360, and Altium. Although these programs are well-documented and exhibit many tools and features, we found KiCad to better align with our team's workflow and preferences due to both its accessibility and ease of use. Since we determined that KiCad was the most user friendly and accessible we were then able to begin the designing process. The STM32 is the MCU we will be utilizing for both units and so for the design procedure to begin we needed to heavily reference both the datasheet and various application notes to design basic necessities needed for a proper functioning system. We also relied on the STM32Cube IDE as a reference to easily select which pins are capable of performing the actions needed and how many were available.

6.1 Control Unit

The control unit consists of some of the major data peripherals of BREATHE, those being the LCD screen, temperature sensor, carbon dioxide sensor, and the buzzer. A block diagram of how this subsystem works can be seen below in Figure 12.

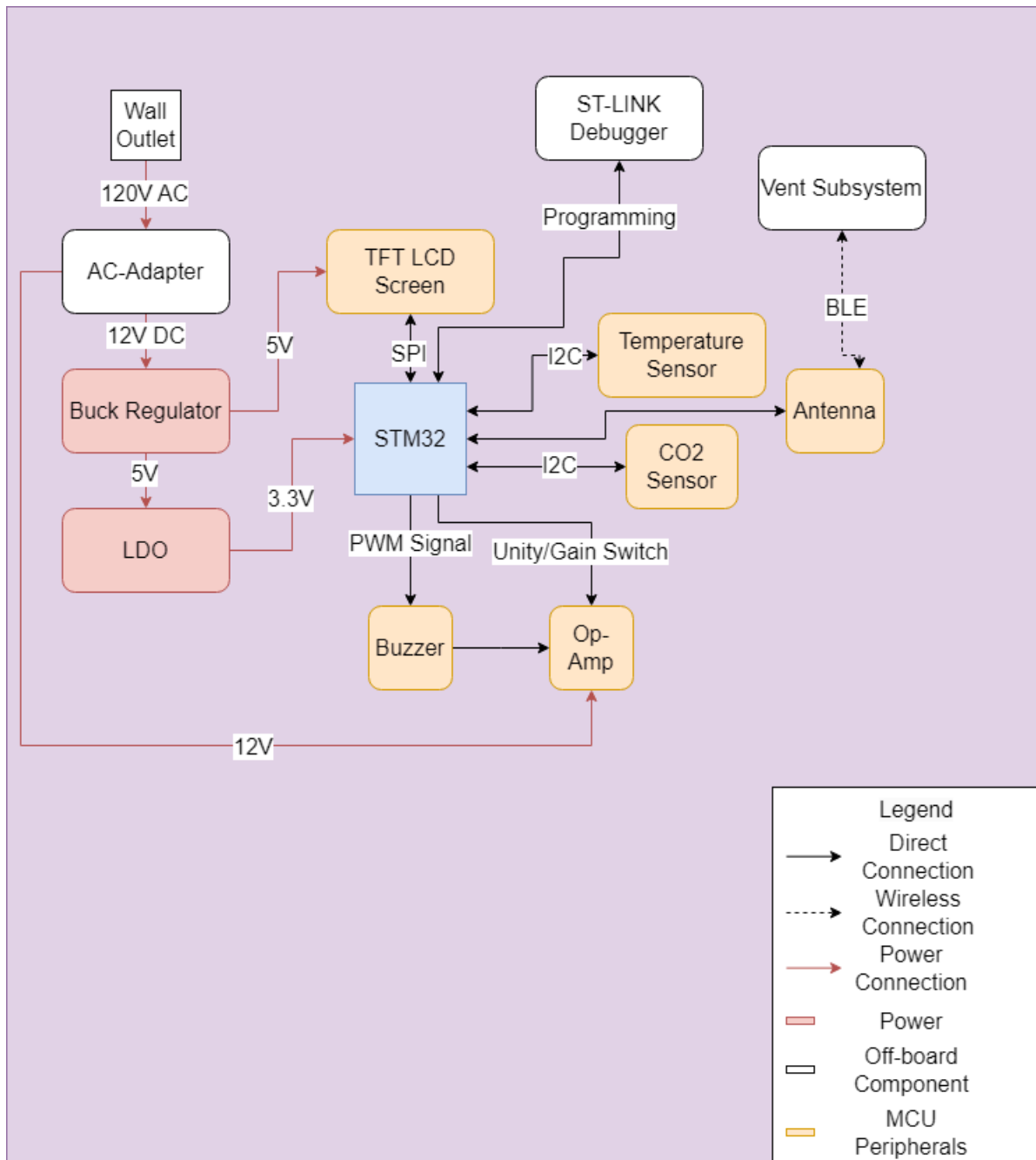


Figure 12: Hardware Block Diagram for Control Unit

6.1.1 MCU

Unfortunately, at some point during the design we realized the STM32WB09 was quite limited in the amount of available GPIO(General Purpose Input Output) pins it had that we needed to interface with the various peripherals on both boards. The TFT LCD screen in the control unit was a large point of contention as it needed 11 GPIO pins.

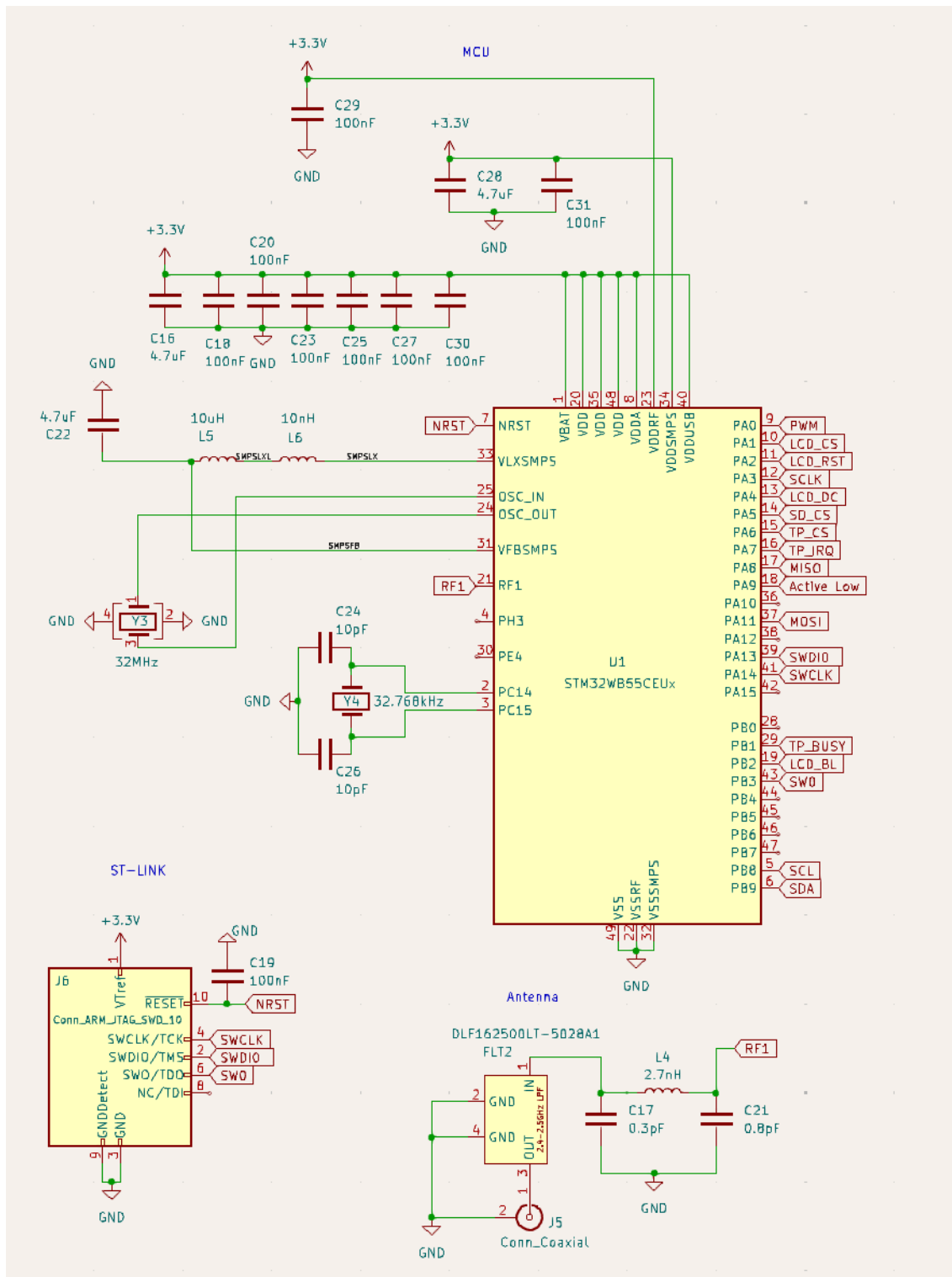


Figure 13: Control Unit MCU Isolated Schematic

There was also limited documentation on the WB09 board and the application notes for the STM32WB series were more adaptable to the STM32WB5x boards rather than the STM32WB0x boards. The design was still very similar, but in some instances more research was necessary to determine what was specific to the WB09 board.

After researching and discussing, it made more sense to instead use the STM32WB55 board since there was much more documentation on it and it had more than enough pins to accommodate our various peripherals. Thankfully, since the two boards are so similar, the code and overall design were easily transferable. From the original schematic for the vent interaction subsystem, the only changes necessary to move from the WB09 to the WB55 was moving a few pins and adding a few more decoupling capacitors since the WB55 has more power pins.

The STM32WB55 requires at least one 100nF decoupling capacitor per VDD pin, and also requires a 4.7uF bulk capacitor to act as a charge reservoir to keep the voltage stable whenever the main supply fluctuates. The STM32WB55 also lets the user configure the SMPS (Switch Mode Power Supply) to be on or off. Since the datasheet specifies that it is recommended to leave it on for low-power applications, we connected the SMPS pins to two inductors and a bulk capacitor as specified in the application notes [121]. The VDDRF pin also requires a decoupling capacitor and a bulk capacitor that is isolated from the other VDD pins. The SMPS VDD pin needs an isolated decoupling capacitor as well.

The datasheet also specifies the use of a 32MHz high speed external oscillator connected between the OSC pins and a low-speed 32kHz connected to the PC14 and PC15 pins with additional decoupling capacitors for each pin [122].

Antenna: The next required component is for the RF capabilities of the MCU such as bluetooth. Since the standalone chip does not come with its own antenna, we need to use an external antenna. For this design, we are using a UFL connector to connect to the antenna. The RF application notes by ST specify that the antenna needs to be impedance matched to the RF1 pin and also requires a specific RF low-pass filter for the antenna [121]. This impedance matching is achieved using 2 capacitors and an inductor which all need to be sized to 0402 to reduce parasitic capacitance/inductance.

ST-LINK: The last major component to our MCU design is the method of programming and debugging. To flash and debug the STM32WB55, ST

recommends utilizing SWD (Serial Wire Debug) connections. We plan on using the ST-Link V2 debugger which only supports SWD connections over a 20-wire JTAG connector. To reduce the amount of extra unused pins on the board, we will utilize a generic JTAG to SWD adapter instead. It is important to note other ST-LINK versions utilize regular 10 wire SWD connectors. On the actual board, we've routed a 10-pin jumper to interface the ST-LINK through SWD. The SWCLK, SWDIO, and SW0 pins are all routed to appropriate pins on the MCU. The voltage reference is given by the main 3.3V voltage rail. Finally, the reset pin is connected to the MCU's NRST pin with a decoupling capacitor to limit debouncing.

6.1.2 LCD Screen

Once we made the appropriate changes to our MCU selection and our LCD screen brand we were able to properly decide how we wanted to incorporate the LCD. The options were to either incorporate the LCD screen into our PCB or connect to it via pin headers. We ultimately decided that the best decision would be to connect the screen via wires and a pin header. Following the STM32 data sheet and the user manual for the 4 inch TFT touch shield, an Interface table is presented in the LCD user manual with descriptions as to what each pin needs. Cross referencing both the data sheet and the user manual the pin configuration schematic with respect to the needs of the LCD screen can be seen below in Figure 14.

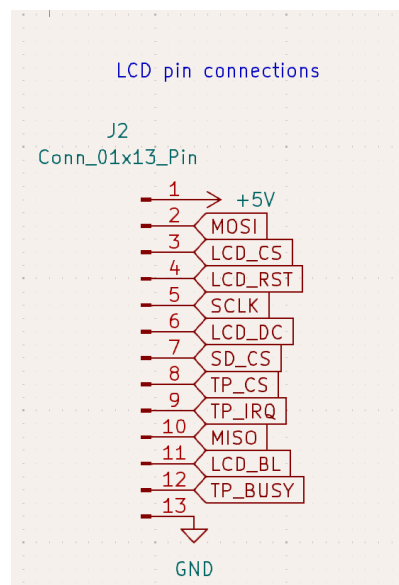


Figure 14: LCD Pin connections

6.1.3 Temperature Sensor

To begin the temperature sensor schematic, we had to take a look at the TMP102 temperature sensor data to understand its working conditions and limitations. Once a significant understanding was complete, we discovered an application and implementation section of the datasheet. A figure of a typical application of the TMP102 was shown and then utilized as a guide for schematic purposes. The supply voltage for the temperature sensor is 3.3V which is denoted by the arrow pointed upwards it is then split three ways with the connections leading to 3 resistors, a capacitor, and the input voltage of the sensor. The resistors are all 5K Ω and act as pull up resistors for their specific components which are the pins, SCL, SDA and Alert. The capacitor is rated at 0.01uF and acts as a supply bypass capacitor which is needed to prevent any possible noise from entering the system and bypassing it to ground. The schematic for the TMP102 sensor is shown below in Figure 15.

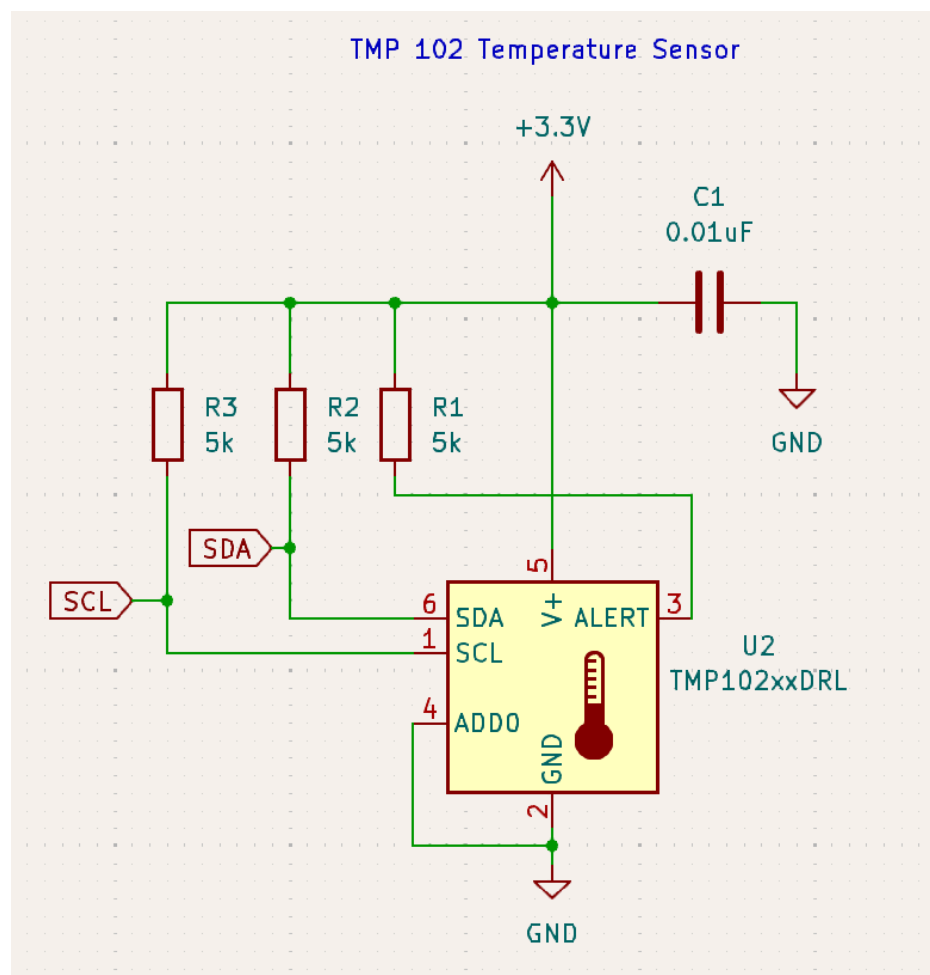


Figure 15: Temperature Sensor Schematic

6.1.4 Carbon Dioxide Sensor

The SCD41 Carbon Dioxide Sensor schematic process was very similar to how we designed the temperature sensor. To begin we examined the SCD41 data sheet to understand its working conditions and limitations. As soon as we were able to understand the main ideas of how the sensor worked we could move forward with schematic design. In the data sheet, a section titled interface specifications explained the best practice for setting up this sensor and was followed with a figure entitled typical application circuit. This typical application circuit was extremely beneficial in guiding the schematic design for the carbon dioxide sensor. This section went on to explain how the VDD and VDDH pins were to always be kept at the same voltage, detailed how the SDA and SCL pins were for transferring data to and from the sensor, and synchronizing the I2C communication between the MCU and sensor. The data sheet then goes on to say that the SDA and SCL lines should be connected to external pull up resistors. We followed all of the data sheets recommendations and the schematic for the sensor can be seen below in Figure 16.

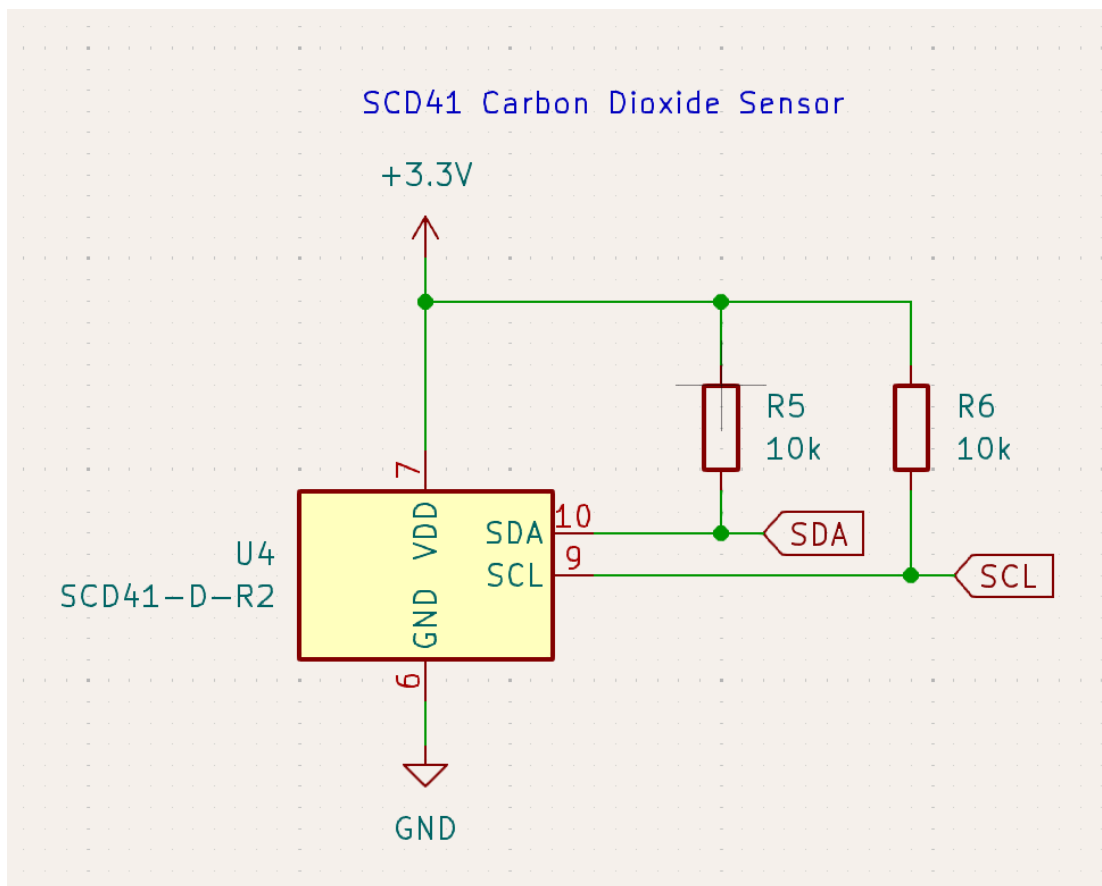


Figure 16: Carbon Dioxide Sensor Schematic

6.1.5 Buzzer

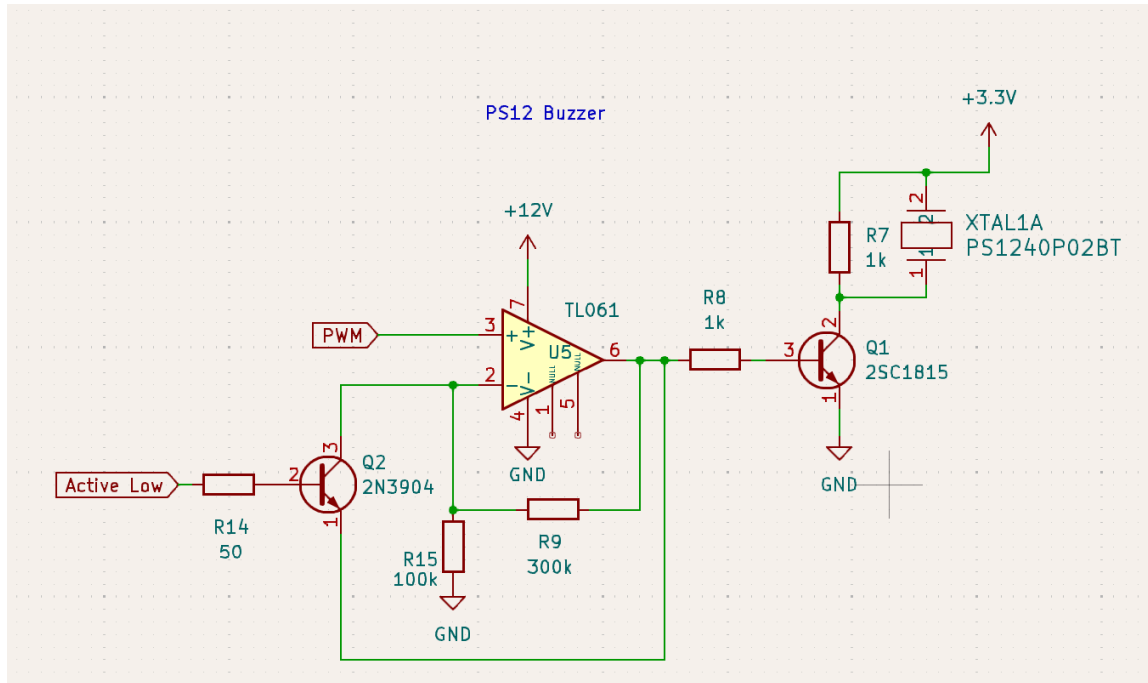


Figure 17: Buzzer Schematic

For the piezo buzzer, which will alert the user of excess carbon dioxide, dangerous temperatures, or low battery life, careful considerations needed to be made to be able to vary the volume and alarm pattern based on the various conditions outlined. The datasheet outlines a popular example of a piezo buzzer driver circuit which we have adjusted to meet our needs [123]. First, there is a TL061 op-amp which is fed by a PWM signal from the MCU whenever the buzzer needs to be turned on. The buzzer will only work when fed a PWM signal.

We utilized a 2N3904 jellybean BJT transistor to switch the op-amp from unity gain to a gain of 4 which would vary the volume. Since the PWM signal from the MCU is 2.5V, when the transistor is pulled low, the op-amp will output a 10V PWM signal. If the transistor is pulled high, then the op-amp will output 2.5V. Thus, for low battery life, the volume will be lower than for the harmful environmental conditions previously outlined. A GPIO output pin on the MCU will control the transistor by either pulling the base voltage to ground or applying 3.3V to the transistor's base. A 50 Ω resistor is placed at the base junction of the transistor to establish a high enough base current at 3.3V to drive the transistor into saturation.

The second stage is from the datasheet and also consists of a switching circuit using a different NPN BJT transistor. The transistor will apply a voltage across

the piezo buzzer when the base current is high enough to drive the transistor into saturation. Part of the purpose of this switch is to isolate noise from inadvertently making the buzzer click and to provide the buzzer an isolated end for it to charge and discharge. Piezo buzzers act almost as capacitors and will discharge current which is why there is a resistor in the collector junction of the transistor. This resistor is to provide the buzzer a load which will dissipate whatever current it discharges.

6.1.6 Power Design for Control Unit

For the control unit, the power section is designed to accommodate all of our peripherals without too much complexity. This unit will utilize a 12V AC-DC adapter which will convert the 120V AC power from a residential wall outlet into a 12V DC output which will power the entire control unit. These adapters are plentiful and allow for a lot of extra headroom for our various peripherals. Another advantage is that this gives us a large supply for the switchable op-amp coming from the buzzer. This adapter will be connected through a standard DC barrel jack where it will then be regulated into two distinct voltage rails.

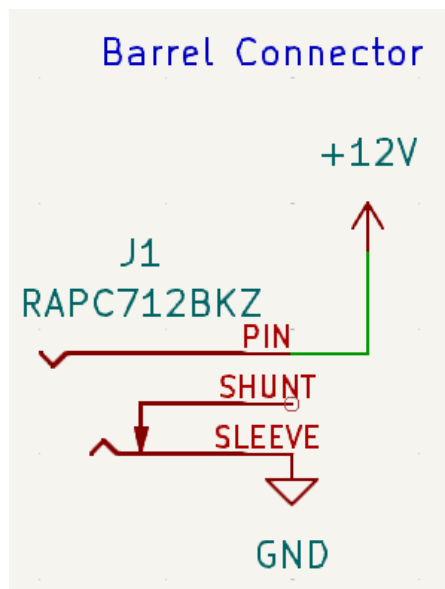


Figure 18: AC-DC Adapter Barrel Connector

Even though the TFT LCD screen that will be incorporated into the control unit utilizes 3.3V logic for all of its main drivers and peripherals, since it was designed with the Arduino Uno development board in mind (which runs off of 5V) the screen is designed to take a 5V input and uses an LDO to regulate that input to 3.3V. The dropout voltage of this regulator is relatively high, and since

the MCU has a maximum input voltage of 3.6V, running both the MCU and the LCD screen off of one voltage rail is not feasible unless we were to take the LDO out of circuit by modifying the LCD. This means we need a separate 3.3V and 5V rail to power both the LCD and MCU respectively. It is important to note 3.3V was chosen as the input voltage for the MCU in this section because the CO₂ sensor requires a 3.3V input.

Because using a linear regulator to step down 12V to 5V would result in 59% of the power from this conversion to be dissipated as heat, it seemed more reasonable to use a switching regulator to deliver a stable 5V output to the LCD screen. Using a linear regulator in this manner would have likely required a heatsink, and the additional heat generated from this inefficient regulation could make the results of the temperature sensor less accurate as the enclosure would get warmer.

However, to provide the 3.3V output to the MCU we decided to use an LDO in series with the 5V buck-converter instead of using another buck-regulator mostly to limit the design complexity. LDO's require less components and less design overhead when laying out the design on a PCB. Since power consumption is not an issue on the control unit, the increased efficiency of a buck converter doesn't hold as much impact. As long as a suitable package is chosen that can properly sink the extra heat generated due to efficiency losses (34% of the total power) this option is perfectly suitable for powering the MCU. Moreover, LDO's are widely used in series with switching regulators to reduce noise, so this option would give the MCU a much cleaner power source.

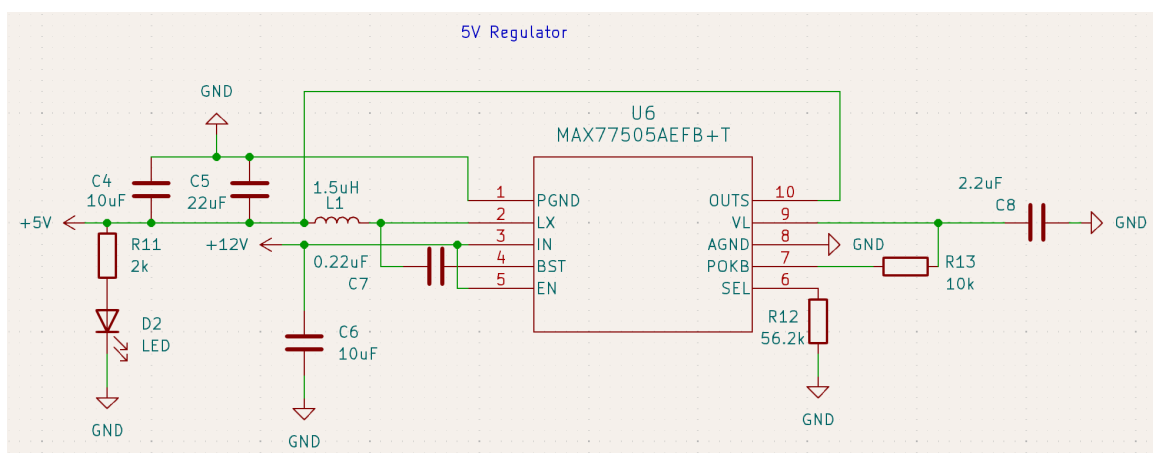


Figure 19: 5V Buck-Converter Schematic

The layout of the buck-converter mostly follows the datasheet's application circuit with some notable tweaks to suit the control-unit's specific needs [66].

The SEL pin was set with a specific resistance which would configure the voltage output to 5V. The schematic follows the datasheet's recommended capacitor and inductor values for voltage outputs above 0.8V. The enable pin EN is tied to the voltage supply at the input pin to ensure the regulator is always on. We added an LED with a suitable current-limiting resistor to give us a visual indicator to tell if the buck-converter is working properly and outputting current.

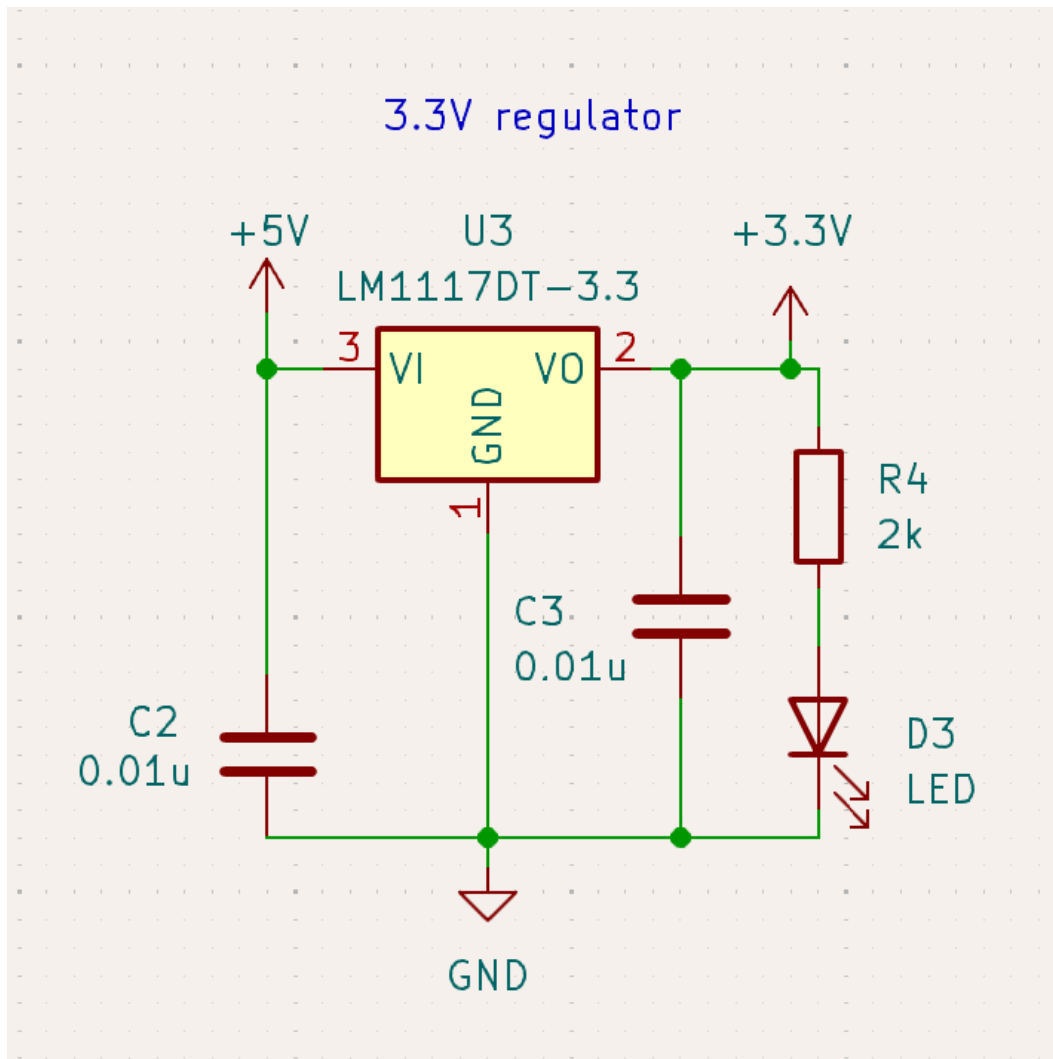


Figure 20: LDO Regulator for MCU

The LDO takes the 5V output from the buck-regulator at its VI input pin. Two capacitors are placed from the input and output to ground as specified in the datasheet [125]. Once more, an LED is placed at the output to give us an indicator that the regulator is working properly.

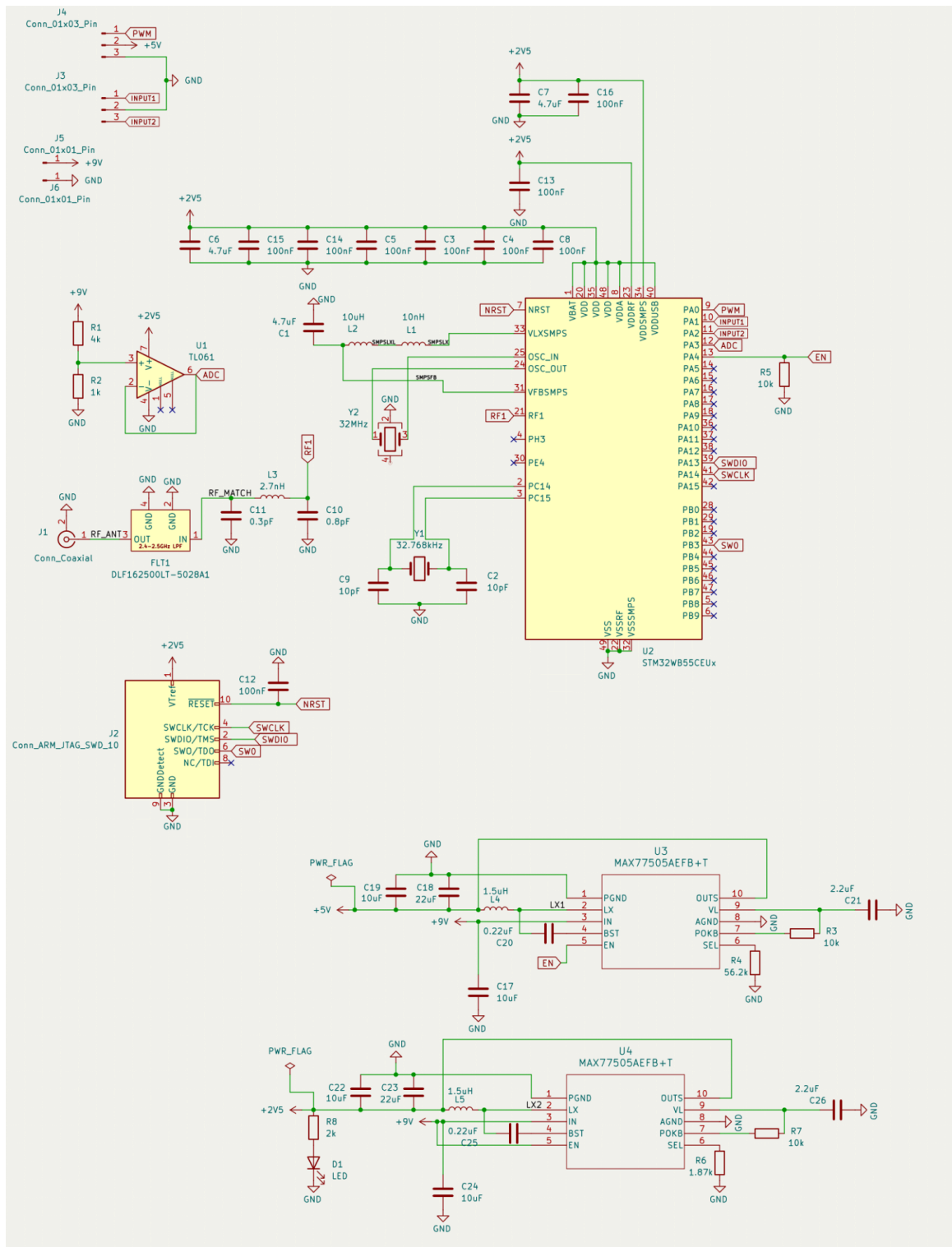


Figure 21: Overall Schematic of Control Unit PCB

6.2 Vent Interaction Subsystem Design

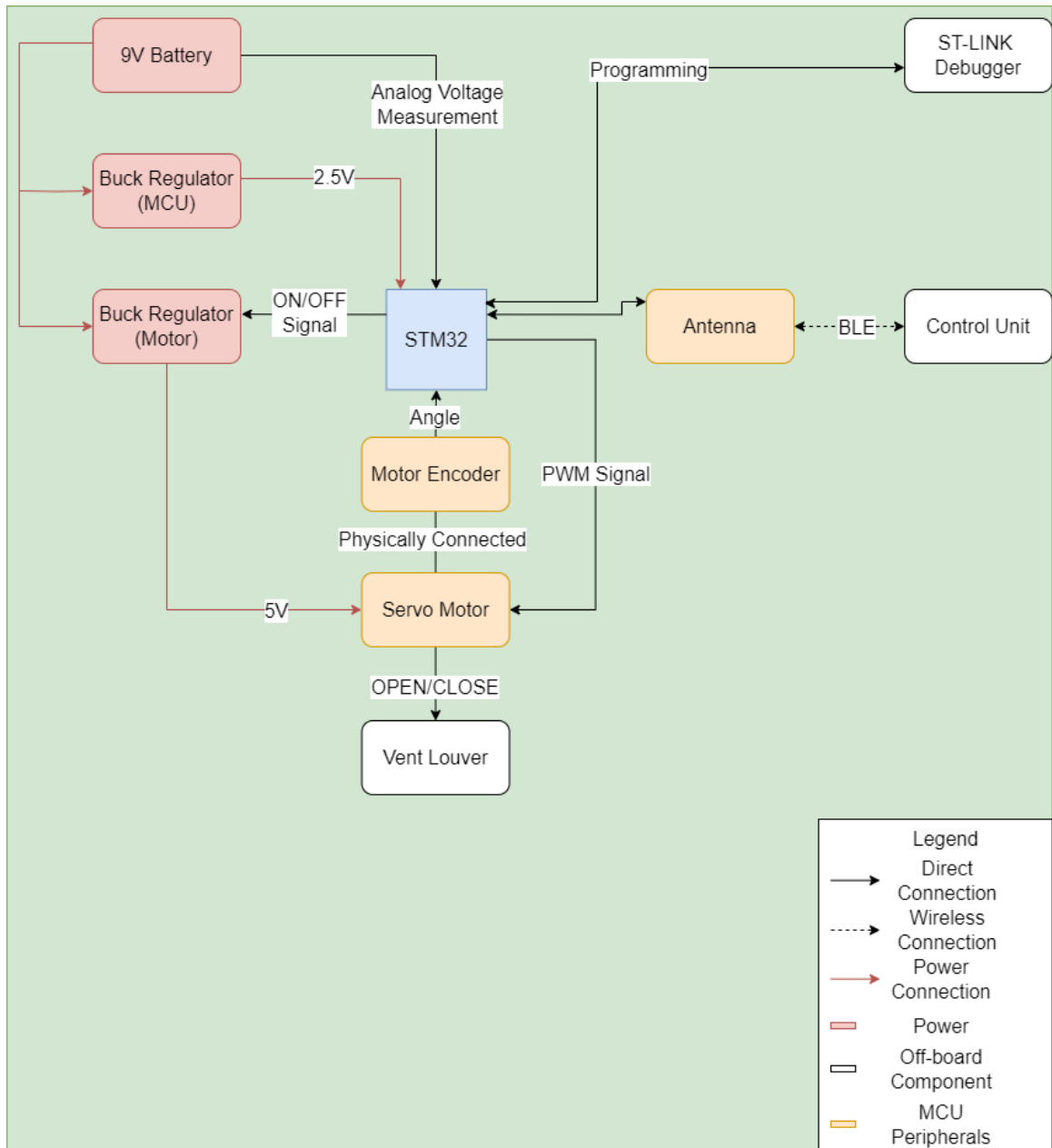


Figure 22: Vent Interaction Subsystem Hardware Block Diagram

6.2.1 MCU

The MCU layout is identical to the control unit with only two notable exceptions. First, the MCU will be powered by a 2.5V supply as opposed to a 3.3V supply. Second, some of the GPIO pins utilized are different and specific to the peripherals needed in the vent interaction subsystem.

6.2.2 Servo Motor, Motor Encoder

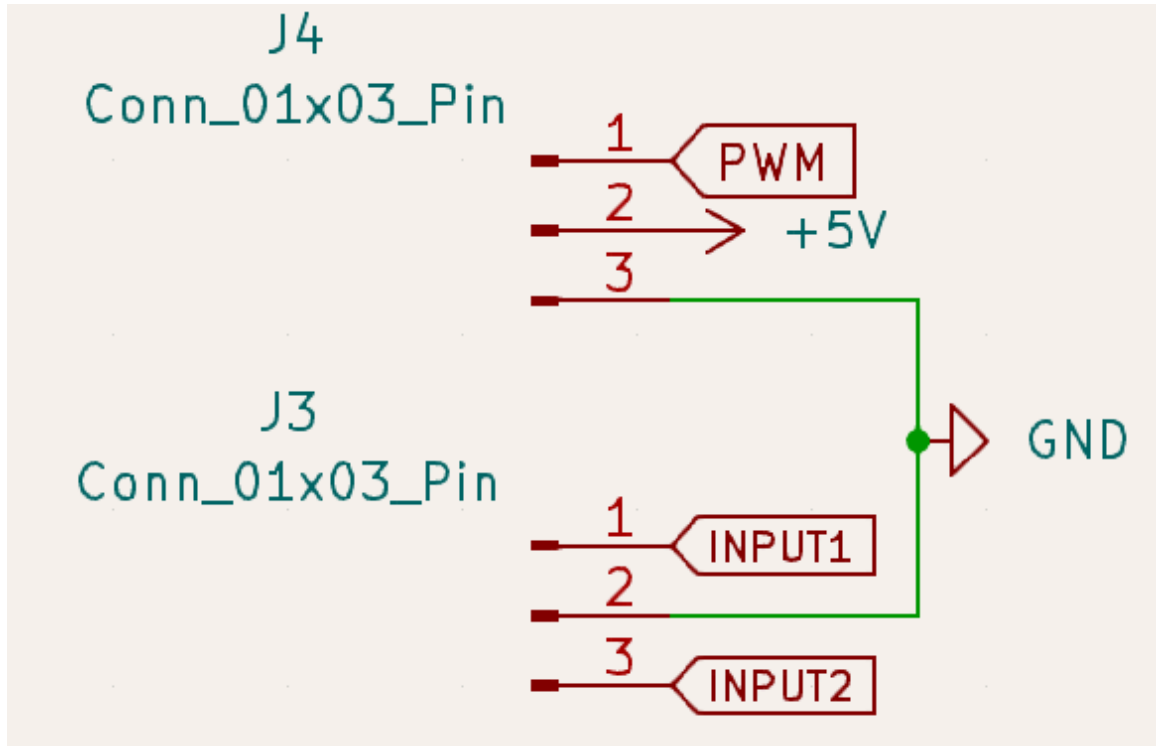


Figure 23: Vent Interaction Subsystem PCB Overall Schematic

For the servo motor and the rotary encoder attached to it to record the angle of the motor, we determined these components would need to be wired offboard. The top 1x3 connector will be reserved for the motor which requires a PWM signal from the MCU as well as a 5V supply. The bottom 1x3 connector is for the two sides of the encoder which will be inputted into the MCU.

6.2.3 Power Design for Vent Interaction Subsystem

For the vent interaction subsystem, we need two voltage rails once more, one 5V to power the servo motor and another rail to power the MCU. Since current draw is much more of a concern to preserve battery life, a buck-regulator in series with an LDO would not be suitable for use in this particular design. Instead, we opted to place two MAX7750 buck-regulators in parallel to supply both voltage rails. As previously discussed in chapter 3, using 2.5V to power the MCU as opposed to the standard 3.3V used in the control unit would extend the battery life even further. This is why we opted to use a 2.5V rail in this design, and since there are no peripherals that require 3.3V this would be a perfectly suitable option to power the STM32.

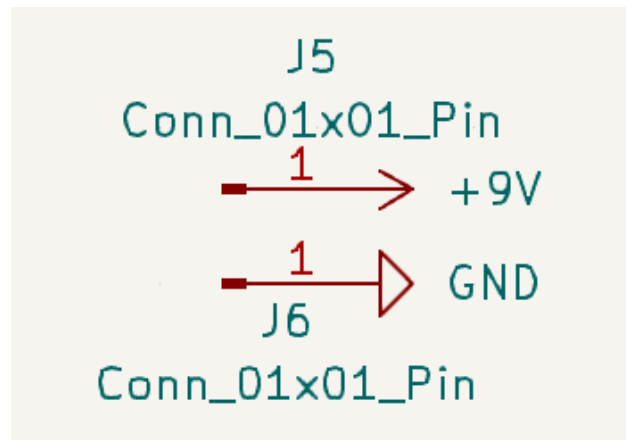


Figure 24: 9V Battery Input Schematic

Battery Input: For the battery input, two test pads will be placed on the board which will allow us to solder the positive and ground of the battery connector to the board. Below is an example of a standard 9V battery enclosure soldered to a PCB in this exact manner.



Figure 25: Example of 9V Battery Enclosure and Connection

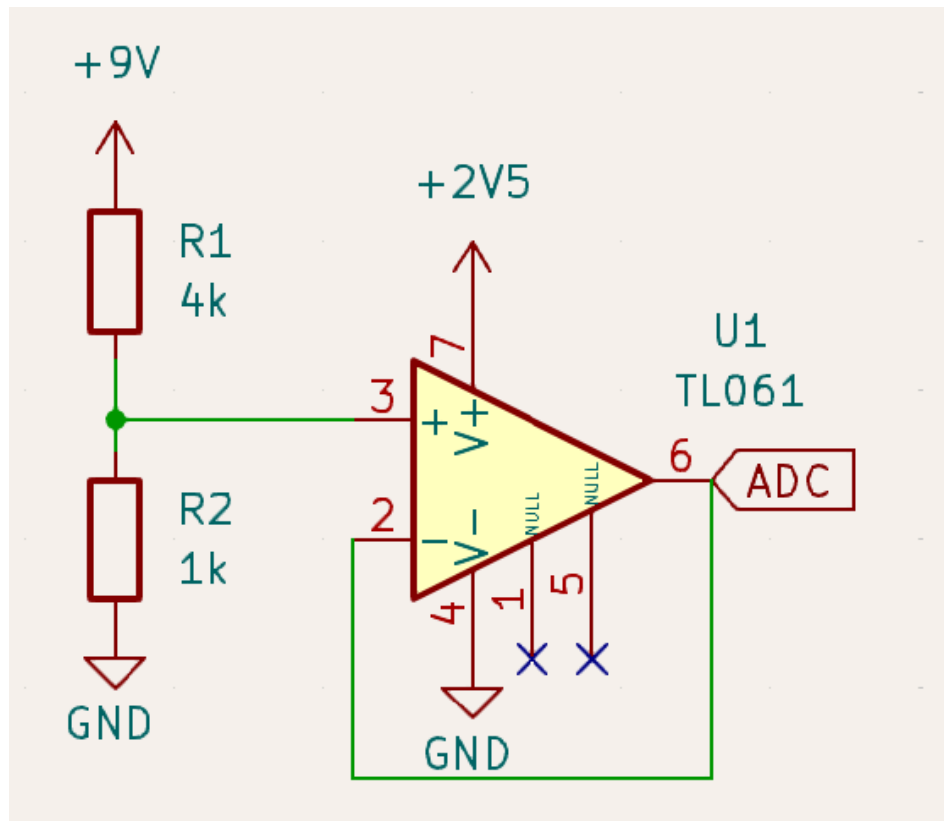


Figure 26: Battery Life Indicator Schematic

Battery Life Indicator: One crucial element in the design of the vent interaction subsystem is being able to notify the user of the battery life. In particular, we want to make sure the user is aware if the battery life is low and it needs to be replaced. Thankfully, the STM32WB55 has an analog to digital converter (ADC) which can read analog voltages and convert them into bits which can be read and stored. This can be used to read the voltage value and determine the battery life in relation to the cutoff voltage of the battery and its rated nominal voltage. This value will be sent via bluetooth to the control unit and, if it is near the cutoff voltage, the buzzer in the control unit will alert the user of low battery. There is one notable issue, the battery is 9V but the MCU is powered using 2.5V. 2.5V in this case is the reference voltage for the ADC and the ADC cannot read voltages greater than this reference voltage. This means it wouldn't be able to read the voltages at all, even when the battery is far below its cutoff voltage. This, however, can be easily solved by using a simple voltage divider using two resistors. This solution would give us a voltage with a known ratio that is just low enough to be within the ADC's operating voltage range. We will use a ratio of 5:1 which will ensure our maximum battery life would correspond to a voltage of 1.8V, far below the ADC's voltage reference. There is another caveat though, if the impedance of the two resistors in the voltage divider is too close to the input

impedance of the ADC then the voltage at that pin will be less accurate. The STM32WB55 datasheet specifies that the input impedance of the ADC is around $50k\ \Omega$ [122]. This poses a problem with our design as even if we were to use 400 and $100\ \Omega$ resistors in this divider (extremely low values) the voltage output would still be slightly inaccurate. This may seem trivial, but since our ratio is so large the cutoff voltage is only 0.6V below the nominal voltage out of the divider, so these small inaccuracies are amplified in some regard.

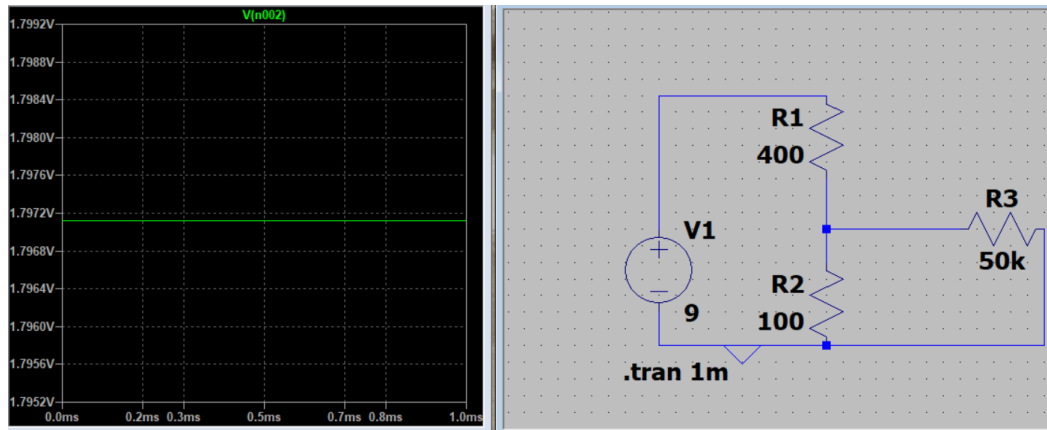


Figure 27: LT-Spice Simulation of Voltage Divider

There is another simple solution to this, however, and that is to use an op-amp at unity gain to buffer the output. Since an op-amp has a very high input impedance, very little current will go to its input and the voltage would therefore be more accurate to the ratio given by the voltage divider. In this case our supply can either be the MCU supply or any other voltage supply on the board, but we chose the MCU's supply since this circuit will be closer to the MCU.

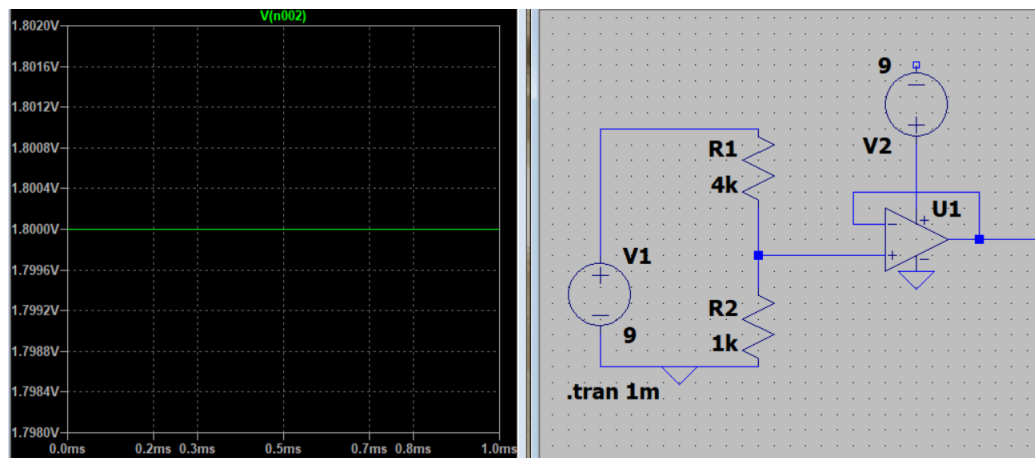


Figure 28: LT-Spice Simulation of Buffered Voltage Divider

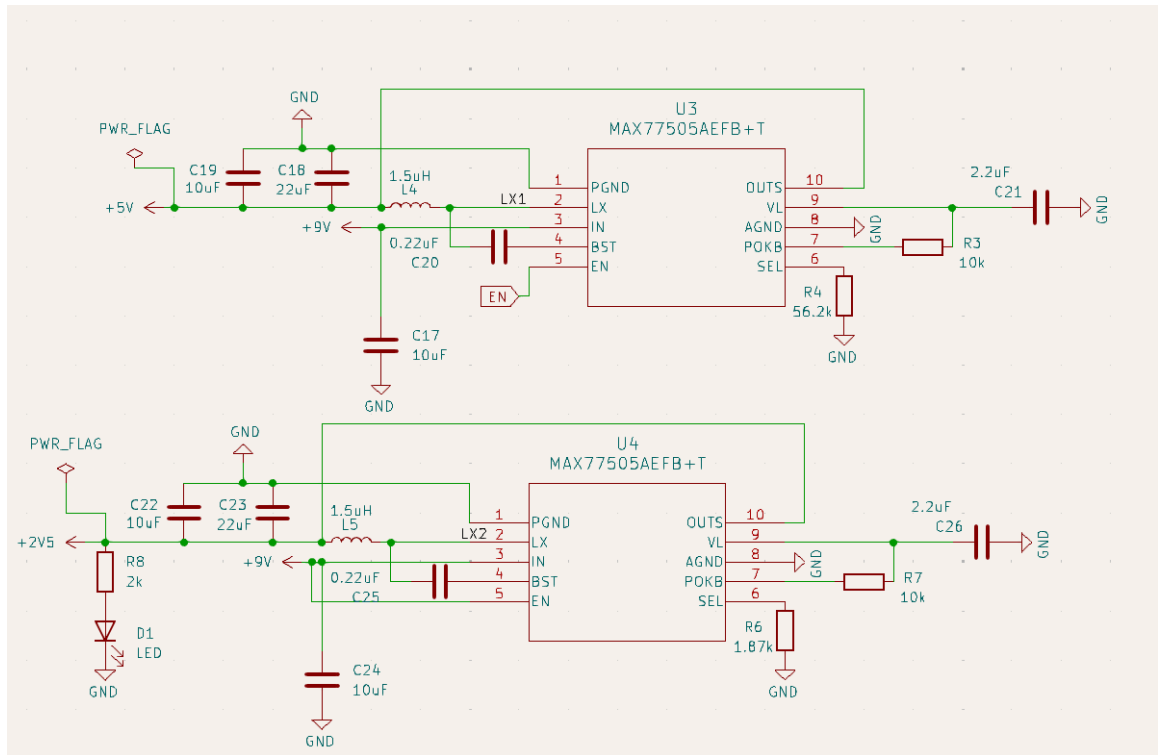


Figure 29: Buck-Regulator 2.5V and 5V Rail

Buck-regulator: For the buck-regulator used in the vent interaction subsystem, the overall layout and parts will be mostly identical to that of the 5V regulator layout in the control unit. However, there are a few notable differences. For one these regulators will both be powered by the 9V battery, and we will be using one for the MCU and one for the motor as opposed to utilizing an LDO at the output of a single regulator. The second regulator is also going to power a 2.5V rail for the MCU as discussed before, which means the resistor tied to the SEL pin needs to be a different value. The last major difference has to do with the enable pin EN. This pin can be set high to turn on the regulator and low to turn off the regulator. For the MCU, this will be tied to the input pin (high) so it will always be on just like the buck-converter in the control unit. For the motor, however, the EN pin is tied to a GPIO pin which will be pulled down to 0V by default. This is so the GPIO pin PA4 can enable or disable the pin whenever the motor needs to open or close the vent. Although the MCU's pins do have internal pull up/pull-down resistors, just to ensure the pin is never floating these will be disabled and we have opted to use an external pull-down resistor. The datasheet specifies the EN pin has a soft-start process, so extra capacitors to manage transients or debouncing will not be used [66].

Figure 30: Vent Interaction Subsystem PCB Overall Schematic

7.0 Software

7.1 Configuring the Pins

Before any software can be programmed onto the STM32, the pins must be configured in order to facilitate proper interfacing with any connected devices. Configuring the pins on the STM32 microcontroller is an important step in hardware development, however the process can be streamlined via software using the STM32CubeMX IDE environment. It provides a graphical interface that allows manual configuration of pins for specific functionalities, such as GPIO, I2C, UART, or SPI. Additionally, there are also preset configurations that STM32Cube provides depending on the board that one is using.

The process of selecting pins begins by selecting the desired STM32 microcontroller and its package. Then, functions can be then assigned to each pin by clicking on the desired pin and choosing from the available options. For instance, the PB1 pin on the STM32WB09KE can be configured as either a GPIO pin or an ADC pin. Once configured, STM32CubeMX generates the corresponding initialization code based on the configurations set by the developer. In summary, this approach simplifies the process behind pin configuration and reduces the likelihood of errors compared to manual register programming.

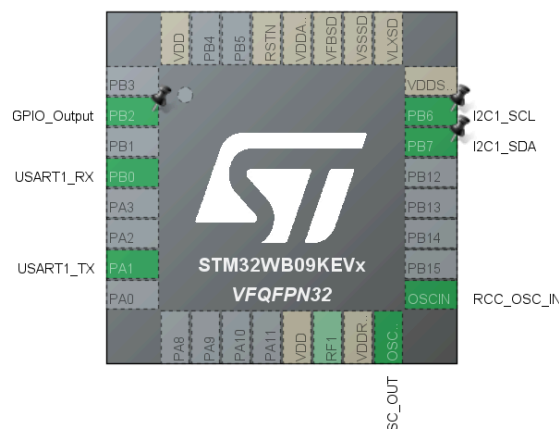


Figure 31: Pinout configuration of the STM32WB09

7.2 Hardware Abstraction Layer

Regardless of what is being developed, the STM32 microcontroller necessitates a series of core configurations and initializations to enable seamless integration and functionality across all components. Tasks such as configuring the system clock, establishing peripheral clock settings, and initializing the Hardware Abstraction Layer (HAL) are foundational requirements, regardless of whether the application involves a temperature sensor, LCD screen, or other subsystems. These initializations ensure synchronized operation and provide a standardized framework for subsystem interaction.

The Hardware Abstraction Layer (HAL) is a crucial component of STM32 microcontroller development, providing a high-level interface for interacting with the hardware. It abstracts the complexity of register-level programming, allowing developers to configure and control peripherals using simple and intuitive APIs. This approach significantly reduces development time and lowers the barrier for engineers to work with advanced microcontrollers like the STM32. Instead of needing detailed knowledge of the microcontroller's internal architecture, developers can focus on designing application-level logic, relying on HAL to handle low-level hardware interactions.

HAL is especially important for ensuring portability and scalability in embedded systems development. Since STM32 microcontrollers have a wide range of variants with different features and capabilities, HAL provides a unified API that works across multiple devices within the STM32 family. This consistency allows developers to migrate code between different STM32 models with minimal changes, enabling seamless upgrades or modifications to meet evolving project requirements. Furthermore, HAL's modular design makes it easier to add new peripherals or update existing configurations, fostering flexibility and adaptability in system design.

Another critical advantage of HAL is its ability to streamline peripheral initialization and configuration. For example, setting up communication protocols such as I²C, UART, or SPI requires configuring multiple registers, which can be error-prone and time-consuming. HAL simplifies this process by encapsulating these operations into pre-defined functions, ensuring correctness and reducing debugging efforts. Additionally, HAL supports advanced features like interrupt handling, DMA (Direct Memory Access), and low-power modes, making it an indispensable tool for maximizing the performance and efficiency of STM32-based systems. By leveraging HAL, developers can focus on creating robust and feature-rich applications while minimizing the complexity of hardware management.

The system clock configuration establishes the timing foundation for the microcontroller, ensuring that all peripherals and internal processes run in sync and meet timing requirements. Peripheral clocks are then configured to provide the necessary clock signals to individual subsystems like I²C, UART, and GPIO, enabling communication and functionality for specific components, such as the TMP102 sensor or the LCD module. The initialization of the HAL abstracts the low-level hardware details, providing a standardized interface for developers to access the microcontroller's features without delving into the intricacies of register-level programming.

These foundational configurations are universal across subsystems, making them a critical step regardless of the specific functionality being implemented. By standardizing the initialization process, the STM32 ensures that each subsystem integrates seamlessly into the overall design, maintaining consistency and reliability throughout the development process.

7.3 Clock Configuration

STM32CubeMX is a powerful tool that simplifies the setup of STM32 microcontrollers, including the critical task of clock configuration. Clock configuration is essential for determining the speed and timing of the microcontroller's operations, as it sets the frequencies for the CPU, memory, and peripherals. STM32CubeMX automatically generates the necessary initialization code based on user-defined settings, such as selecting internal or external oscillators (e.g., HSI, HSE, LSI, LSE) and configuring the Phase-Locked Loop (PLL) for frequency scaling. It also ensures proper configuration of clock sources for peripherals, allowing for precise synchronization and optimal performance. For example, CubeMX can set up the required 48 MHz clock for USB peripherals or adjust divider settings for low-power applications. This automation saves significant development time by handling the complex relationships between system and peripheral clocks, ensuring that the configuration adheres to STM32 specifications and meets application-specific requirements. By leveraging CubeMX, developers can confidently integrate customized clock settings without the risk of manual configuration errors, enabling efficient and reliable system performance.

7.4 Temperature Sensor

At the start of the code, the HAL (Hardware Abstraction Layer) is initialized using the `HAL_Init()` function. This function initializes the internal peripherals and system components that the STM32 needs for proper operation. Then, the

system clock is then configured using the `SystemClock_Config()` function, which sets the clock source and configures the system's clock settings such as the High-Speed External (HSE) oscillator. After this, the peripheral's clock is then configured using the `PeriphCommon_Config()` function, which ensures that various peripherals such as I2C and UART are correctly driven by the clock.

Next, the system initializes its hardware peripherals using certain functions. The `MX_I2C1_Init()` function configures the I2C communication protocol to interact with the TMP102 temperature sensor. Within this function, various I2C parameters are specified, such as the timing, addressing mode, and whether the device should operate in dual address mode. Establishing these parameters ensures that the microcontroller can communicate with the sensor over the I2C bus.

Similarly, the `MX_USART1_UART_Init()` function sets up UART for serial communication. For testing purposes, the value outputted by the TMP102 temperature sensor is transmitted over UART to a connected terminal, allowing BREATHE to verify the accuracy of the temperature readings, debug the system, and ensure proper communication with the TMP102 sensor. The UART configuration plays a crucial role in ensuring reliable data transmission. In this implementation, the UART is set with a baud rate of 115200, which defines the speed of communication by specifying the number of bits transmitted per second. This high baud rate ensures fast and efficient data transfer, minimizing latency during testing and debugging.

Additionally, the UART configuration uses no parity, which means that no extra bit is added for error detection. Without a parity bit, the UART communication relies solely on other mechanisms, such as checksums or retransmissions, for error detection and correction. While this configuration reduces the overhead in data transmission, it does not provide immediate error-checking capability that parity bits offer. The word length is set to 8 bits, which is a standard configuration for transmitting ASCII characters and other data, while the stop bit configuration of 1 ensures minimal overhead in the data frame. Flow control is disabled (no hardware control signals like CTS/RTS), simplifying the connection between the microcontroller and the terminal during testing.

The use of these specific UART settings ensures robust and efficient communication with the terminal during development. This setup provides developers with a convenient and reliable way to validate the data, fine-tune the software in real time, and ensure that the temperature readings are both accurate and reliable before transitioning to the final implementation.

The main program logic runs inside the `main()` function, where the system initializes and begins continuous operation. An initial message is sent to the UART terminal using `printf()`, indicating that the system is starting the temperature reading process. Inside the infinite loop, the program continuously reads the temperature data from the TMP102 sensor. The `TMP102_ReadTemperature()` function is called, which interacts with the TMP102 sensor via I²C. In this application, the STM32 microcontroller acts as the I²C master, and the TMP102 sensor acts as the slave device with the address 0x48. The function begins by sending a start condition, followed by the 7-bit slave address (0x48) and a write bit (0). This combination signals the TMP102 that the microcontroller intends to write to the device. After receiving an acknowledgment (ACK) from the TMP102, the microcontroller sends the register pointer value, which specifies the internal register to access. In this case, the pointer is set to the temperature register, typically 0x00 or 0x01 depending on configuration.

After the register pointer is set, the function sends a repeated start condition, followed by the slave address (0x48) and a read bit (1), indicating that the microcontroller now wants to read data from the specified register. The TMP102 responds by sending two bytes of data. The first byte contains the most significant bits (MSB) of the temperature value, while the second byte contains the least significant bits (LSB). Once the two bytes are received, the microcontroller sends a stop condition, signaling the end of the I²C transaction.

These two bytes are combined to form a 16-bit raw value, where the MSB represents the integer portion of the temperature, and the LSB represents the fractional portion. This raw value is then multiplied by the TMP102's resolution (0.0625°C per bit) to compute the temperature in Celsius. The precise use of start, repeated start, and stop conditions, along with the slave address and register pointer, ensures accurate and reliable data communication between the STM32 and the TMP102. The function reads two bytes of data from the sensor's temperature register and combines them into a single 16-bit raw value. This value is then converted to a temperature in Celsius by multiplying by 0.0625, as specified by the TMP102 datasheet. The temperature is then converted to Fahrenheit using the following formula:

$$F = \frac{9}{5}C + 32$$

Moreover, a delay of 1 second using the `HAL_Delay` function is introduced between each reading to ensure the program does not overwhelm the sensor and to provide time for the sensor to stabilize between readings. The code includes several instances of error handling to ensure proper operation. For

example, if the I2C communication fails to read the data from the TMP102 sensor, an error message is printed to the terminal, and the program returns a placeholder value (set to -273.15) to indicate a failure in the temperature reading. Additionally, the `Error_Handler()` function is invoked whenever a critical failure occurs, such as when the I2C initialization or UART initialization fails. Likewise, the `Error_Handler()` function enters an infinite loop, allowing the issue to be troubleshooted.

In summary, the software for the STM32 microcontroller reads temperature data from a TMP102 sensor over the I2C communication protocol and outputs the readings via UART to a terminal. It also includes appropriate error handling and peripheral initialization to ensure that the system runs smoothly and can handle unexpected situations. The code allows for easy communication with the TMP102 sensor and provides a stable loop for continuous temperature monitoring with periodic readings.

Below is a flowchart demonstrating how the software for the TMP102 sensor works.

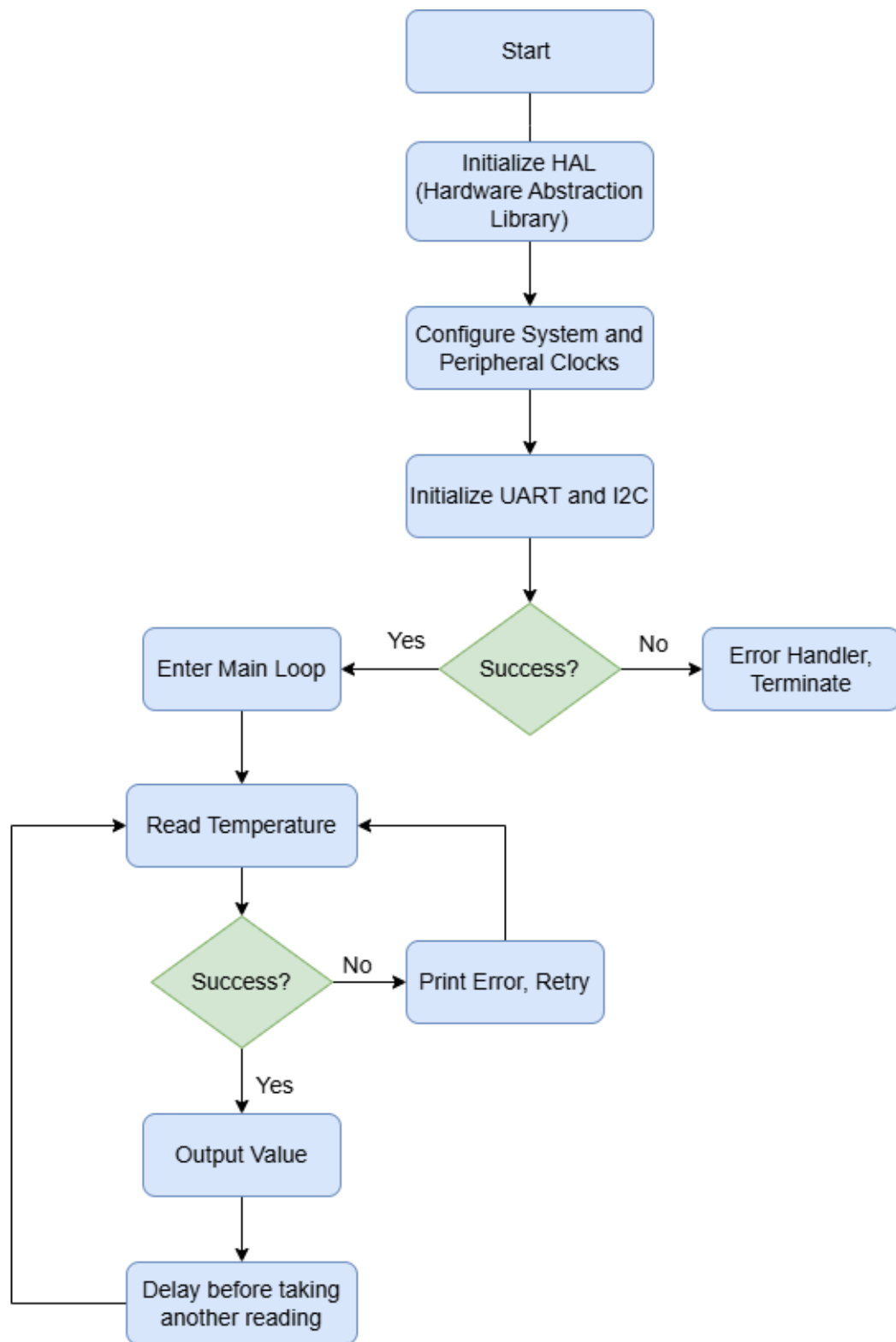


Figure 32: TMP102 Temperature Sensor Flowchart

7.5 CO2 Sensor

The software for the CO2 sensor utilizes the Sensirion SCD41 sensor to measure the concentration of carbon dioxide found within the environment. Since the SCD41 uses I2C as its communication method, it will be configured very similarly to the temperature sensor. The process begins by initializing various functions, such as the UART and I2C functions. Like the TMP102, it uses the `MX_I2C1_Init` and `MX_USART1_UART_Init` functions, and each parameter such as the baud rate and parity bits are configured the same.

The primary functionality for CO2 measurement is encapsulated in the `SCD41_ReadCO2` function. This function starts by sending a command to the sensor via I2C to initiate a CO2 measurement. The command is transmitted using the HAL function `HAL_I2C_Master_Transmit`, which writes the necessary command byte (0x03 for a measurement request) to the sensor. Following this, a delay of several seconds is introduced using `HAL_Delay` to allow the SCD41 sensor sufficient time to perform the measurement and prepare the data.

The delay was chosen to be 5 seconds since the SCD41 sensor requires sufficient time to perform its measurement and transmit the data to the STM32 microcontroller. The SCD41 operates in periodic measurement modes, where it requires several milliseconds to process environmental data and generate an accurate reading. Additionally, the sensor takes time to stabilize and respond to read requests, especially in conditions where environmental parameters are changing. Given the measurement cycle times and the sensor's processing requirements, a 5 second delay ensured that the sensor had enough time to complete its internal calculations, transmit the data reliably, and avoid any overlap or communication errors with subsequent readings. This delay helps maintain communication integrity and prevents the system from overwhelming the sensor with too many requests, allowing for efficient data acquisition.

After the delay, the function retrieves the raw measurement data from the sensor using `HAL_I2C_Master_Receive`. This data, received as two bytes representing the raw CO₂ concentration, is processed into a human-readable value in ppm by combining the bytes into a 16-bit integer and converting it to a floating-point number. Similar to the TMP102, error handling measures were implemented. If a communication failure occurred during the transmission or reception of data, the function prints an error message using `printf` and returns an invalid value to signal the failure. This allows for any errors to be quickly identified.

The subsystem operates in a continuous loop within the main function, repeatedly calling `SCD41_ReadCO2` to obtain updated CO₂ readings. The

results are transmitted over UART for display in the serial console, providing real-time monitoring. If an error is detected, an appropriate message is displayed to notify the user. This continuous operation ensures consistent air quality monitoring and enables integration with systems for automated responses, such as ventilation control or safety alerts. By leveraging these functions, the CO₂ sensor effectively fulfills its role in maintaining safe indoor air quality and contributing to occupant health and safety.

Below is a flowchart demonstrating how the software for the SCD41 sensor works.

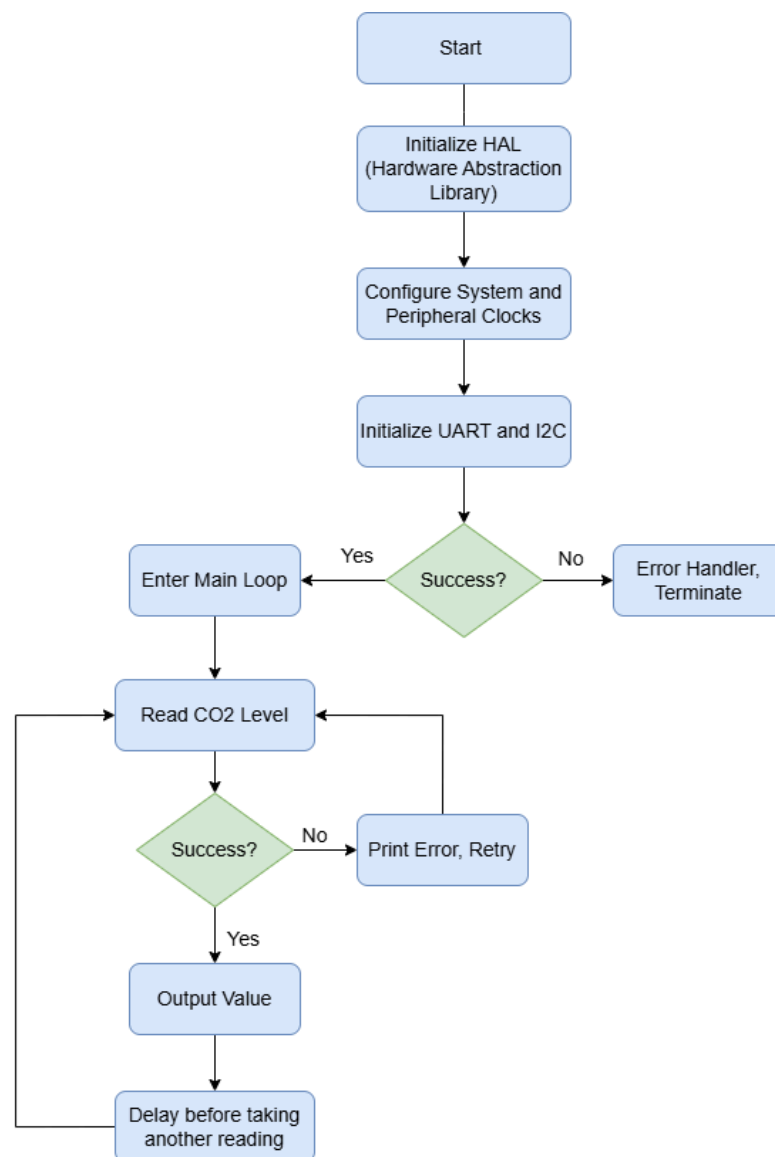


Figure 33: SCD41 CO2 Sensor Flowchart

7.6 BLE Testing

Bluetooth Low Energy (BLE) communication requires a robust and precise hardware setup to ensure reliable data transmission and reception. To test the BLE capabilities of the STM32, two separate software were created in order to implement a robust Bluetooth Low Energy (BLE) communication system, with one functioning as the BLE server and the other as the BLE client. Together, they facilitate seamless wireless communication by leveraging the RADIO and RADIO_TIMER peripherals for packet transmission and synchronization. Both codes are structured to handle the initialization of the system clock, GPIOs, and the critical RADIO peripherals, ensuring the hardware is correctly configured to meet BLE protocol requirements.

The server code initializes the system and configures the RADIO and RADIO_TIMER peripherals to operate as a BLE peripheral. It continuously advertises its availability to nearby BLE clients, broadcasting essential information such as its UUID and connection parameters. This setup allows a BLE client to discover the server and establish a connection. The server also processes data requests from the client and manages responses, acting as the provider of information or services. The MX_RADIO_Init function ensures the RADIO peripheral is prepared for transmitting and receiving BLE packets, while MX_RADIO_TIMER_Init configures precise timing to align with BLE's strict timing protocols. These components enable the server to operate as a reliable and responsive BLE device.

The client code, on the other hand, is designed to initiate communication with the server. It begins by scanning for available servers broadcasting their advertisements. Once it discovers a server that matches its predefined criteria, the client establishes a connection. The MX_RADIO_Init and MX_RADIO_TIMER_Init functions in the client code mirror those in the server code, ensuring the client's hardware is similarly configured for BLE operations. Once connected, the client can exchange data with the server, either by sending requests for information or subscribing to notifications. The client also plays a key role in managing the BLE connection, including determining the connection interval and ensuring efficient communication.

Together, the server and client codes implement a full BLE communication system. The server continuously advertises and awaits connections, while the client actively scans for available servers and manages the connection process. Both codes utilize the RADIO and RADIO_TIMER peripherals to ensure reliable packet transmission and precise timing synchronization, which are fundamental

to BLE's low-power, high-efficiency communication. By working in tandem, the two codes enable the seamless exchange of data, making this system suitable for a wide range of wireless communication applications.

More specifically, BREATHE will be using BLE to communicate between the control and the vent interaction subsystem, where environmental data and user input can be transmitted from the control MCU to the vent MCU in order to dictate the vent's behavior.

Below is a software diagram showcasing how the software responsible for BLE testing between two STM32 microcontrollers works.

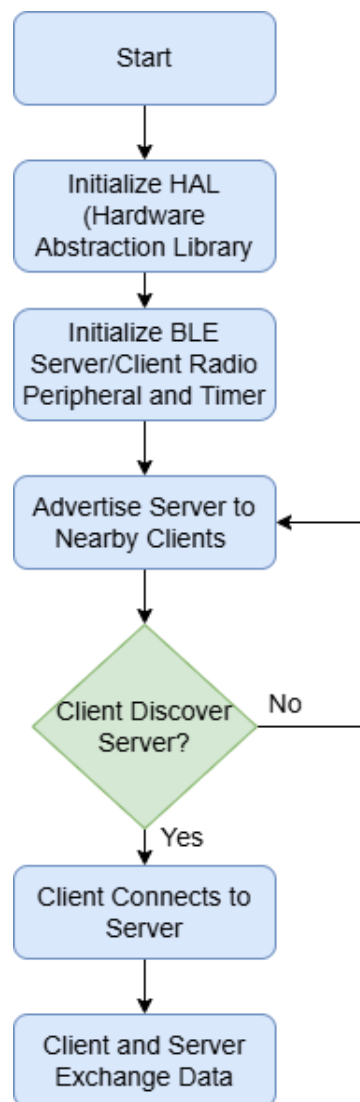


Figure 34: BLE Testing Flowchart

7.7 Buzzer

The electromagnetic buzzer acts by hooking up one terminal to a PWM signal from the MCU, and the other terminal to ground. The duty cycle of the PWM can cause the buzzer to turn on or off, and the frequency of the signal can affect the tone of the buzzer. The PWM signal is achieved by assigning the output pin to a timer, which is TIM2 on the STM32WB09KE. We utilize the `MX_TIM2_Init()` function to initialize the timer, and then configure the necessary registers to reach the desired state. In this function we set the mode to counter mode up, which means the timer increments up until a specific value is met before resetting back to 0 and causing an event to occur, which in this case is turning the timer on or off. The volume of the buzzer is dependent on the amplitude of the waveform. Although this is not adjustable through the STM32WB09KE by itself, the default sound through the development board is sufficient.

When implemented in the final design, the MCU will be waiting for a signal from the control unit to be transmitted via bluetooth. When it receives the signal, it'll store the message in a buffer and interpret it. The incoming message will either respond with a power alert or a CO2 alert. If the MCU receives a CO2 alert, it will send a PWM signal with a very high amplitude. This will be achieved through interfacing with the PSU through an additional unit such as an Op amp. For the power alert, the unit will send a PWM signal with a lower amplitude, which would utilize the same initial logic without additional interfacing with the PSU to adjust the signal.

Below is a diagram describing how the buzzer will be used.

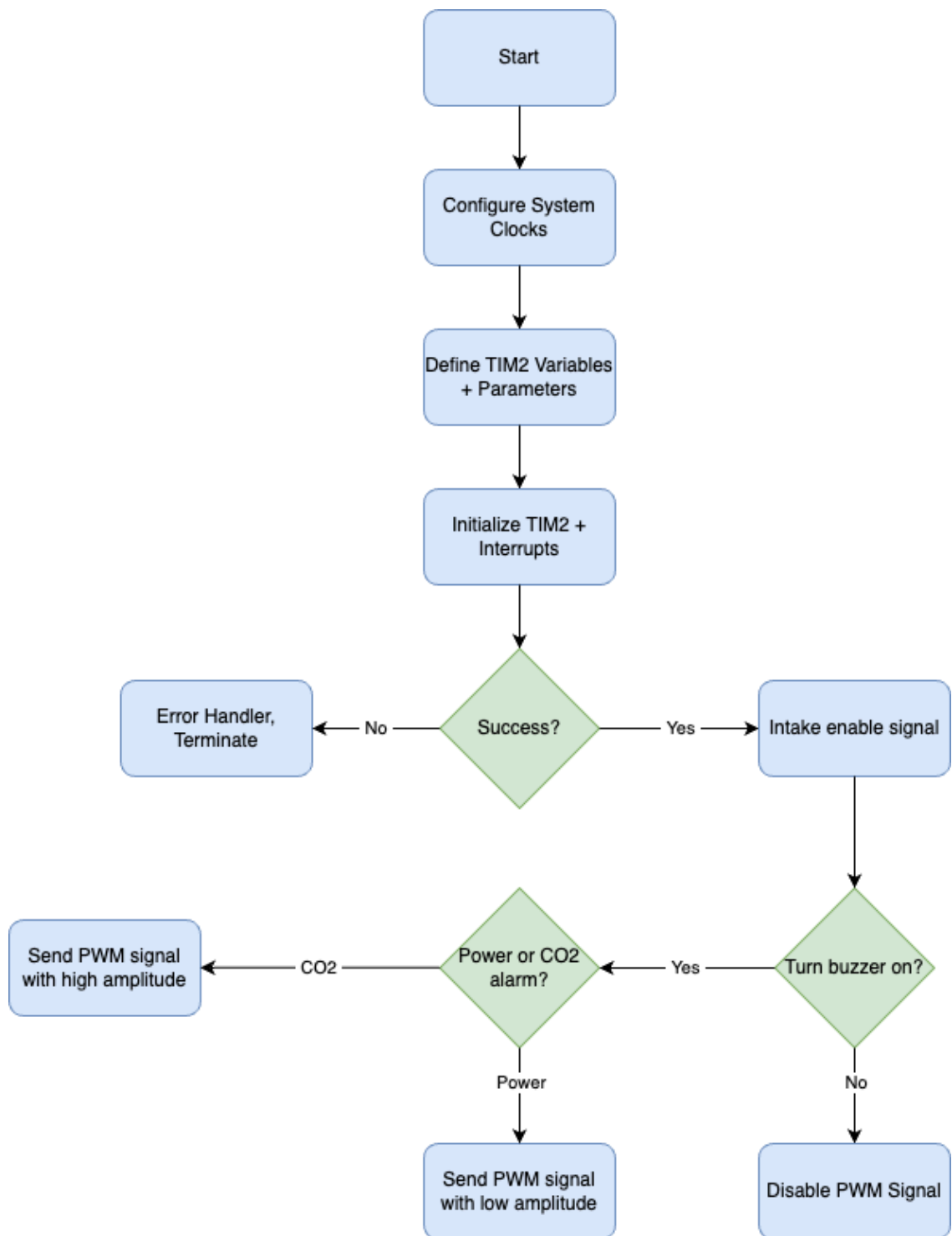


Figure 35: Buzzer Flowchart

7.8 Motor

BREATHE will be utilizing a servo motor to interface with the vent. To manipulate the actions of the motor, the MCU will be utilizing similar logic and have the same initial setup as the buzzer. Servo motors intake a PWM signal and adjust the angle of the motor's rod according to the pulse width. Similar to the buzzer, the MCU will use an initialized TIM2 to enable PWM output, and then hook it up to a pin different from the buzzer. This will then allow the MCU to adjust the pulse width being sent to the motor, allowing us to adjust the angle of louvers. Every servo motor has a unique period that is required for enabling movement. For the MG996R, a period of 50hz is required. By initializing this when setting up the TIM2 clock in the `__LL_TIM_CALC_ARR` function, we are able to interact with the motor and receive the desired movements. We can also adjust the pulse width of the output signal by using the `LL_TIM_OC_SetCompare` function. Below is a diagram showcasing the logic for initializing and utilizing the motor.

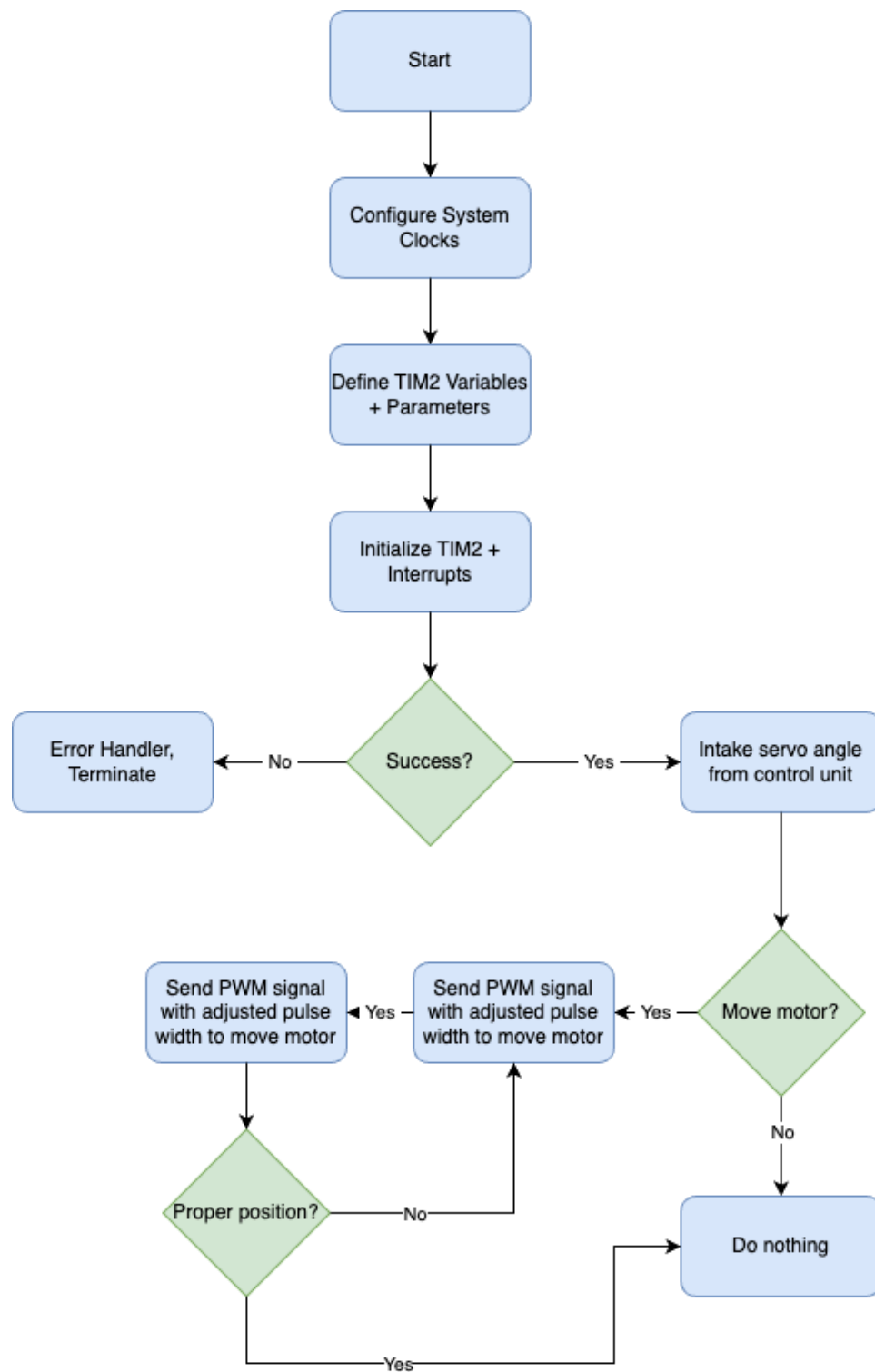


Figure 36: Motor Flowchart

7.9 User Interface System

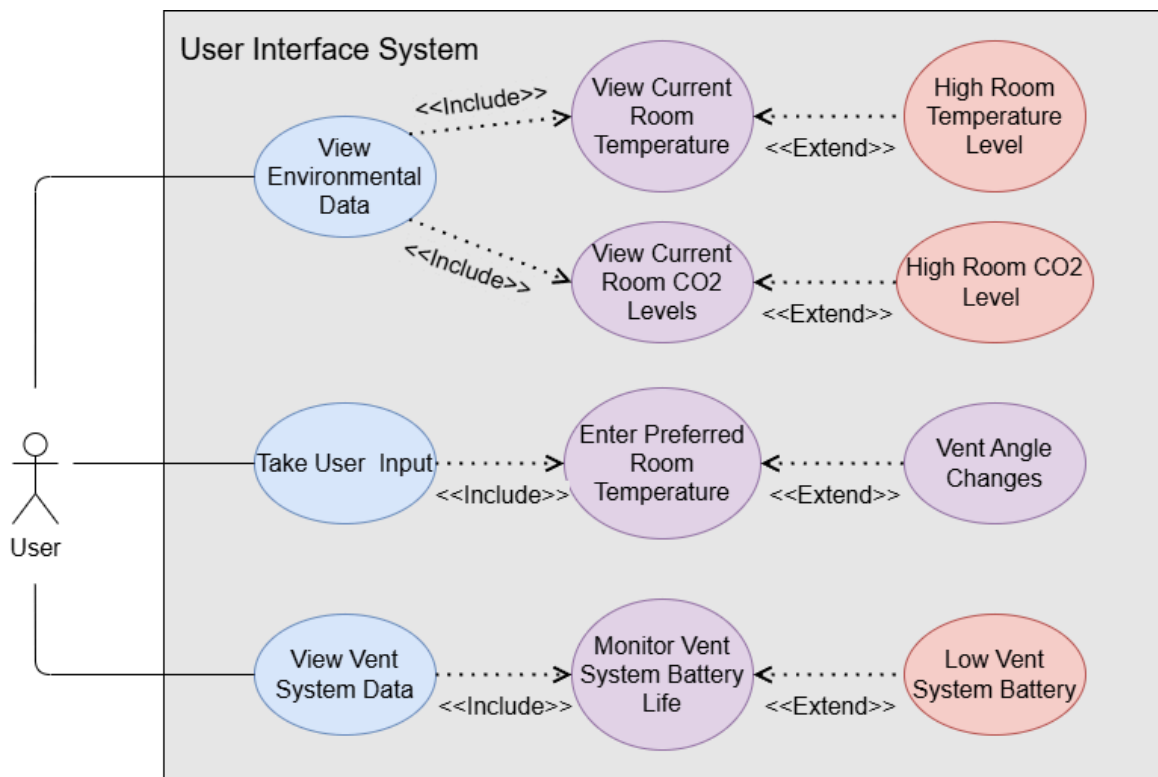


Figure 37: User Interface Use Case Diagram

As displayed above, the Use Case Diagram for the Smart Vent System outlines the interactions between the user and the system, as well as the system's response to user input. The diagram centers around the user, who interacts with the system to monitor environmental data and provide preferences for room conditions. The system allows the user to view environmental data, including the current room temperature and CO2 levels, and it provides the ability to determine if these conditions exceed acceptable thresholds. Additionally, the User can take input, such as entering their preferred room temperature, which directly influences the system's behavior.

Based on the user's input, the system adjusts the vent angle to maintain the desired room conditions. This is represented in the diagram by the "Vent Angle Changes" use case, which is triggered by the user's preferences or by the environmental data such as high room temperature or CO2 levels. If the user inputs a preferred temperature, the system adjusts the vent to help maintain that temperature. The use of the <<extend>> relationship indicates that the vent

angle change is contingent upon specific conditions, such as the user's input or when room temperature exceeds a predefined threshold.

In addition to the user-driven features, the system also monitors its battery life and alerts the user if the battery level is low, ensuring continuous operation. The "Monitor Vent System Battery Life" use case is linked to a "Low Vent System Battery" notification, signaling the user when the system's battery is nearing depletion. This provides the user with feedback on system health, enabling timely intervention if needed. These functionalities ensure that the system operates reliably and provides the user with an intuitive, interactive experience.

It is important to note that the system retains autonomous functionality. Even though the user can input preferences, the Smart Vent System is still capable of operating automatically in the background to maintain optimal conditions. If the user does not provide specific input, or if the system detects that conditions like room temperature or CO₂ levels are beyond acceptable limits, the vent adjusts automatically to bring the room back to comfortable levels. The autonomous features are seamlessly integrated, and the system will only omit this automatic behavior if the user explicitly chooses to rely solely on manual control. This flexibility allows the user to balance automation with manual preference, making the system adaptable to different needs.

In summary, this use case diagram effectively captures the various components of the Smart Vent System, highlighting both user-driven actions and system responses to user input. It shows how the system responds to environmental data and user preferences to maintain optimal room conditions, making the system both responsive and user-friendly.

7.10 Additional Software Design Considerations

7.10.1 Manually Implementing Floating Point Numbers In STM32CubeIDE

Initially, the STM32 microcontroller did not support floating-point operations, which presented a significant challenge for implementing the BLE communication system, particularly for processing sensor data such as CO₂ concentrations. The SCD41 sensor outputs its CO₂ measurements in a raw format, which requires conversion into floating-point values (parts per million, ppm) for accurate and meaningful representation. However, without floating-point support enabled, the microcontroller was unable to perform the necessary arithmetic operations, resulting in errors or incorrect data processing.

To address this, it was necessary to manually configure the build environment to enable floating-point support. Specifically, the project had to be configured with the `-u _printf_float` linker flag to ensure that floating-point operations were properly supported during runtime. This flag allows the STM32 to handle floating-point arguments in functions like `printf` and ensures that the floating-point library is linked correctly. Without this configuration, any attempt to use `printf` to output floating-point values would result in errors or omitted data, as the default configuration of many STM32 environments excludes floating-point support to conserve memory.

Enabling floating-point support required adjustments in the project's makefile or build settings in the IDE. For example, in STM32CubeIDE, this was accomplished by adding the `-u _printf_float` flag to the linker options. This modification ensured that floating-point values could be processed and displayed correctly, which was essential for debugging and analyzing sensor data in real time. Although this configuration increases memory usage slightly, it is critical for applications that rely on precise numerical computations.

This manual configuration not only resolved the immediate issue but also highlighted an important aspect of embedded systems development: the need to tailor the build environment to the specific requirements of the application. By enabling floating-point support, the STM32 was able to seamlessly handle the data conversion and output operations required for the BLE system, ensuring accurate and meaningful communication between devices.

7.10.2 Clearing Flash

During the development and testing phases of the Smart Vent System, clearing the flash memory periodically was a crucial step to ensure reliable operation. Flash memory in embedded systems like the STM32 is used to store firmware, calibration data, and other configuration settings. As part of the iterative development process, frequent updates to the code and settings meant that reprogramming the device and ensuring the flash memory was cleared of outdated or incorrect data was necessary. Failure to do so could result in conflicts between old and new code, causing unpredictable behavior or system crashes. This was particularly important for ensuring that new firmware versions would not interact with residual data from previous versions, which could lead to errors or faulty sensor readings.

Clearing the flash memory was essential for several reasons. First, it helped avoid data corruption, as old data from previous firmware versions could remain

in the flash memory unless explicitly erased. This could lead to conflicts with the new code, especially if the old data was incompatible with the new version. Second, clearing the flash ensured that the system always started with a clean slate each time new firmware was loaded, which helped maintain consistency and prevent issues from leftover data. Third, periodic clearing helped prevent flash wear, which is important when frequently updating firmware, even though modern flash memory has wear-leveling mechanisms to mitigate excessive writes. Finally, during development and debugging, clearing the flash allowed the team to test new code versions without the risk of residual data affecting the system's behavior.

To manage this process, STM32CubeProgrammer was used. This software tool, part of the STM32Cube suite, provided a reliable interface for programming, erasing, and reading the flash memory of STM32 microcontrollers. STM32CubeProgrammer allowed the user to connect to the STM32 microcontroller via a ST-Link programmer or USB-to-serial interface, depending on the hardware configuration. Once connected, the tool enabled the erasure of the flash memory, either entirely or by erasing specific sectors that needed to be cleared. This was a critical part of the reprogramming process, ensuring that outdated or corrupt data did not interfere with the new firmware.

After the flash was cleared, new firmware was flashed onto the microcontroller using STM32CubeProgrammer. The software also provided a verification process to ensure that the new code was written correctly and without errors. During debugging sessions, STM32CubeProgrammer allowed the development team to monitor the system's behavior in real time, checking for any issues that might arise due to flash corruption or residual data. This ensured that each firmware iteration was installed properly and that the system was ready for further testing or deployment. Conclusively, the ability to clear and reprogram the flash memory using STM32CubeProgrammer played an important role in maintaining the integrity of the development process and ensuring that the Smart Vent System operated as expected.

8.0 System Fabrication and Prototype Construction

When designing the PCBs for our project we understood that we would need to separate it into two separate PCBs, one for the Control Unit and one for the Vent Interaction Subsystem. In doing so there are certain key aspects one must take into account before making their PCB layout. For starters a detailed system

schematic is crucial for PCB design and since we have detailed our process for the schematic designs in chapter 6 by using KiCad the next step is to begin the boards layout process.

First, we needed to decide on which company would fabricate and ship our PCBs as this will decide the board stackup and the design constraints. The stackups and design constraints are typically unique to each fabrication company. We chose to use JLCPCB as they are widely used, have reasonable pricing, and have decent quality control. We also chose to use a 4 layer board as it doesn't add too much cost and will make routing easier. JLC PCB has many different options for board stackups, but we particularly needed an impedance controlled stackup to handle the RF components needed for the MCU. The RF components as a result will need specific trace widths in comparison to the other routed components. JLC PCB thankfully has a calculator which will show the various stackups and accompanying RF trace widths for a 50 Ω impedance matched transmission line. We opted to use a microstrip line for simplicity and used the JLC041611-2116 board stackup with 1oz inner and outer copper layers. The stackup's incorporation into the KiCad board setup is shown below in Figure 38. This board configuration set our trace width for the RF traces to 0.1725mm which is important for routing later on [125].

The image shows the 'Board Stackup' dialog in KiCad, configured for a 4-layer impedance-controlled PCB. The stackup is as follows:

Layer	Id	Type	Material	Thickness	Color	Epsilon R	Loss Tan
F.Silkscreen	Top Silk Screen	Not specified	Not specified		Not specified		
F.Paste	Top Solder Paste						
F.Mask	Top Solder Mask	Not specified	0.01 mm	Not specified	3.3	0	
F.Cu	Copper		0.035 mm				
Dielectric 1	PrePreg	2116	0.109 mm	FR4 natural	4.16	0	
In1.Cu	Copper		0.03 mm				
Dielectric 2	Core	FR4	1.23 mm	FR4 natural	4.6	0.02	
In2.Cu	Copper		0.03 mm				
Dielectric 3	PrePreg	2116	0.109 mm	Not specified	4.16	0.02	
B.Cu	Copper		0.035 mm				
B.Mask	Bottom Solder Mask	Not specified	0.01 mm	Not specified	3.3	0	

At the bottom, the 'Board thickness from stackup' is calculated as 1.598 mm, and there is an 'Adjust Dielectric Thickness' button.

Figure 38: KiCad Board Stackup

JLC PCB also has specific design constraints that can be incorporated into KiCad which will be useful when running the final DRC check to show the constraints are being met [126]. These design constraints need to be met so JLC PCB can also properly fabricate the board. These standards were incorporated into our design with a little extra slack above the minimum design constraints to reduce cost a little since using purely the minimum constraints would add to the cost of fabrication.

Once the setup of our board layout is complete we can begin with organizing components. At first when you open the PCB editor all of the components you used in your schematic editor sheet are imported and clustered together and organized by component type not connections. A good rule of thumb for organization sake is to select the specific schematic you'd like to work on in the schematic editor which will highlight all the components pertaining to that part in the PCB editor and then you can move them to a less congested area to begin the layout. The best practice when it comes to the PCB layout is to start with the MCU since it is the most critical component and then move on to organizing the decoupling capacitors as close to their MCU pin connections as feasible. Moving forward, the next step would be to proceed onto the most sensitive components, in our case the crystal oscillators were next and then progressing from most to least sensitive components. Once the layout is organized per connection and schematic guidelines, you can then begin to route your connecting components together. First we needed to establish our two inner layers to be dedicated ground planes and the bottom layer to be used for routing vias and power.

8.1 Control Unit PCB

Since the Control unit consists of the most peripherals it was by far the most challenging PCB to design. Following the steps explained in the introduction above is the majority of how the layout design came from. However, since the placement of the peripherals was also something to consider in terms of designing it added an extra step to consider. Since the main visual aspect of the control unit consists of the LCD screen it was important to consider that the housing unit size and PCB for this unit were proportional to the screen and didn't look outlandish. The LCD screen is 95mm by 62mm and the PCB behind it could only be at most about 25-38mm larger. The actual dimensions of the designed pcb are 103mm by 70mm and thus we successfully designed within the bounds of our specifications. As far as the peripheral component placements went we decided that the barrel jack connector would be best placed near either the bottom left or bottom right corners so a user could easily

plug in the unit without any unnecessary bending of the cable that would happen if it were placed on the sides or on the top. The buzzer was chosen to be in a higher configuration on the board so as to be able to project the sound at an altitude closer to the user's ears. Next would be the temperature and carbon dioxide sensor which were chosen to be placed across from each other on the right side of the board to not interfere with the buzzer or power supply sections. A component layout and 3D view of the control unit PCB can be seen below in Figures 39 and 40.

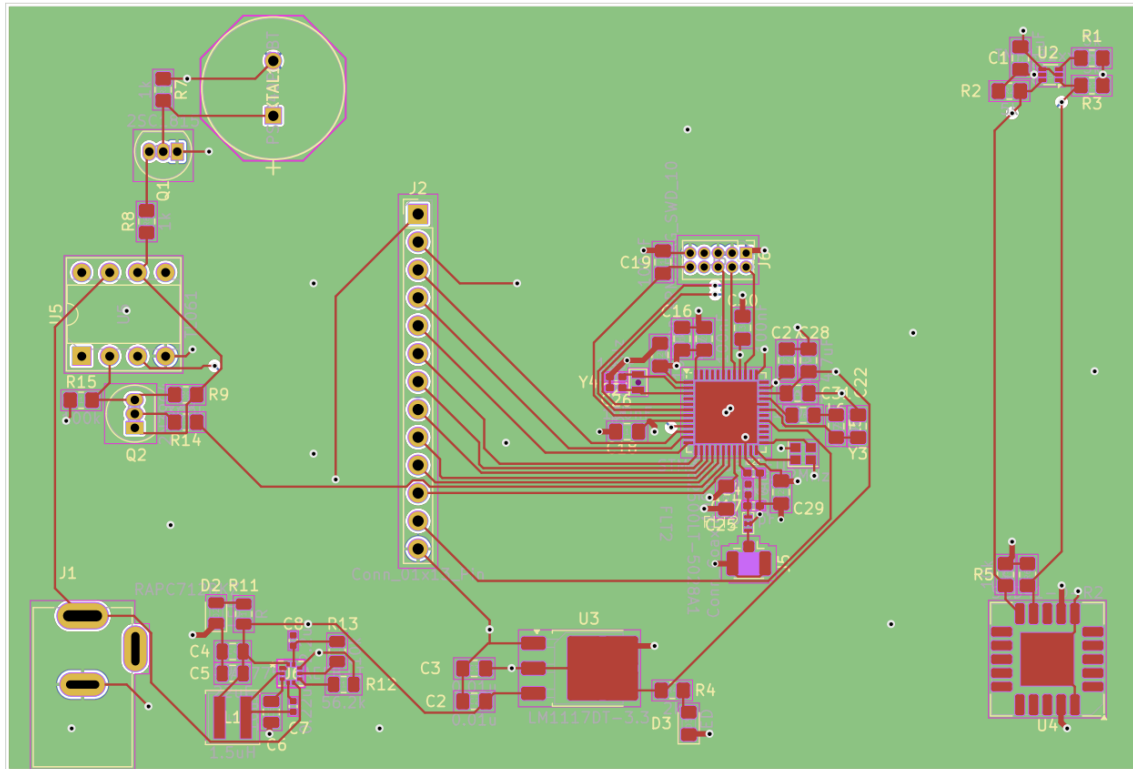


Figure 39: Control unit PCB Layout

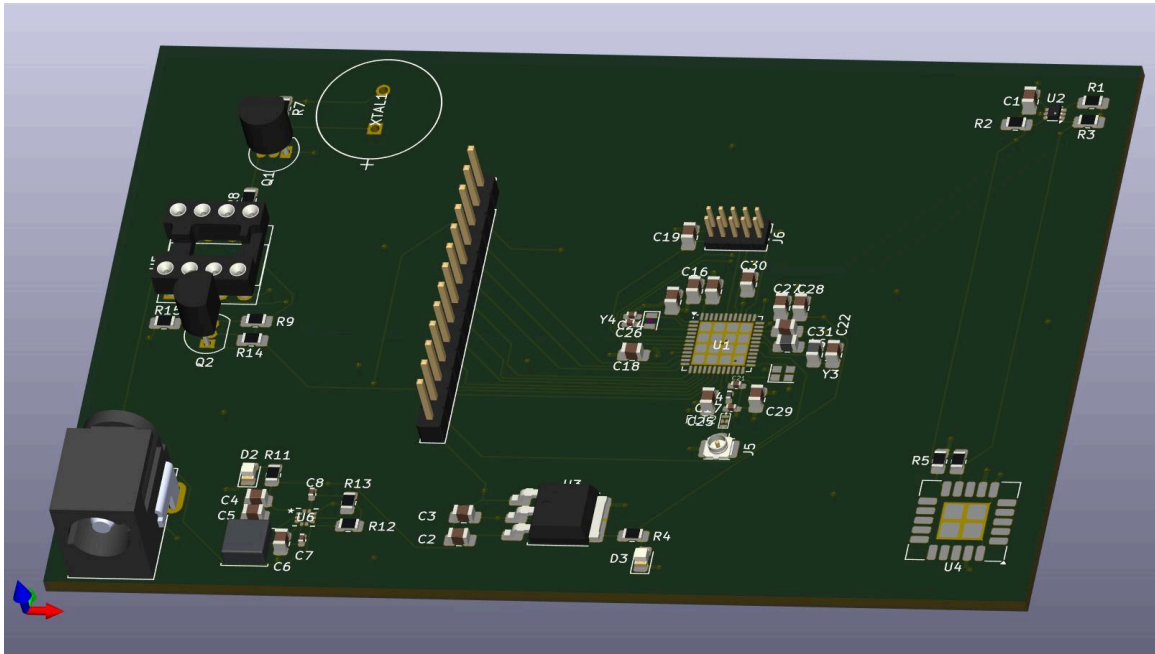


Figure 40: 3D Model of Control Unit PCB

8.2 Vent Interaction Subsystem PCB

Comparatively to the Control Unit PCB, the vent interaction subsystem had much fewer peripherals, but the two buck regulators did require careful routing. The MCU required careful placement to ensure components could easily be routed, and some capacitors needed to be changed from an 0805 package to an 0603 package just to be able to fit some of the necessary vias and traces. Decoupling capacitors needed to be placed as close as possible to the MCU, but sometimes we needed to move them farther away to make sure more critical components could be routed properly. For most power and ground traces 0.5mm traces were used, which usually required using a 0.2mm trace until enough clearance was given to use a 0.5mm trace. The inner two copper layers were dedicated entirely to ground whilst the bottom layer was given a full copper pour for 2.5V power connections. The bottom layer was also used to route traces through vias if they could not be easily routed on the top layer. Some of the dedicated inductors or bulk capacitors were given multiple ground vias to reduce inductance and dissipate more heat. The MCU was also given many ground pads for this same reason, aptly placed to not cause any clearance issues with the MCU's pads.

The two buck-regulators were placed in the general vicinity of where the components that needed the specific voltage rails were. So the 5V rail was

placed near the jumper for the motor whilst the 2.5V rail was placed near the MCU. One of the trickier routes involved the buck regulators. Since the 9V supply was only near one regulator, many vias had to be placed to get the 9V supply across to the 5V regulator. In the future, a layout with both regulators in close vicinity would be preferred. Copper pours on the bottom layers were used around the inductor for some pins and the precautions described in the PCB design section of the regulator's datasheet were followed as closely as possible [66].

The crystal oscillators also needed to be placed as close as possible to its necessary pins and also relatively far away from the SMPS inductor. The RF traces were the most delicate as they needed to be placed as close as possible to the RF1 pin to ensure proper functionality. The antenna, low pass filter, and matching network were placed extremely close together to ensure traces were short. These traces were 0.1725mm as specified previously to ensure the 50 Ω line is impedance controlled. These RF components were given green net classes to make placement easier as seen in the image below.

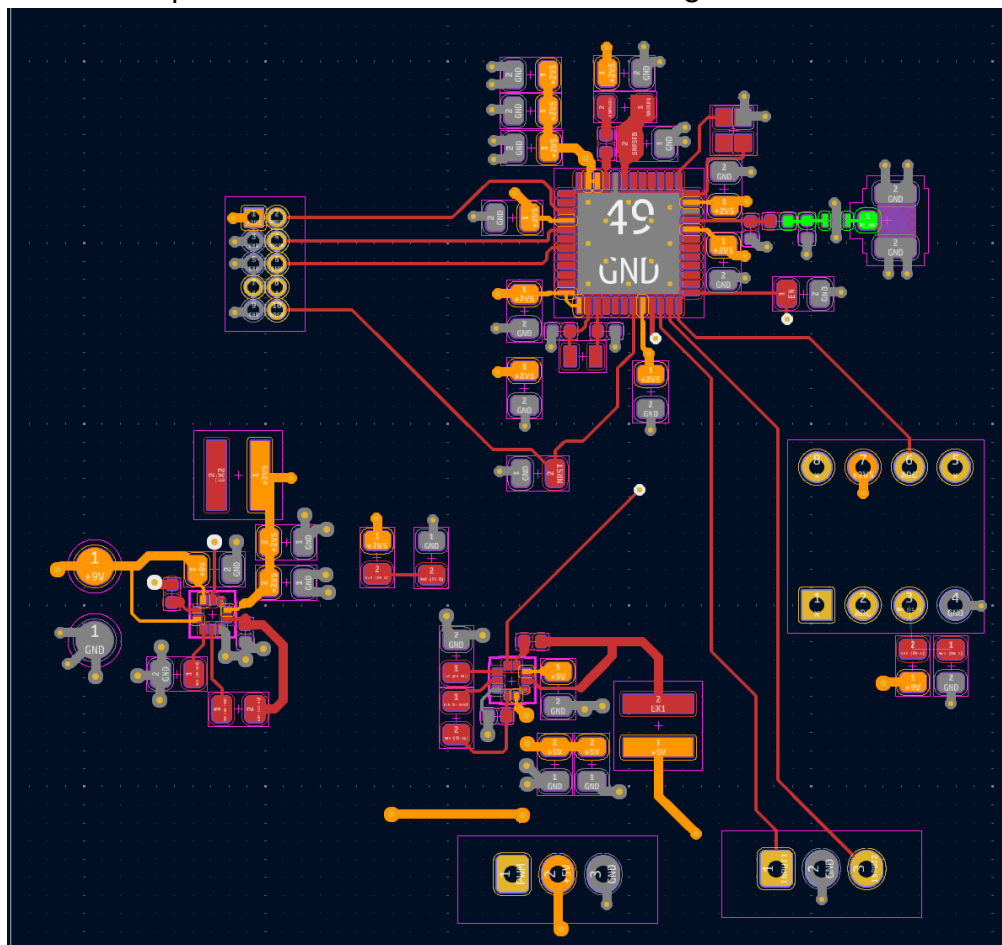


Figure 41: Vent Interaction Subsystem PCB Layout

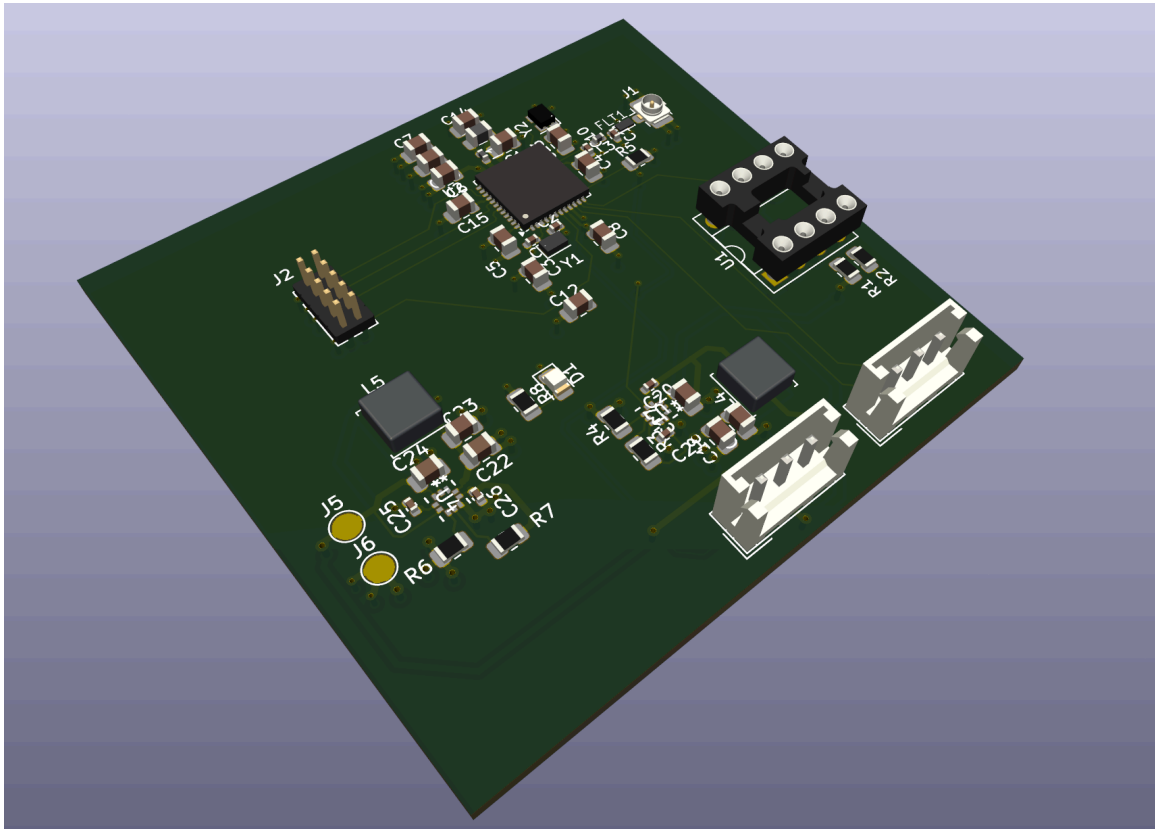


Figure 42: 3D Model of Vent Interaction Subsystem PCB

8.3 Prototype Construction

8.3.1 Control unit

For the control unit, the goal is to create a simplified box that can be mounted onto a wall at eye level for the user where they can easily access the LCD screen to make temperature adjustments needed without having to open an enclosure to access the screen. A 3D prototype visual can be seen in Figure 43 of this enclosure. The lid of the enclosure will have the LCD screen and 3 drilled holes in front of the sensors and buzzer. These holes will act as an opening for the sensors to get more accurate readings of the environment's temperature and carbon dioxide levels as well as an opening for the buzzer's sound to more easily escape from the enclosure. As of now, we are still deciding on whether we should 3D print this enclosure utilizing UCF's Senior Design lab technologies or outsourcing the task to a company such as Hammond. Hammond produces a variety of electrical enclosures that are easily customizable. A particular model

we are considering is the Diecast Aluminum Enclosure 1590 series which boasts protection against water, dust and improves shielding from Electromagnetic Interference (EMI) and Radio Frequency Interference (RFI).

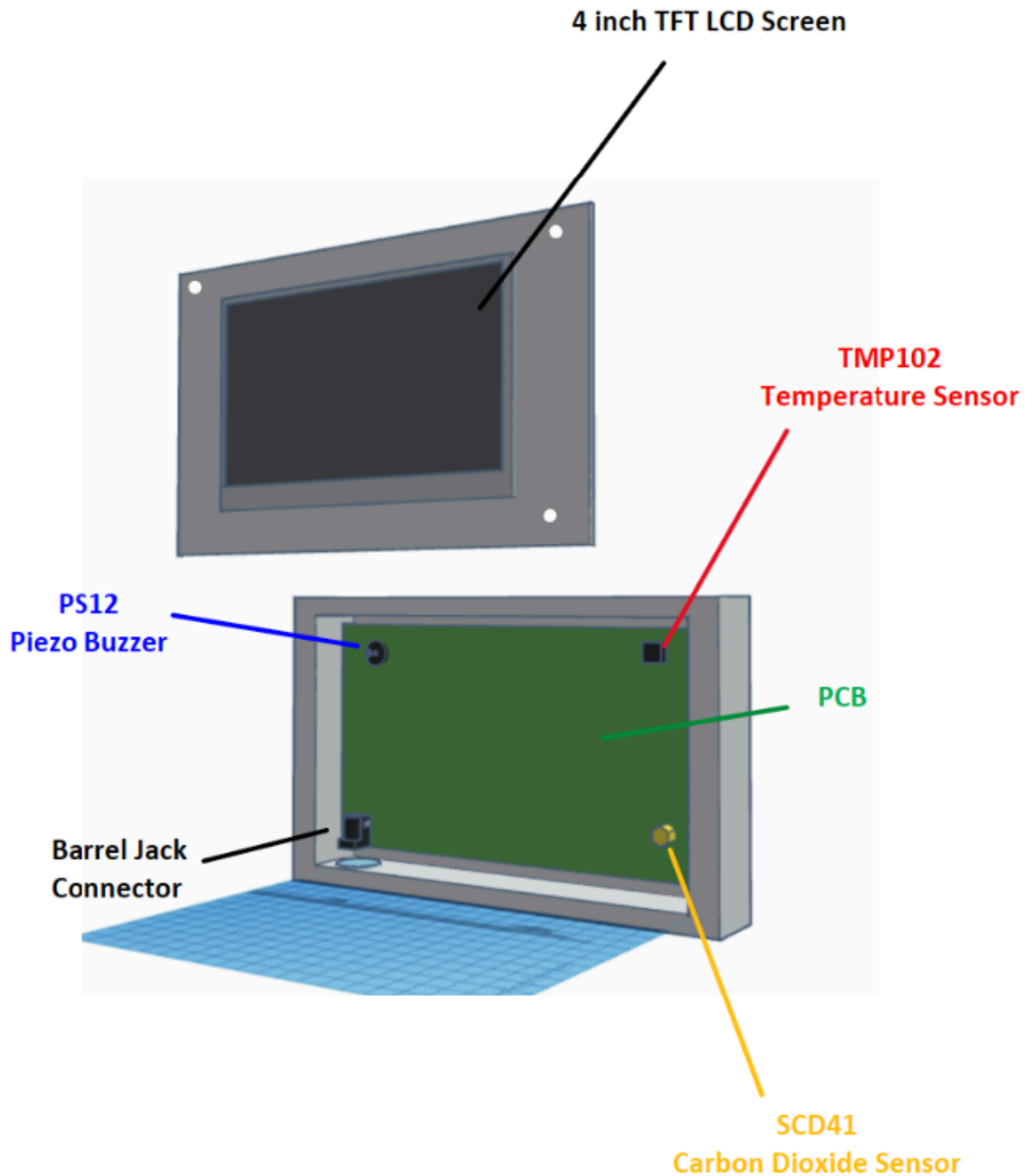


Figure 43: Prototype design for Control Unit

8.3.2 Vent Interaction Subsystem

For the Vent Interaction Subsystem, the main goal was for this to be compact enough to fit inside of the ceiling duct with our vent. In Figure 44, you can see our prototype idea for how the components will fit in the vent. This view is from the back side of the vent where the louvers are located with our components located beside them. The 9V batteries, servo motor, and PCB are all closely placed on one side of the louvers thus showing how important a compact design is. As a team, we are still combing through our options to decide whether we would like to use a pre-existing vent anyone can purchase at a home improvement store and attach our components, or 3D design and print something completely custom to what we need and what could ultimately work most efficiently.

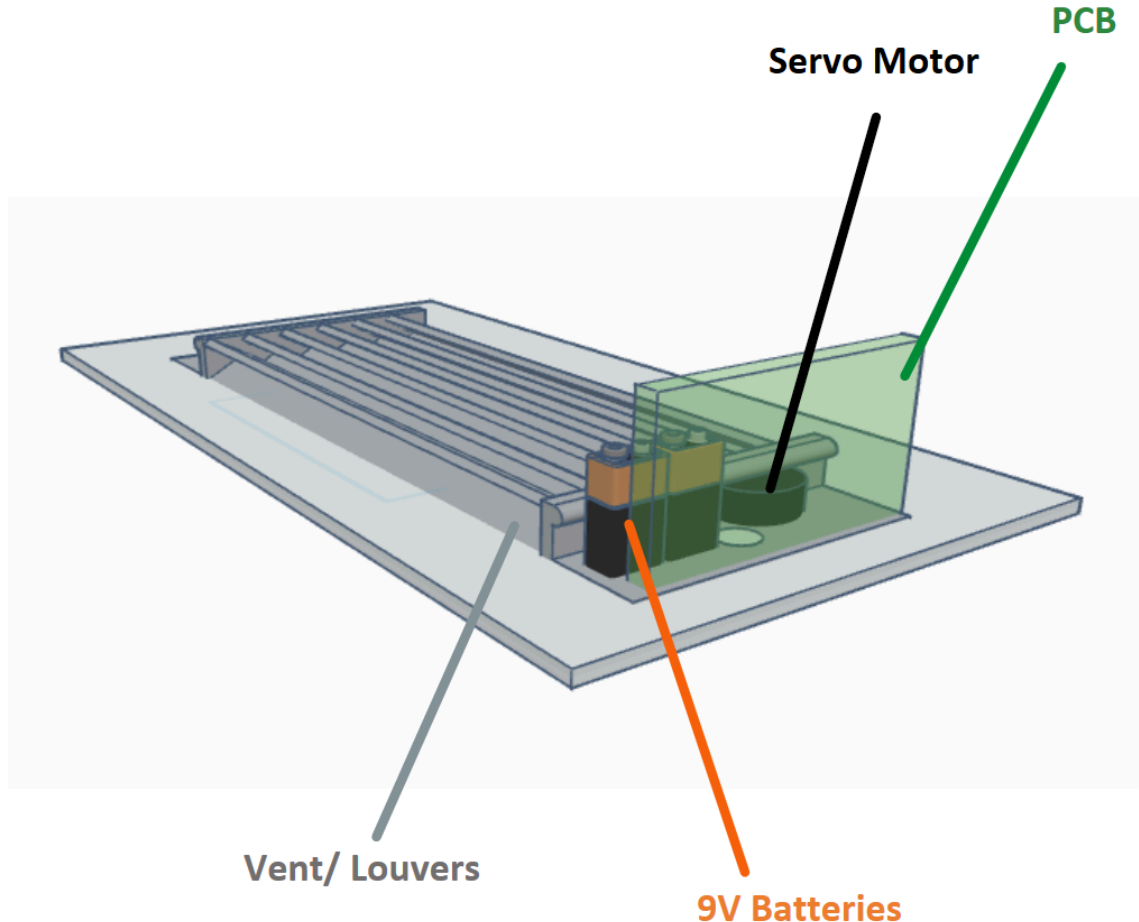


Figure 44: Prototype design for Vent Interactive Subsystem

9.0 System Testing and Evaluation

9.1 Intro

There's a certain level of programming to go along with each of our hardware components which in a way intertwines both components of testing. Both hardware and software required thorough testing to ensure the system functions as intended. While hardware testing involved tasks like verifying connections, measuring voltages, and checking signal integrity, developing the software for each hardware component was equally essential to ensure seamless integration. This included managing communication protocols such as I2C or SPI and ensuring accurate data flow between devices. Together, these processes allow us to identify and resolve issues more effectively, as problems in functionality can arise from either hardware faults or software misconfigurations. This combined approach ensures that both the hardware and software aspects of the system work seamlessly in unison.

9.2 STM32 Software Testing

In order to test the STM32WB09KE, we used the NUCLEO-WB09KE board and utilized the STM32CubeIDE to generate code. Unfortunately there was not much documentation for the board that we chose, however we were able to create and test code while referencing the datasheet and the sample code from the IDE. First we created an account on the ST website and connected it to the STM32CubeIDE. From here we were able to download the necessary firmware to our board. We then referenced the datasheet for the NUCLEO-WB09KE to see the ports and their corresponding pins. After creating a sample STM32 project we used the Hardware Abstraction Layer (HAL) to generate the necessary code to configure the registers for the GPIO pins, and enable the port. First we went to the project's .ioc file to open the diagram with the chip. We then configured the chip to enable output for a GPIO pin and toggled the pin every 500 milliseconds. After hooking up the pin to an LED we were confident that we could interface with the pins on the board, and that the board could perform basic functionality.

In order to perform tests on the STM32WB09KE, we used the NUCLEO-WB0KE development board and utilized the STM32CubeIDE to develop software. Despite the small documentation for the board, creating and testing code was possible through referencing both the datasheet and sample code provided from the STM32CubeIDE. We broke down our goals into smaller subgoals and aimed to work our way up. For example, to test the temperature sensor we first had to

ensure that our board could run basic code and print to a terminal before looking into retrieving data from the sensor.

9.3 Bluetooth Testing

In order to test the BLE capabilities of the STM32, we implemented the sample code available through the IDE to establish the bluetooth connection between two NUCLEO-WB09KE boards. We first tested the bluetooth compatibility of the boards by creating code by referencing the BLE_p2pServer sample code. We then uploaded the code to the board and established a connection to a mobile phone through the STM32WB app. By doing so we were able to send a signal to the board and toggle an LED. Afterwards, we drafted and tested code on both boards to establish a client and server relationship. These files enabled BLE on both boards and would cause them to search for a compatible board and connect. Once they are connected many functionalities can be done to prove connectivity, such as pressing a button on the server to send a signal to the client and enable an LED.

9.4 UART Testing

Universal Asynchronous Receiver Transmitter (UART) was utilized to verify if the data from each sensor was transmitted and received correctly. In short, UART served as a reliable and simple means of observing sensor outputs.

In order to implement UART, functions were created that defined various parameters such as baud rate and parity bit. These parameters were adjusted by experimenting with various configurations, such as using different baud rates ranging from 9600 to 115200 and switching the parity bit between odd and none. Generally, standard settings were followed to maintain interoperability. However, testing these configurations ensured stable UART communication and reliable data transmissions, especially when interfacing with the connected sensors. This process helped us determine the most optimal settings for exchanging data in the final implementation.

After implementing UART and experimenting with different parameters, the STM32 was integrated with each sensor through I2C for data transmission and acquisition. To monitor and evaluate the transmitted data, we used the terminal monitoring application Tera Term the terminal application utilized was Tera Term. Tera Term provides a user-friendly interface for viewing data transmission, debugging communication errors, and validating sensor outputs. The terminal

also facilitated debugging by showing any error messages or unexpected data patterns, enabling quick identification and resolution of issues.

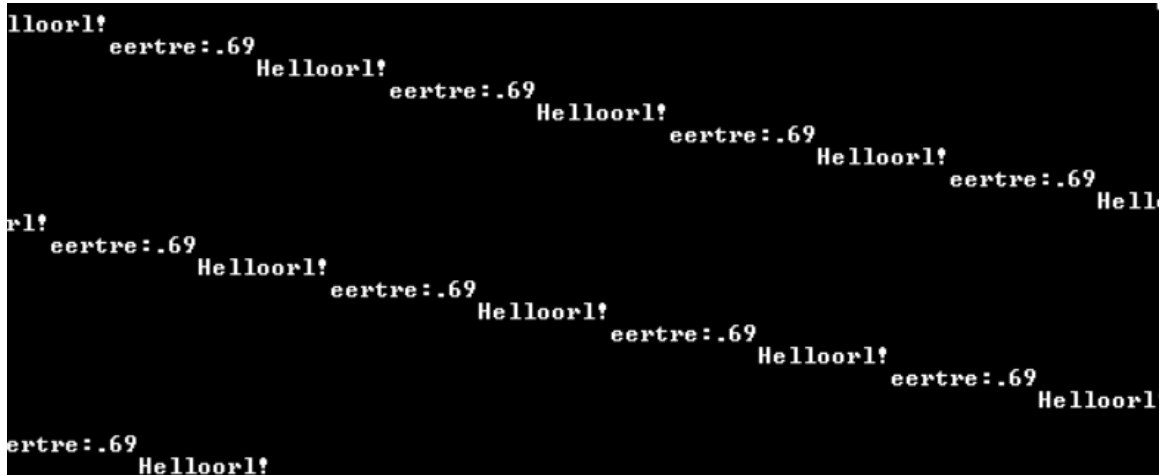


Figure 45: Communication Error

Sometimes, there were some failures in communication between the sensor and the MCU. These issues usually stemmed from the I2C communication protocol, which was responsible for the data transmission between the sensor and the MCU.

9.5 Carbon Dioxide Sensor Testing

9.5.1 Software Testing

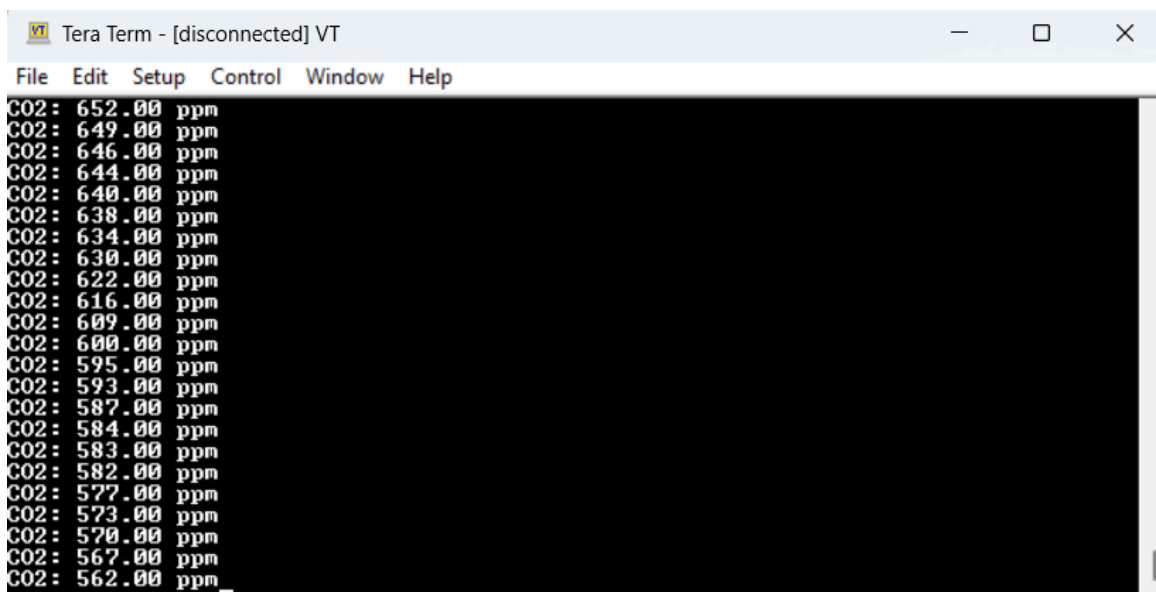
Software testing for the CO₂ sensor involved developing and verifying the code needed to initialize and communicate with the sensor. As aforementioned in the software section, a crucial portion of testing the software was configuring UART and I2C settings by establishing various settings such as baud rate and I2C addressing modes. After this, a function was created to read the CO₂ around the temperature's environment. Then, the results from this reading would be outputted to a Tera Term terminal via UART.

During software testing for the CO₂ sensor, an issue was encountered where the system failed to read CO₂ data, with the error message "Failed to read CO₂ data" consistently appearing. After debugging, it was determined that the issue stemmed from a misconfiguration of the I2C communication protocol, which the sensor relied on to exchange data with the microcontroller. The misconfiguration involved an incorrect I2C address setting, which caused the communication between the STM32 and the SCD41 sensor to fail. Since the STM32 was

attempting to communicate with a wrong address, the sensor did not respond, resulting in unsuccessful data reads.

To resolve the issue, we reconfigured the I2C settings in the microcontroller firmware. This involved correcting the I2C address in the code to match the SCD41 sensor's correct address and adjusting the communication parameters to ensure proper data transfer. After making these adjustments, communication between the sensor and the microcontroller was successfully established, allowing for accurate CO₂ data readings.

This debugging process highlighted the importance of ensuring proper configuration of communication protocols and thorough testing under various conditions to identify and resolve such issues.

A screenshot of a Tera Term terminal window titled "Tera Term - [disconnected] VT". The window has a menu bar with "File", "Edit", "Setup", "Control", "Window", and "Help". The terminal displays a list of 20 CO2 readings, each followed by "ppm". The readings are: 652.00, 649.00, 646.00, 644.00, 640.00, 638.00, 634.00, 630.00, 622.00, 616.00, 609.00, 600.00, 595.00, 593.00, 587.00, 584.00, 583.00, 582.00, 577.00, 573.00, 570.00, 567.00, and 562.00. The text is white on a black background.

```
CO2: 652.00 ppm
CO2: 649.00 ppm
CO2: 646.00 ppm
CO2: 644.00 ppm
CO2: 640.00 ppm
CO2: 638.00 ppm
CO2: 634.00 ppm
CO2: 630.00 ppm
CO2: 622.00 ppm
CO2: 616.00 ppm
CO2: 609.00 ppm
CO2: 600.00 ppm
CO2: 595.00 ppm
CO2: 593.00 ppm
CO2: 587.00 ppm
CO2: 584.00 ppm
CO2: 583.00 ppm
CO2: 582.00 ppm
CO2: 577.00 ppm
CO2: 573.00 ppm
CO2: 570.00 ppm
CO2: 567.00 ppm
CO2: 562.00 ppm
```

Figure 46: Successful reading of CO₂

9.5.2 Hardware testing

Once the initial coding was complete, the next step was to conduct the hardware testing of the CO₂ sensor. Our plan for testing was to subject the CO₂ sensor to multiple different environments to ensure its measurement capabilities and ultimately implement a pass fail criteria for the results.

To begin testing, our group started off by placing the CO₂ inside of an occupied UCF library study room. Results showed that the CO₂ levels were around 1100 ppm (parts per million) which is accurate to what the average levels of a small enclosed room would be with poor air circulation, and thus it passed this initial

test. Following this, we moved the sensor outside of the study room to the third floor of the library to which we hypothesized would give us a decrease in ppm levels. However, to our surprise they were actually elevated and reached about 1300 ppm. After some consideration, we concluded that the crowded 3rd floor had elevated CO₂ levels during midterm exam week. It became clear that the increased levels were due to the significantly higher number of people on the floor at that time. We then proceeded to walk outside of the library to an open area near trees and the ppm values decreased immensely to around 300 ppm, which also passed since 300 ppm is the average natural concentration of an outdoor environment. With these results, we deemed that overall the CO₂ successfully passed each test case.

9.6 Temperature Sensor Testing

9.6.1 Software testing

To test the software for the temperature sensor, it was crucial to establish an I2C connection and ensure we could print information to a terminal, similar to the carbon dioxide sensor. Initially, there was an issue with printing data through UART to the terminal, as the I2C connection worked, but the terminal displayed garbage text. The temperature reading could be partially seen, however it was obstructed by a jumbled mix of letters and ascii symbols instead of the temperature reading. This issue was traced to a mismatch in configuration between the settings in the code and the terminal software. Specifically, the UART configuration in the code had a bit setting of 8, while the terminal was set to 7 bits. Once this discrepancy was identified, adjusting the terminal settings to match the code resolved the issue, enabling clear and accurate data to be displayed.

With UART communication successfully established, we proceeded to connect the temperature sensor to the corresponding pins on the development board, referencing the datasheet to ensure proper connections. I2C communication was implemented by sending the base address of 0x48 to initiate a read request to the carbon dioxide sensor, which responded with two bytes of data representing the temperature. These bytes were then combined into a single float variable, which we printed to the terminal for verification. After successful debugging of the UART configurations in the software, we could proceed to hardware testing.

9.6.2 Hardware testing

For hardware testing of the TMP102 temperature sensor, our plan consisted of programming the sensor in conjunction with the STM32 development board kit. Since the sensor doesn't have visual or audible cues for showcasing successful readings, it required a programmable aspect to view the readings of the temperature in a Tera Term terminal window. After successfully implementing and testing the software for the TMP102 temperature sensor, we moved on to hardware testing. Our plan involved programming the sensor to work along with the STM32 development board kit. As mentioned earlier, the TMP102 sensor relied on outputting data to a Tera Term terminal window, allowing us to monitor and verify the sensor's output during testing.

Once programming was completed and troubleshooting was finalized, we were able to get consistent readings of temperature. We first tested if the sensor could read a consistent value of the ambient temperature of the room it was located in and then we proceeded with doing small tests like breathing hot air onto the sensor to see if the temperature increased and fanning the sensor to ensure the temperature would decrease. These small tests proved to be successful and so we were then able to take the sensor into the senior design lab to take advantage of the technologies present for a more drastic temperature shift. Inside the senior design lab we connected the sensor to the appropriate pins on our STM32 development board kit and waited until the temperature sensor was able to read an accurate ambient reading of the lab. Once ambient temperature was reached on the sensor, we turned on the heat gun in the lab and pointed it to our sensor to see if the sensor could recognize a drastic increase in temperature of the air around the sensor. The tests produced in our original room and in the senior design lab proved to be accurate which assured us for picking the appropriate and correct temperature sensor for our project.

9.7 Hardware and Software Testing of The Buzzer

Completion of the hardware testing of the PS1240 Piezo Buzzer was one of the simplest hardware testing completed. Within the product description of the Piezo buzzer, it boasts its ability to work with a 3 to 30 Volt peak-to-peak square wave input with zero DC bias and within the frequency range of 2K to 10K Hz. The test plan we chose to go with was to feed an initial voltage source to the buzzer and observe the outcome, from there we are to clarify the input signal with a varying peak-to-peak square input voltage and appropriate frequency range. Once the initial check is complete the test plan continues with incorporating the development kit for the STM 32 and programming the desired

output signal through PWM. By adjusting the duty cycle of the signal we were able to get different sounds from the buzzer.

Initial testing then began when we attached the buzzer to a breadboard with one pin in ground and the other pin connected in series with the Rhodes & Schwarz NGE100 power supply for an input voltage of 3 Volts. This did not work due to there being no square wave input and so we continued with the next phase. For the next phase we disconnected the Rhodes & Schwarz NGE100 power supply and modified the circuit in the breadboard to connect the Piezo buzzer with one pin to ground then the other pin in series with the Keysight EDU33212A Waveform generator that provided a 3 Volt peak-to-peak square wave input with zero DC bias and 2 KHz frequency. This next phase produced an appropriate sound to which we were happy with. We then listened for differences in volume and pitch when varying the input voltage from 3 to 30 Volts and then varying the frequency from 2KHz to 10KHz.

The next step in the testing process was to connect it to the STM32 development kit and use code to utilize the button on the board and adjust the duty cycle. First we experimented and attempted to output DC to the buzzer, however this produced a low, brittle sound. After looking at the board's datasheet, we found that we were likely outputting a sine wave with minimal variation which would explain the sound output. Next we looked into inputting a square wave, which could be achieved through a PWM signal. We configured the TIM2 on the NUCLEO-WB09KE, which allowed us to send a PWM output through a pin on the board. After hooking up the buzzer to this pin and common ground we were able to get a solid, desired loud noise. We were then able to cycle through different duty cycles by connecting a button interrupt with different percentages for the input voltage. We found that by changing the duty cycle we achieved different sounds, however there were minimal changes to the volume.

Since it would be ideal to have different volumes for different buzzer alarms, we decided to test out an op-amp to amplify the PWM signal going to the buffer. Notably, we did not utilize the BJT driver circuit and instead plugged the positive and ground of the PWM signal directly to the buzzer. This did not cause any notable issues, but we will incorporate and test this driver circuit in the final design. Since we had only a 5V supply at the time of testing, we could only get the amplified PWM signal to make the buzzer 1dB louder. The final design will incorporate a PWM signal with a higher amplitude with a 12V supply, so it should be significantly louder if we were to max out the gain before clipping.

9.8 Servo Motor and Motor Encoder Testing

Interfacing the motor with the STM32 required a bit of research. We initially powered the motor with 5VDC and sent in a PWM signal, however this did not affect the movement of the motor's rod. Traditionally, servo motors are able to be in compliance with hobbyist boards such as the Arduino series and ESP32s by implementing a servo library and initializing the motor through pre-existing functions. We were not able to find a reliable servo library in compliance with the STM32WB09KE MCU, and so we attempted to send a raw PWM signal to make it move. After doing some research, we found out that servo motors require a specific period in order to interpret input signals, and that the MG996R motor requires a 50 hz period. By adjusting this value in the code we were able to get the motor moving to the desired angle through the development board.

9.9 LCD Screen Testing

For LCD screen testing we ran into some issues with the pin availability on our STM32 Development kit. The original 4 inch TFT touch screen we purchased from wave share had 34 pins which included 3 SPI pins and 16 GPIO (general purpose input output) data pins e.t.c. Since our selection for MCU only has 32 pins, 27 being GPIO pins it was impossible to incorporate our original selection of LCD screen along with our remaining peripherals including the temperature sensor, carbon dioxide sensor, buzzer, servo motor and motor encoder. As such problems arose we will be beginning senior design 2 with testing for the new LCD screen we have ordered which will work more cohesively with the rest of our system.

9.10 Plan for Senior Design 2

In SD2 we plan on incorporating all of the subsystems into one comprehensive unit, and implement our plans for combining the PSU and MCU in both the control unit and the vent. We plan on polishing our PCB design and ordering it as soon as possible so we could test and ensure that the subsections meet the desired functionality. We are also planning on finalizing the code that will be implemented on both subsystems, being able to combine all of the individual components into one master script that will also implement the logic as shown in the flowcharts. Once we have both of these accomplished, we will look into uploading the code onto the flash of the MCU on the PCB.

We are also going to look into implementing software for the LCD screen. Once we are able to configure the pins to our MCU and turn the LCD screen on, we are planning on being able to print characters and ensure touch screen

capabilities work as intended. We are also going to use the graphics library to aid in development of the user interface. The screen will also be able to cycle through different menus, with each one having their own design. Once we are certain that the LCD screen works and is compatible with the graphics library and the STM32, we will connect it with the logic of the rest of the software design and ensure that two way communication and data interpretation is possible between the LCD screen and the MCU.

In order to upload code onto the flash of the STM32WB09KE we will need to implement a method on each board that will allow us to interface with the MCU to program and debug it as necessary. The STM32 can be programmed through JTAG or SWD (Serial Wire Debug). ST offers several debuggers under the ST-LINK product line. The ST-LINK V2 and V3 lines are the main considerations for our design considering the other products in the line are obsolete. The ST-LINK V2 is a popular and cheap option with a few caveats. Firstly, we plan on using SWD to interface with the STM32 as this is what ST recommends and it requires less pins than JTAG (10 as opposed to 20). Unfortunately, the ST-LINK V2 is only capable of SWD through a JTAG socket, requiring 20 pins on the board to be able to interface with the MCU. There is, however, a work-around involving the use of a dedicated JTAG to SWD adapter which would allow us to only need the standard 10 pins for SWD on the board. This would add cost and may add some headache if the adapter is found to be non-functional. Tagconnect also offers officially promoted third-party cables that only require small pads to be etched into the PCB as opposed to an actual pin header. This option, however, tends to be quite costly and also may come loose from the board much easier than using pin-connectors.

The ST-LINK V3 is a little more modern and utilizes the proper 10-pin SWD socket without the need for an adapter like the ST-LINK V2. Unfortunately, the ST-LINK V3 does not support application voltages under 3.3V, which would pose issues when interfacing with the vent interaction subsystem which has a 2.5V supply. This means using the ST-LINK V2 with a proper adapter will be the method we use to program our MCUs moving forward.

In addition to having the previous sections working, we will also test the battery life of the system. We will accomplish this by having all of the necessary components available and powered, then examining and interpreting the power consumed over a period of time. Once we find out the average power consumption for every mode the system will be in, we will be able to approximate the average time spent in each mode and calculate the life expectancy of the vent before a battery replacement is necessary.

In SD2 we are also planning on interfacing our components with a vent design. We are still evaluating the pros and cons of different vent designs, and once we find the most optimal design we are going to test function compatibility to meet our specifications. There are many mechanisms that we can experiment with to allow BREATHE to open and close the vent, however our main focus will be dedicated towards the electrical and software aspects.

10.0 Administrative Content

10.1 Budget

Item Description	Quantity	Estimated Price	Overall Cost
PCB Boards	2	\$35	\$70
MCU's	2	\$25	\$125
DC Motor	1	\$15	\$15
Temperature Sensor	1	\$10	\$10
CO ₂ Sensor	1	\$30	\$30
Batteries	2	\$40	\$80
Sample Vent	1	\$20	\$20
Panel Enclosure	1	\$30	\$30
Touchscreen LCD	1	\$0	\$0
Passive Speaker	1	\$2	\$2
		Total Cost	\$382

Table 27: Budget Estimate Table

For the budget, the team opted to account for the absolute worst case scenario in terms of cost for each of the items needed to fulfill our project's design. The two MCU's we plan on using will likely cost less than \$25, but we determined the most costly MCU to use for our sensors would be around that price if we use an existing integrated board. The same methodology is applied to the two batteries we plan on using. Fortunately, we already own a resistive touch TFT

LCD screen so this cost will not be factored into the budget. We have researched many different options which might fit within our project goals based on power consumption and safety. Depending on what works best and fits within our constraints, we adjusted the budget to allow some flexibility. It is very likely the total cost will not reach this estimate, but this should be a good estimate based on the direction we plan to take our project in. Thankfully, as long as no parts are damaged, this budget should be fairly accurate when accounting for possible PCB fabrication issues. This project is sponsored, but despite that we are aiming for this project to be relatively low cost in its most basic form.

Item:	Total Needed For Project	Backup quantitiy	total Quantity:	Item cost:	Total Cost:
TMP102 Sensor	1	3	4	\$ 2.50	\$ 10.00
SCD41 CO2 Sensor	1	1	2	\$ 37.10	\$ 74.20
4 inch TFT Touch Screen	1	1	2	\$ 34.99	\$ 69.98
Piezo Buzzer	1	4	5	\$ 1.50	\$ 7.50
MG996R Servo Motor	1	3	4	\$ 4.25	\$ 17.00
STM32 WB09KE devkit	2	0	2	\$ 25.00	\$ 50.00
TPS562242 Buck Converter	3	2	5	\$ 0.35	\$ 1.75
EC10E1220501 Encoder	1	3	4	\$ 0.90	\$ 3.60
9V battery Energizer	2	1	3	\$ 16.00	\$ 48.00
				Total Cost	\$ 282.03

Table 28: Bill of Materials

10.2 Project Milestones

Task	Task Description	Start Date	Anticipated End Date
Group Formation	Form a group before the second lecture <i>Group Formation</i>	8/20/2024	8/22/2024

Project Idea Creation	Formulate a project idea	8/22/2024	8/30/2024
Divide and Conquer Document	Finish at least 10 pages of the D/C document	8/30/2024	9/6/2024
Divide and Conquer Meeting with Professor	Discuss divide and conquer document and take note of criticism and plan to make changes	9/10/2024	9/10/2024
Divide and Conquer Revisions	Discuss criticisms given and make revisions to the Divide and Conquer Document	9/10/2024	9/27/2024
60 Page Report Draft	Finish our group's 60 page report draft	9/28/2024	10/25/2024
60 Page Report Revision	Discuss criticisms given and make revisions to the 60 page report	10/26/2024	11/8/2024
Final Report and Mini Demo Video	Complete the Final Report and Mini Demo Video for SD1	11/9/2024	11/26/2024

Table 29: Senior Design I Milestones

Task	Task Description	Start Date	Anticipated End Date
PCB Testing	Start PCB testing and ensure they all function as desired	TBD	TBD
System Integration and Testing, incorporate	Start integrating all subsystems together and begin testing their functionality. Begin	TBD	TBD

stretch goals if possible	implementing stretch goals if realistic and possible. Need some time to identify and correct errors on both the software and hardware side.		
Finalize project prototype	Finalize implemented all subsystems together into one, cohesive project.	TBD	TBD
Practice Project Demo	Begin practicing a simulated project demonstration to make sure everything works as anticipated	TBD	TBD
Possibly implement optimizations (if necessary and or possible)	If a system can be improved, begin implementing new optimizations to BREATHE.	TBD	TBD
Finalize any documents	Finalize any documents needed	TBD	TBD
Group Practices Final Presentation	Practice Final presentation as a group	TBD	TBD
Final Presentation	Present final project to SD committee.	TBD	TBD

Table 30: Senior Design II Milestones

10.3 Work Distribution Table

Responsibilities	Primary Member	Secondary Member
Power Supply Design	Kyle Ingleton	Emily Baross
Vent Interaction subsystem PCB Design	Kyle Ingleton	Emily Baross
Control Unit PCB Design	Emily Baross	Kyle Ingleton

Vent Interaction Subsystem Software Design	Marcus Loyd	Patrick Tumbos
Control Unit Software Design	Patrick Tumbos	Marcus Loyd
LCD and GUI Design	Marcus Loyd	Patrick Tumbos
Carbon Dioxide Sensor Testing	Patrick Tumbos	Emily Baross
Temperature Sensor Testing	Patrick Tumbos	Emily Baross
Motor Testing and Configuration	Marcus Loyd	Emily Baross
Vent Interaction Subsystem Enclosure Design/Testing	Emily Baross	Marcus Loyd
Buzzer configuration and Testing	Patrick Tumbos	Kyle Ingleton

Table 31: Work Distribution Table

11.0 Conclusion

In conclusion, BREATHE offers a user-friendly and efficient solution for improving the environmental conditions of common rooms in households. By allowing users to input their desired conditions of their rooms, they are able to comfortably live without worries of temperature variations. This can significantly improve quality of life due to not having to rely on less effective alternative means of temperature control such as ceiling fans. Although this product can benefit consumers, like any technology there is still a lot of room for improvement. This can include stretch goals such as implementing a mobile app to allow users to have a more convenient user interface with the control unit.

In summary, although the STM32WB09KE was originally selected and utilized for testing, the STM32WB55 was chosen as the MCU going forward due to its robust documentation and plethora of pins. The temperature and carbon dioxide sensors that were selected were the TMP102 and SCD41 respectively, as they both provided a strong balance between efficiency, ease of integration with the STM32, and reliability. Moreover, the PS1240 piezoelectric buzzer was selected for its ability to output a clear and audible sound and was amplified with the use of an operational amplifier. Likewise, the motor selected was the MG966R servo motor due to its high capability of torque and speed. Additionally, the chosen methods of voltage regulation were an LDO and buck converter which were

compliant in the vent interaction subsystem's long term power needs. Various software tools were used, such as STM32CubeIDE and STM32CubeProgrammer in the development of BREATHE's software. Serial communications such as UART and I2C made interfacing and testing the sensors possible, and the use of BLE allowed for the MCU's to communicate with each other efficiently. Lastly, each component underwent thorough testing to ensure that they worked optimally.

By working on this project the group was able to build and expand our foundational skills to prepare us for industry. We were able to apply the skills we gained from class to a practical project, guiding us throughout the development process all the way from system design and research to prototyping and experimentation. This project has also introduced us to different technologies utilized in industry, such as KiCad and STM32CubeIDE. The challenges that we came across had us consider many different possible options and we evaluated each one before picking the most optimal solution. The biggest challenges we faced were finding ways to reduce power consumption for the vent interaction subsystem and have each subsystem interact with other subsystems, however by learning and utilizing the past knowledge and experiences we were able to design BREATHE to accommodate for these.

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Appendix B - Copyright Permissions

PT

Patrick Tumbos

To: ConnectionsHRServices@analog.com

Cc: Marcus Loyd; Emily Baross; Kyle Ingleton

Reply

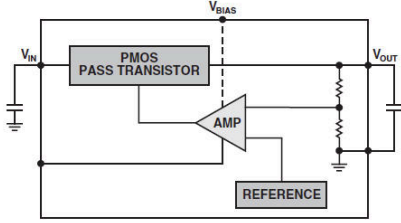
Reply all

Forward

Tue 10/29/2024 12:44 PM

Dear Analog Devices HR,

We are a group of students attending the University of Central Florida reaching out to request permission to use an image of one of Analog Devices' LDO regulators in our senior design project. The image would be used solely for educational purposes as part of our project materials, with appropriate credit given to Analog Devices. We appreciate your assistance and look forward to your response. The image requested is attached below.



Thank you for your time ,

Emily Baross
Kyle Ingleton
Marcus Loyd
Patrick Tumbos

PT

Patrick Tumbos

To: support@duracellpowercenter.com

Cc: Marcus Loyd; Emily Baross; Kyle Ingleton

Reply

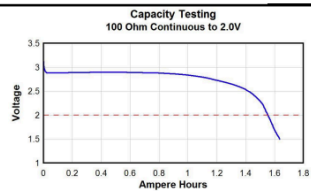
Reply all

Forward

Tue 10/29/2024 12:51 PM

Dear Duracell Support,

We are a group of students from the University of Central Florida working on our senior design project. We would like to request permission to use an image from a Duracell battery datasheet as part of our project materials. The image would be used solely for educational purposes, with appropriate credit given to Duracell. The image requested and link is attached below.



https://www.duracell.com/wp-content/uploads/2021/06/CR123_US.pdf

We appreciate your assistance in this matter and look forward to your response.

Thank you,

Emily Baross
Kyle Ingleton
Marcus Loyd
Patrick Tumbos

Reply

Reply all

Forward

Figure 7, Await=

PT

Patrick Tumbos

To: khg@kristenhalgeisler.com

Cc: @ Marcus Loyd; @ Kyle Ingleton; @ Emily Baross

Dear Ms. Kristen Hall-Geisler,

We are a group of students from the University of Central Florida working on our senior design project, and we would like to request permission to use an image from your article, *How Gears Work*, co-authored with Mr. Karim Nice. The image would be used solely for educational purposes in our project materials, with appropriate credit given to both you and Mr. Nice.

The image and a link to it are attached below for reference.



Rack (straight bar with teeth) and pinion gears from a household scale
HOWSTUFFWORKS

<https://science.howstuffworks.com/transport/engines-equipment/gear.htm>

Thank you very much for your time and consideration, and we look forward to your response.

Regards,

Emily Baross
Kyle Ingleton
Marcus Loyd
Patrick Tumbos

☺️ ↩️ Reply ↩️ Reply all ➡️ Forward 📎 📧 ⋮

Tue 10/29/2024 1:02 PM

PT

Patrick Tumbos

To: AskWCB@wcbranham.com

Cc: @ Marcus Loyd; @ Kyle Ingleton; @ Emily Baross

Dear WC Branham,

We are a group of students from the University of Central Florida working on our senior design project, and we would like to request permission to use an image from the blog *As the Worm Turns: How Worm Gears Control Speed in Industrial Machinery*. The image would be used solely for educational purposes in our project materials, with appropriate credit given to WC Branham.

The image and a link to it are attached below for reference.



<https://blog.wcbranham.com/worm-gears-regulate-speed>

Thank you very much for your time and consideration, and we look forward to your response.

Best regards,

Emily Baross
Kyle Ingleton
Marcus Loyd
Patrick Tumbos

☺️ ↩️ Reply ↩️ Reply all ➡️ Forward 📎 📧 ⋮

Tue 10/29/2024 1:18 PM

Request for Permission to Use Image from MAX77505 Datasheet

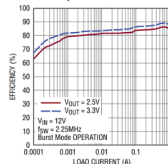
Kyle Ingleton
Yo: brand@analog.com
Cc: Patrick Tumbos, Marcus Loyd

Reply Reply All Forward
Tue 11/26/2024 3:56 AM

Dear Analog Devices,

We are a group of students from the University of Central Florida working on our senior design project, and we would like to request permission to use an image from the MAX77505 datasheet. The image would be used solely for educational purposes in our project materials, with appropriate credit is given to your company. The image and a link to it are attached below for reference.

Efficiency vs Load Current



https://www.analog.com/media/en/technical_documentation/datasheets/max77505.pdf

Thank you very much for your time and consideration, and we look forward to your response.

Best regards,
Emily Barross
Kyle Ingleton
Marcus Loyd
Patrick Tumbos

Appendix E - ChatGPT prompts and outcomes

Prompt 1:

“What voltage regulator would be best for a battery to last as long as possible”

Response:

“Choosing the right voltage regulator to maximize battery life depends on the specific requirements of your project, such as the input and output voltages, current consumption, and efficiency needs. Here are some key points to consider:

1. Types of Voltage Regulators:

- **Linear Regulators (LDO):** Simple and inexpensive, linear regulators work well for low-current applications but are inefficient when the input voltage is much higher than the output. The excess energy is dissipated as heat, leading to faster battery drain.
- **Switching Regulators (Buck/Boost Converters):** These are much more efficient than linear regulators, especially for higher currents and when the input voltage is significantly different from the output. They can step down (buck) or step up (boost) the voltage.

2. Factors Influencing Battery Life:

- **Efficiency:** Higher efficiency means less power wasted as heat, prolonging battery life. Switching regulators typically have efficiencies of 80-95%, while linear regulators can be as low as 50% or less in some cases.

- Quiescent Current: This is the current the regulator consumes even when the load is minimal. For battery-operated devices, a regulator with low quiescent current is ideal.
- Input Voltage Range: Make sure the regulator can handle the full range of the battery voltage as it discharges.

3. Recommended Voltage Regulators for Maximizing Battery Life:

- Buck Converter: If your battery voltage is higher than the required output voltage, a buck converter (step-down) is suitable. Look for one with high efficiency and low quiescent current, such as the Texas Instruments TPS62125.
- Boost Converter: If your battery voltage is lower than your required output voltage, a boost converter (step-up) is needed. The Analog Devices LTC3539 is an efficient option with low quiescent current.
- Buck-Boost Converter: If your input voltage can fluctuate above and below your desired output, a buck-boost converter like the Texas Instruments LM2623 or the Analog Devices LT8495 is a good choice.

4. Ultra-Low Quiescent Current Regulators:

- If your project is low power and spends a lot of time in sleep mode, choose a regulator with ultra-low quiescent current, such as the Microchip MCP1700 (LDO) or the Texas Instruments TPS62743 (buck converter).

Selecting a regulator that balances efficiency and low quiescent current will help extend battery life.” [114].

Prompt 2:

“Give me standards regarding air quality using co2 and temperature sensors”

“Response (ChatGPT):When it comes to air quality standards involving CO₂ and temperature sensors, several key standards and guidelines can be referenced:

1. NIOSH (National Institute for Occupational Safety and Health)

CO₂ Exposure Limits: NIOSH recommends a ceiling limit of 3,000 ppm (parts per million) for CO₂ in workplace environments to avoid potential health risks.

Heat Stress: Guidelines for temperature in occupational settings recommend maintaining temperatures to prevent heat stress, particularly in high-temperature work environments.

2. OSHA (Occupational Safety and Health Administration)

Air Quality Standards: OSHA does not set a specific CO₂ standard but follows NIOSH recommendations for safe exposure levels.

Thermal Stress: OSHA's standards emphasize maintaining acceptable thermal environments in workplaces to protect employees from heat-related illnesses.

3. ASHRAE (American Society of Heating, Refrigerating and Air-Conditioning Engineers)

Indoor Air Quality (IAQ): ASHRAE Standard 62.1 (Ventilation for Acceptable Indoor Air Quality) suggests maintaining CO₂ levels below 1,000 ppm in indoor spaces to ensure acceptable air quality.

Temperature Guidelines: ASHRAE recommends maintaining indoor temperatures between 68°F and 75°F (20°C to 24°C) in winter and 75°F to 80°F (24°C to 27°C) in summer for optimal comfort.

4. EPA (Environmental Protection Agency)

Indoor Air Quality Guidelines: The EPA provides general recommendations for maintaining indoor air quality, including monitoring CO₂ levels and ensuring good ventilation practices to control pollutant levels.

5. WHO (World Health Organization)

Air Quality Guidelines: WHO recommends keeping CO₂ levels below 1,000 ppm in indoor settings to minimize health risks associated with poor air quality.

Temperature Recommendations: WHO suggests that thermal comfort in indoor environments should be managed to promote health and productivity.

6. EN 13779 (European Standard)

Ventilation for Non-Residential Buildings: This standard specifies requirements for ventilation systems, emphasizing maintaining CO₂ levels below 1,000 ppm and managing temperature for comfort and health.

7. ISO (International Organization for Standardization)

ISO 16000 Series: These standards relate to indoor air quality and provide guidelines for measuring various pollutants, including CO₂. They also include recommendations for maintaining thermal comfort.

Practical Applications

When implementing CO₂ and temperature sensors in your smart vent system, consider adhering to these standards to ensure that your system promotes a healthy indoor environment. Monitoring CO₂ levels and maintaining optimal temperature can help mitigate health risks and enhance overall air quality” [113].

Prompt 3:

“How much current does scd41 consume?”

Response: “The SCD41 CO₂ sensor typically consumes around 70 μ A in low-power mode and up to 120 μ A during measurement mode. It also has a peak current of about 2.5 mA during warm-up. These values make it suitable for battery-powered applications where low power consumption is crucial” [114].

We have utilized LLM for drafting, outlining, comparing, summarizing, and proofreading purposes.